



# THE DATASHEET OF ADM1278-1ACPZ-RL

### FEATURES

- ±0.3% accurate, 12-bit ADC for  $I_{OUT}$ ,  $V_{IN}$ ,  $V_{OUT}$ , and temperature
- 320 ns response time to short circuit
- Shutdown on detection of FET health fault
- Constant power foldback for tighter FET SOA protection
- Remote temperature sensing with programmable warning and shutdown thresholds
- Resistor-programmable 5 mV to 25 mV  $V_{SENSE}$  current limit
- Programmable start-up current limit
- 1% accurate UV, OV, and PWRGD thresholds
- Split hot swap and power monitor inputs to allow additional external ADC filtering
- Reports power and energy consumption over time
- Peak detect registers for current, voltage, and power
- PROCHOT power throttling capability
- PMBus fast mode compliant interface
- 5 mm × 5 mm, 32-lead LFCSP

### APPLICATIONS

- Servers
- Power monitoring and control/power budgeting
- Telecommunication and data communication equipment

### GENERAL DESCRIPTION

The [ADM1278](#) is a hot swap controller that allows a circuit board to be removed from or inserted into a live backplane. It also features current, voltage, power, and temperature readback via an integrated 12-bit analog-to-digital converter (ADC), accessed using a PMBus™ interface. The load current is measured using an internal current sense amplifier that measures the voltage across a sense resistor in the power path via the HS+ and HS– pins. A default current limit of 20 mV is set, but this limit can be adjusted, if required.

The [ADM1278](#) limits the current through the sense resistor by controlling the gate voltage of an external N-channel FET in the power path, via the GATE pin. The sense voltage, and therefore the load current, is maintained below the preset maximum. The [ADM1278](#) protects the external FET by limiting the time that the FET remains on while the current is at its maximum value. This current-limit time is set by the choice of capacitor connected to the TIMER pin. In addition, a constant power foldback scheme is used to control the power dissipation in the MOSFET during power-up and fault conditions. The level of this power, along with the TIMER regulation time, can be set to ensure that the MOSFET remains within safe operating area (SOA) limits.

### TYPICAL APPLICATION CIRCUIT

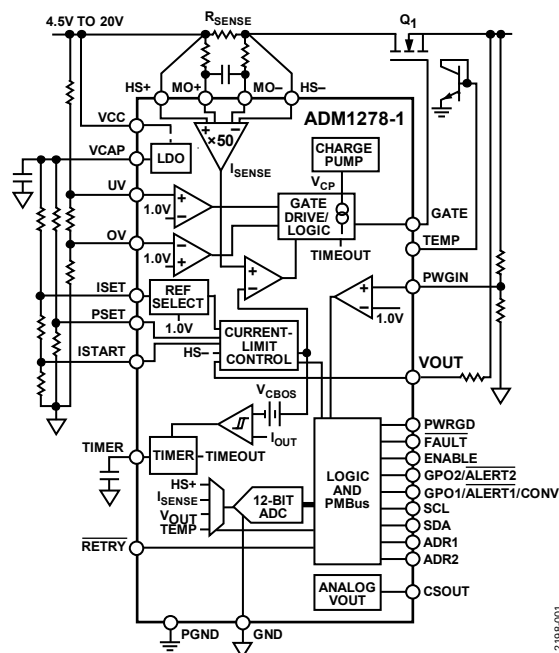


Figure 1.

In case of a short-circuit event, a fast internal overcurrent detector responds within 320 ns and signals the gate to shut down. A 1500 mA pull-down device ensures a fast FET response.

The [ADM1278](#) features overvoltage (OV) and undervoltage (UV) protection, programmed using external resistor dividers on the UV and OV pins. A PWRGD signal can be used to detect when the output supply is valid, using the PWGIN pin to accurately monitor the output.

The [ADM1278](#) is available in a 32-lead LFCSP with a  $\overline{\text{RETRY}}$  pin that can be configured for automatic retry or latch-off when an overcurrent fault occurs.

Table 1. Model Options

| Model                       | ADC Accuracy | SPI Interface | Enable Pin <sup>1</sup> |
|-----------------------------|--------------|---------------|-------------------------|
| <a href="#">ADM1278-1AA</a> | ±0.3%        | No            | Active high             |
| <a href="#">ADM1278-1A</a>  | ±0.7%        | No            | Active high             |
| <a href="#">ADM1278-1B</a>  | ±1.0%        | No            | Active high             |
| <a href="#">ADM1278-2A</a>  | ±0.7%        | Yes           | Active high             |
| <a href="#">ADM1278-3A</a>  | ±0.7%        | No            | Active low              |

<sup>1</sup> Active high relates to the ENABLE pin, and active low relates to the  $\overline{\text{ENABLE}}$  pin.

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## REVISION HISTORY

### 10/2018—Rev. A to Rev. B

|                                       |    |
|---------------------------------------|----|
| Changes to Figure 4 and Figure 5..... | 11 |
| Changes to Figure 6.....              | 14 |
| Updated Outline Dimensions.....       | 61 |
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### 12/2014—Rev. 0 to Rev. A

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### 6/2014—Revision 0: Initial Version

## SPECIFICATIONS

$V_{CC} = 4.5\text{ V to }20\text{ V}$ ,  $V_{CC} \geq V_{HS+}$  and  $V_{MO+}$ ,  $V_{HS+} = 2\text{ V to }20\text{ V}$ ,  $V_{SENSE\_HS} = (V_{HS+} - V_{HS-}) = 0\text{ V}$ ,  $T_A = -40^{\circ}\text{C to }+85^{\circ}\text{C}$ , unless otherwise noted.

Table 2.

| Parameter <sup>1</sup>              | Symbol                   | Min  | Typ  | Max  | Unit | Test Conditions/Comments                                                                               |
|-------------------------------------|--------------------------|------|------|------|------|--------------------------------------------------------------------------------------------------------|
| POWER SUPPLY                        |                          |      |      |      |      |                                                                                                        |
| Operating Voltage Range             | V <sub>CC</sub>          | 4.5  |      | 20   | V    | V <sub>CC</sub> rising                                                                                 |
| Undervoltage Lockout                | UVLO                     | 2.4  |      | 2.7  | V    |                                                                                                        |
| Undervoltage Hysteresis             |                          |      | 90   | 120  | mV   | GATE on and power monitor running                                                                      |
| Quiescent Current                   | I <sub>CC</sub>          |      |      | 5.5  | mA   |                                                                                                        |
| UV PIN                              |                          |      |      |      |      |                                                                                                        |
| Input Current                       | I <sub>UV</sub>          |      |      | 50   | nA   | UV ≤ 3.6 V                                                                                             |
| UV Threshold                        | UV <sub>TH</sub>         |      |      |      |      |                                                                                                        |
| A Grade and AA Grade                |                          | 0.99 | 1.0  | 1.01 | V    | UV falling                                                                                             |
| B Grade Only                        |                          | 0.97 | 1.0  | 1.03 | V    | UV falling                                                                                             |
| UV Threshold Hysteresis             | UV <sub>HYST</sub>       | 45   | 60   | 75   | mV   |                                                                                                        |
| UV Glitch Filter                    | UV <sub>GF</sub>         | 2    |      | 7    | μs   | 50 mV overdrive                                                                                        |
| UV Propagation Delay                | UV <sub>PD</sub>         |      | 5    | 8    | μs   | UV low to GATE pull-down active                                                                        |
| OV PIN                              |                          |      |      |      |      |                                                                                                        |
| Input Current                       | I <sub>OV</sub>          |      |      | 50   | nA   | OV ≤ 3.6 V                                                                                             |
| OV Threshold                        | OV <sub>TH</sub>         |      |      |      |      |                                                                                                        |
| A Grade and AA Grade                |                          | 0.99 | 1.0  | 1.01 | V    | OV rising                                                                                              |
| B Grade Only                        |                          | 0.97 | 1.0  | 1.03 | V    | OV rising                                                                                              |
| OV Threshold Hysteresis             | OV <sub>HYST</sub>       | 45   | 60   | 75   | mV   |                                                                                                        |
| OV Glitch Filter                    | OV <sub>GF</sub>         | 1.5  |      | 3.5  | μs   | 50 mV overdrive                                                                                        |
| OV Propagation Delay                | OV <sub>PD</sub>         |      | 3.0  | 4.0  | μs   | OV high to GATE pull-down active                                                                       |
| HS+ AND HS– PINS                    |                          |      |      |      |      |                                                                                                        |
| Input Current                       | I <sub>SENSEX</sub>      |      |      | 150  | μA   | Per individual pin; V <sub>HS+</sub> , V <sub>HS–</sub> = 20 V                                         |
| Input Imbalance                     | I <sub>ΔSENSE</sub>      |      |      | 5    | μA   | I <sub>ΔSENSE</sub> = (I <sub>+</sub> – I <sub>–</sub> )                                               |
| MO+ AND MO– PINS                    |                          |      |      |      |      |                                                                                                        |
| Input Current                       | I <sub>MO±</sub>         |      |      | 25   | nA   | Per individual pin; V <sub>MO+</sub> , V <sub>MO–</sub> = 20 V                                         |
| VCAP PIN                            |                          |      |      |      |      |                                                                                                        |
| Internally Regulated Voltage        | V <sub>VCAP</sub>        |      |      |      |      |                                                                                                        |
| A Grade and AA Grade                |                          | 2.68 | 2.7  | 2.72 | V    | 0 μA ≤ I <sub>VCAP</sub> ≤ 100 μA; C <sub>VCAP</sub> = 1 μF                                            |
| B Grade Only                        |                          | 2.66 | 2.7  | 2.74 | V    | 0 μA ≤ I <sub>VCAP</sub> ≤ 100 μA; C <sub>VCAP</sub> = 1 μF                                            |
| ISET PIN                            |                          |      |      |      |      |                                                                                                        |
| Reference Select Threshold          | V <sub>ISETRSTH</sub>    | 1.35 | 1.5  | 1.65 | V    | If V <sub>ISET</sub> > V <sub>ISETRSTH</sub> , an internal 1 V reference (V <sub>CLREF</sub> ) is used |
| Internal Reference                  | V <sub>CLREF</sub>       |      | 1    |      | V    | Accuracies included in total sense voltage accuracies                                                  |
| Gain of Current Sense Amplifier     | AV <sub>CSAMP</sub>      |      | 50   |      | V/V  | Accuracies included in total sense voltage accuracies                                                  |
| Recommended Maximum Operating Range | V <sub>ISET</sub>        | 0.25 |      | 1.25 | V    | 5 mV to 25 mV V <sub>SENSE</sub> current limit                                                         |
| Input Current                       | I <sub>ISET</sub>        |      |      | 100  | nA   | V <sub>ISET</sub> ≤ V <sub>VCAP</sub>                                                                  |
| GATE PIN                            |                          |      |      |      |      |                                                                                                        |
| GATE Drive Voltage                  | ΔV <sub>GATE</sub>       |      |      |      |      | Maximum voltage on the gate is always clamped to ≤31 V                                                 |
|                                     |                          | 10   | 12   | 14   | V    | ΔV <sub>GATE</sub> = V <sub>GATE</sub> – V <sub>OUT</sub>                                              |
|                                     |                          | 8    |      | 10   | V    | 20 V ≥ V <sub>CC</sub> ≥ 8 V; I <sub>GATE</sub> ≤ 5 μA                                                 |
|                                     |                          | 7    |      | 9    | V    | V <sub>HS+</sub> = V <sub>CC</sub> = 5 V; I <sub>GATE</sub> ≤ 5 μA                                     |
|                                     |                          |      |      |      | V    | V <sub>HS+</sub> = V <sub>CC</sub> = 4.5 V; I <sub>GATE</sub> ≤ 1 μA                                   |
| GATE Pull-Up Current                | I <sub>GATEUP</sub>      | –20  |      | –30  | μA   | V <sub>GATE</sub> = 0 V                                                                                |
| GATE Pull-Down Current              | I <sub>GATEDN</sub>      |      |      |      |      |                                                                                                        |
| Regulation                          | I <sub>GATEDN_REG</sub>  | 45   | 60   | 75   | μA   | V <sub>GATE</sub> ≥ 2 V; V <sub>ISET</sub> = 1.0 V; (V <sub>HS+</sub> – V <sub>HS–</sub> ) = 30 mV     |
| Slow                                | I <sub>GATEDN_SLOW</sub> | 5    | 10   | 15   | mA   | V <sub>GATE</sub> ≥ 2 V                                                                                |
| Fast                                | I <sub>GATEDN_FAST</sub> | 750  | 1500 | 2250 | mA   | V <sub>GATE</sub> ≥ 12 V; V <sub>CC</sub> ≥ 12 V                                                       |
| GATE Holdoff Resistance             |                          |      | 20   |      | Ω    | V <sub>CC</sub> = 0 V, V <sub>GATE</sub> = 2 V                                                         |

| Parameter <sup>1</sup>                | Symbol                | Min   | Typ  | Max   | Unit          | Test Conditions/Comments                                                                                                          |
|---------------------------------------|-----------------------|-------|------|-------|---------------|-----------------------------------------------------------------------------------------------------------------------------------|
| <b>HOT SWAP SENSE VOLTAGE</b>         |                       |       |      |       |               |                                                                                                                                   |
| Hot Swap Sense Voltage Current Limit  | $V_{SENSECL}$         |       |      |       |               |                                                                                                                                   |
| A Grade and AA Grade                  |                       | 19.75 | 20   | 20.25 | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{GATE} = (V_{HS+} + 3\text{ V})$ ; $I_{GATE} = 0\text{ }\mu\text{A}$                              |
| B Grade Only                          |                       | 19.6  | 20   | 20.4  | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{GATE} = (V_{HS+} + 3\text{ V})$ ; $I_{GATE} = 0\text{ }\mu\text{A}$                              |
| Constant Power Inactive               |                       |       |      |       |               | $V_{GATE} = (V_{HS+} + 3\text{ V})$ ; $I_{GATE} = 0\text{ }\mu\text{A}$ ; $V_{DS} = (HS-) - V_{OUT}$                              |
| A Grade and AA Grade                  |                       | 24.75 | 25   | 25.25 | mV            | $V_{ISET} = 1.25\text{ V}$ ; $V_{DS} < 2\text{ V}$                                                                                |
|                                       |                       | 19.75 | 20   | 20.25 | mV            | $V_{ISET} = 1.0\text{ V}$ ; $V_{DS} < 2\text{ V}$                                                                                 |
|                                       |                       | 14.75 | 15   | 15.25 | mV            | $V_{ISET} = 0.75\text{ V}$ ; $V_{DS} < 2\text{ V}$                                                                                |
| B Grade Only                          |                       | 24.6  | 25   | 25.4  | mV            | $V_{ISET} = 1.25\text{ V}$ ; $V_{DS} < 2\text{ V}$                                                                                |
|                                       |                       | 19.6  | 20   | 20.4  | mV            | $V_{ISET} = 1.0\text{ V}$ ; $V_{DS} < 2\text{ V}$                                                                                 |
|                                       |                       | 14.6  | 15   | 15.4  | mV            | $V_{ISET} = 0.75\text{ V}$ ; $V_{DS} < 2\text{ V}$                                                                                |
| Constant Power Active                 |                       |       |      |       |               | FET power limit = $(V_{PSET} \times 8)/(50 \times R_{SENSE})$ ; constant power active when $V_{DS} > (V_{PSET} \times 8)/I_{SET}$ |
| A Grade and AA Grade                  |                       | 9.25  | 10   | 10.75 | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} = 0.25\text{ V}$ ; $V_{DS} = 4\text{ V}$                                                   |
|                                       |                       | 4.65  | 5    | 5.35  | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} = 0.25\text{ V}$ ; $V_{DS} = 8\text{ V}$                                                   |
|                                       |                       | 1.7   | 2    | 2.3   | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} = 0.25\text{ V}$ ; $V_{DS} = 20\text{ V}$                                                  |
| B Grade Only                          |                       | 9     | 10   | 11    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} = 0.25\text{ V}$ ; $V_{DS} = 4\text{ V}$                                                   |
|                                       |                       | 4.6   | 5    | 5.4   | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} = 0.25\text{ V}$ ; $V_{DS} = 8\text{ V}$                                                   |
|                                       |                       | 1.4   | 2    | 2.6   | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} = 0.25\text{ V}$ ; $V_{DS} = 20\text{ V}$                                                  |
| Start-Up Current Limit                | $V_{ISTARTCL}$        |       |      |       |               |                                                                                                                                   |
| A Grade and AA Grade                  |                       | 4.7   | 5    | 5.3   | mV            | STRT_UP_IOUT_LIM = 3; $V_{ISET} > 1.65\text{ V}$                                                                                  |
|                                       |                       | 3.7   | 4    | 4.3   | mV            | $V_{ISET} = 0.2\text{ V}$                                                                                                         |
| B Grade Only                          |                       | 4.5   | 5    | 5.5   | mV            | STRT_UP_IOUT_LIM = 3; $V_{ISET} > 1.65\text{ V}$                                                                                  |
|                                       |                       | 3.5   | 4    | 4.5   | mV            | $V_{ISET} = 0.2\text{ V}$                                                                                                         |
| Start-Up Current-Limit Clamp          | $V_{ISTARTCL\_CLAMP}$ |       |      |       |               |                                                                                                                                   |
| A Grade and AA Grade                  |                       | 1.6   | 2    | 2.4   | mV            | $V_{ISET} = 0\text{ V}$ or STRT_UP_IOUT_LIM = 0                                                                                   |
| B Grade Only                          |                       | 1.4   | 2    | 2.6   | mV            | $V_{ISET} = 0\text{ V}$ or STRT_UP_IOUT_LIM = 0                                                                                   |
| Circuit Breaker Offset                | $V_{CBOS}$            | 0.6   | 0.88 | 1.12  | mV            | Circuit breaker trip voltage, $V_{CB} = V_{SENSECL} - V_{CBOS}$                                                                   |
| <b>SEVERE OVERCURRENT</b>             |                       |       |      |       |               |                                                                                                                                   |
| Voltage Threshold                     | $V_{SENSEOC}$         |       |      |       |               |                                                                                                                                   |
| A Grade and AA Grade                  |                       | 23    | 25   | 27    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; optional select PMBus (125%)                                             |
|                                       |                       | 28    | 30   | 32    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; optional select PMBus (150%)                                             |
|                                       |                       | 38    | 40   | 42    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; optional select PMBus (200%)                                             |
|                                       |                       | 43    | 45   | 47    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; default at power-up (225%)                                               |
| B Grade Only                          |                       | 20    | 25   | 30    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; optional select PMBus (125%)                                             |
|                                       |                       | 25    | 30   | 35    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; optional select PMBus (150%)                                             |
|                                       |                       | 35    | 40   | 45    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; optional select PMBus (200%)                                             |
|                                       |                       | 40    | 45   | 50    | mV            | $V_{ISET} > 1.65\text{ V}$ ; $V_{PSET} > 1.1\text{ V}$ ; default at power-up (225%)                                               |
| Short Glitch Filter Duration          |                       | 100   |      | 220   | ns            | $V_{SENSE\_HS}$ step = 18 mV to (2 mV above $V_{SENSEOC\_MAX}$ )                                                                  |
| Long Glitch Filter Duration (Default) |                       | 530   |      | 900   | ns            | $V_{SENSE\_HS}$ step = 18 mV to (2 mV above $V_{SENSEOC\_MAX}$ )                                                                  |
| Response Time                         |                       |       |      |       |               |                                                                                                                                   |
| Short Glitch Filter                   |                       | 200   |      | 320   | ns            | $V_{SENSE\_HS}$ step = 18 mV to (2 mV above $V_{SENSEOC\_MAX}$ )                                                                  |
| Long Glitch Filter                    |                       | 630   |      | 1000  | ns            | $V_{SENSE\_HS}$ step = 18 mV to (2 mV above $V_{SENSEOC\_MAX}$ )                                                                  |
| <b>ISTART PIN</b>                     |                       |       |      |       |               |                                                                                                                                   |
| Active Range                          |                       | 0.1   |      | 1.25  | V             | Tie ISTART to VCAP to disable start-up current limit                                                                              |
| Gain of Current Sense Amplifier       | $AV_{CSAMP}$          |       | 50   |       | V/V           | Accuracies included in total sense voltage accuracies                                                                             |
| Input Current                         | $I_{ISTART}$          |       |      | 100   | nA            | $V_{ISET} \leq V_{VCAP}$                                                                                                          |
| <b>TIMER PIN</b>                      |                       |       |      |       |               |                                                                                                                                   |
| TIMER Pull-Up Current                 |                       |       |      |       |               |                                                                                                                                   |
| Power-On Reset (POR)                  | $I_{TIMERUPPOR}$      | -2    | -3   | -4    | $\mu\text{A}$ | Initial power-on reset; $V_{TIMER} = 0.5\text{ V}$                                                                                |
| Overcurrent (OC) Fault                | $I_{TIMERUPFLT}$      | -57   | -60  | -63   | $\mu\text{A}$ | Overcurrent fault; $0.2\text{ V} \leq V_{TIMER} \leq 1\text{ V}$                                                                  |

| Parameter <sup>1</sup>           | Symbol                     | Min  | Typ | Max  | Unit          | Test Conditions/Comments                                                                                       |
|----------------------------------|----------------------------|------|-----|------|---------------|----------------------------------------------------------------------------------------------------------------|
| TIMER Pull-Down Current          |                            |      |     |      |               |                                                                                                                |
| Retry                            | $I_{\text{TIMERDNRT}}$     | 1.7  | 2   | 2.3  | $\mu\text{A}$ | After fault when GATE is off; $V_{\text{TIMER}} = 0.5\text{ V}$                                                |
| Hold                             | $I_{\text{TIMERDNHOLD}}$   |      | 100 |      | $\mu\text{A}$ | Holds TIMER at 0 V when inactive; $V_{\text{TIMER}} = 0.5\text{ V}$                                            |
| TIMER High Threshold             | $V_{\text{TIMERH}}$        | 0.98 | 1.0 | 1.02 | V             |                                                                                                                |
| TIMER Low Threshold              | $V_{\text{TIMERL}}$        | 0.18 | 0.2 | 0.22 | V             |                                                                                                                |
| TIMER Glitch Filter              | $\text{TIMER}_{\text{GF}}$ |      | 10  |      | $\mu\text{s}$ |                                                                                                                |
| Minimum POR Duration             |                            |      | 27  |      | ms            | Minimum initial insertion delay regardless of $C_{\text{TIMER}}$ value                                         |
| PSET PIN                         |                            |      |     |      |               | FET power limit = $(V_{\text{PSET}} \times 8)/(50 \times R_{\text{SENSE}})$                                    |
| Reference Select Threshold       | $V_{\text{PSETRSTH}}$      | 1.35 | 1.5 | 1.65 | V             | If $V_{\text{PSET}} > V_{\text{PSETRSTH}}$ , constant power is disabled                                        |
| Gain of Current Sense Amplifier  | $AV_{\text{CSAMP}}$        |      | 50  |      | V/V           | Accuracies included in total sense voltage accuracies                                                          |
| Input Current                    | $I_{\text{PSET}}$          |      |     | 100  | nA            | $V_{\text{PSET}} \leq V_{\text{VCAP}}$                                                                         |
| VOUT PIN                         |                            |      |     |      |               |                                                                                                                |
| Input Current                    |                            |      |     | 40   | $\mu\text{A}$ | $V_{\text{OUT}} = 20\text{ V}$                                                                                 |
| FAULT PIN                        |                            |      |     |      |               |                                                                                                                |
| Output Low Voltage               | $V_{\text{OL\_LATCH}}$     |      |     | 0.4  | V             | $I_{\text{FAULT}} = 1\text{ mA}$                                                                               |
|                                  |                            |      |     | 1.5  | V             | $I_{\text{FAULT}} = 5\text{ mA}$                                                                               |
| Leakage Current                  |                            |      |     | 100  | nA            | $V_{\text{FAULT}} \leq 2\text{ V}$ ; $\overline{\text{FAULT}}$ output high-Z                                   |
|                                  |                            |      |     | 1    | $\mu\text{A}$ | $V_{\text{FAULT}} = 20\text{ V}$ ; $\overline{\text{FAULT}}$ output high-Z                                     |
| ENABLE PIN                       |                            |      |     |      |               |                                                                                                                |
| Input High Voltage               | $V_{\text{IH}}$            | 1.1  |     |      | V             |                                                                                                                |
| Input Low Voltage                | $V_{\text{IL}}$            |      |     | 0.8  | V             |                                                                                                                |
| Glitch Filter                    |                            |      | 1   |      | $\mu\text{s}$ |                                                                                                                |
| RETRY PIN                        |                            |      |     |      |               |                                                                                                                |
| Input High Voltage               | $V_{\text{IH}}$            | 1.1  |     |      | V             | Latch off when high; internal pull-up sets this as default                                                     |
| Input Low Voltage                | $V_{\text{IL}}$            |      |     | 0.8  | V             | 10 second automatic retry when pin pulled low                                                                  |
| Glitch Filter                    |                            |      | 1   |      | $\mu\text{s}$ |                                                                                                                |
| Internal Pull-Up Current         |                            |      | 8   |      | $\mu\text{A}$ |                                                                                                                |
| CSOUT PIN                        |                            |      |     |      |               |                                                                                                                |
| CSOUT Gain                       |                            |      | 350 |      | V/V           | $\text{CSOUT} = V_{\text{SENSE\_HS}} \times 350$ ; $V_{\text{CC}} > \text{CSOUT} + 2\text{ V}$                 |
| Total Output Error               |                            | -1.6 |     | +1.6 | %             | $V_{\text{SENSE\_HS}} = 20\text{ mV}$ ; $I_{\text{CSOUT}} \leq 1\text{ mA}$ ; $C_{\text{CSOUT}} = 1\text{ nF}$ |
|                                  |                            | -3.0 |     | +3.0 | %             | $V_{\text{SENSE\_HS}} = 10\text{ mV}$ ; $I_{\text{CSOUT}} \leq 1\text{ mA}$ ; $C_{\text{CSOUT}} = 1\text{ nF}$ |
| Output Swing to GND              |                            |      | 40  |      | mV            |                                                                                                                |
| Current Limiting                 |                            |      | 5   |      | mA            | CSOUT short-circuit current                                                                                    |
| GPO1/ALERT1/CONV PIN             |                            |      |     |      |               |                                                                                                                |
| Output Low Voltage               | $V_{\text{OL\_GPO1}}$      |      |     | 0.4  | V             | $I_{\text{GPO1}} = 1\text{ mA}$                                                                                |
|                                  |                            |      |     | 1.5  | V             | $I_{\text{GPO1}} = 5\text{ mA}$                                                                                |
| Leakage Current                  |                            |      |     | 100  | nA            | $V_{\text{GPO1}} \leq 2\text{ V}$ ; GPO1 output high-Z                                                         |
|                                  |                            |      |     | 1    | $\mu\text{A}$ | $V_{\text{GPO1}} = 20\text{ V}$ ; GPO1 output high-Z                                                           |
| Input High Voltage               | $V_{\text{IH}}$            | 1.1  |     |      | V             | Configured as CONV                                                                                             |
| Input Low Voltage                | $V_{\text{IL}}$            |      |     | 0.8  | V             | Configured as CONV                                                                                             |
| Glitch Filter                    |                            |      | 1   |      | $\mu\text{s}$ | Configured as CONV                                                                                             |
| GPO2/ALERT2 PIN                  |                            |      |     |      |               |                                                                                                                |
| Output Low Voltage               | $V_{\text{OL\_GPO2}}$      |      |     | 0.4  | V             | $I_{\text{GPO2}} = 1\text{ mA}$                                                                                |
|                                  |                            |      |     | 1.5  | V             | $I_{\text{GPO2}} = 5\text{ mA}$                                                                                |
| Leakage Current                  |                            |      |     | 100  | nA            | $V_{\text{GPO2}} \leq 2\text{ V}$ ; GPO2 output high-Z                                                         |
|                                  |                            |      |     | 1    | $\mu\text{A}$ | $V_{\text{GPO2}} = 20\text{ V}$ ; GPO2 output high-Z                                                           |
| PWRGD PIN                        |                            |      |     |      |               |                                                                                                                |
| Output Low Voltage               | $V_{\text{OL\_PWRGD}}$     |      |     | 0.4  | V             | $I_{\text{PWRGD}} = 1\text{ mA}$                                                                               |
|                                  |                            |      |     | 1.5  | V             | $I_{\text{PWRGD}} = 5\text{ mA}$                                                                               |
| VCC That Guarantees Valid Output |                            | 1    |     |      | V             | $I_{\text{SINK}} = 100\text{ }\mu\text{A}$ ; $V_{\text{OL\_PWRGD}} = 0.4\text{ V}$                             |
| Leakage Current                  |                            |      |     | 100  | nA            | $V_{\text{PWRGD}} \leq 2\text{ V}$ ; PWRGD output high-Z                                                       |
|                                  |                            |      |     | 1    | $\mu\text{A}$ | $V_{\text{PWRGD}} = 20\text{ V}$ ; PWRGD output high-Z                                                         |

| Parameter <sup>1</sup>                                       | Symbol         | Min  | Typ     | Max      | Unit               | Test Conditions/Comments                                                                                            |
|--------------------------------------------------------------|----------------|------|---------|----------|--------------------|---------------------------------------------------------------------------------------------------------------------|
| PWGIN PIN                                                    |                |      |         |          |                    |                                                                                                                     |
| Input Current                                                | $I_{PWGIN}$    |      |         | 50       | nA                 | $PWGIN \leq 3.6\text{ V}$                                                                                           |
| PWGIN Threshold                                              | $PWGIN_{TH}$   |      |         |          |                    |                                                                                                                     |
| A Grade and AA Grade                                         |                | 0.99 | 1.0     | 1.01     | V                  | PWGIN falling                                                                                                       |
| B Grade Only                                                 |                | 0.97 | 1.0     | 1.03     | V                  | PWGIN falling                                                                                                       |
| PWGIN Threshold Hysteresis                                   | $PWGIN_{HYST}$ | 50   | 60      | 70       | mV                 |                                                                                                                     |
| Glitch Filter                                                |                |      | 1       |          | $\mu\text{s}$      | Asserting and deasserting of PWRGD pin                                                                              |
| CURRENT AND VOLTAGE MONITORING                               |                |      |         |          |                    | See Table 3 for power monitor accuracy specifications                                                               |
| ADC Conversion Time                                          |                |      | 144     | 165      | $\mu\text{s}$      | Includes time for power multiplication<br>One sample of $I_{OUT}$ ; from command received to valid data in register |
|                                                              |                |      | 64      | 73       | $\mu\text{s}$      | One sample of $V_{IN}$ ; from command received to valid data in register                                            |
|                                                              |                |      | 64      | 73       | $\mu\text{s}$      | One sample of $V_{OUT}$ ; from command received to valid data in register                                           |
| ADRx PINS                                                    |                |      |         |          |                    |                                                                                                                     |
| Address Set to 00                                            |                | 0    |         | 0.8      | V                  | Connect to GND                                                                                                      |
| Input Current for Address Set to 00                          |                | -40  | -22     |          | $\mu\text{A}$      | $V_{ADRx} = 0\text{ V to }0.8\text{ V}$                                                                             |
| Address Set to 01                                            |                | 135  | 150     | 165      | k $\Omega$         | Resistor to GND                                                                                                     |
| Address Set to 10                                            |                | -1   |         | +1       | $\mu\text{A}$      | No connect state; maximum leakage current allowed                                                                   |
| Address Set to 11                                            |                | 2    |         |          | V                  | Connect to VCAP                                                                                                     |
| Input Current for Address Set to 11                          |                |      | 3       | 10       | $\mu\text{A}$      | $V_{ADRx} = 2.0\text{ V to VCAP}$ ; must not exceed the maximum allowable current draw from VCAP                    |
| TEMP PIN                                                     |                |      |         |          |                    | External transistor is 2N3904                                                                                       |
| Operating Range                                              |                | -55  |         | +150     | $^{\circ}\text{C}$ | Limited by external diode                                                                                           |
| Accuracy                                                     |                |      | $\pm 1$ | $\pm 10$ | $^{\circ}\text{C}$ | $T_A = T_{DIODE} = -40^{\circ}\text{C to }+85^{\circ}\text{C}$                                                      |
| Resolution                                                   |                |      | 0.25    |          | $^{\circ}\text{C}$ | LSB size                                                                                                            |
| Output Current Source <sup>2</sup>                           |                |      |         |          |                    |                                                                                                                     |
| Low Level                                                    |                |      | 5       |          | $\mu\text{A}$      |                                                                                                                     |
| Medium Level                                                 |                |      | 30      |          | $\mu\text{A}$      |                                                                                                                     |
| High Level                                                   |                |      | 105     |          | $\mu\text{A}$      |                                                                                                                     |
| Maximum Series Resistance for External Diode <sup>2</sup>    | $R_S$          |      |         | 100      | $\Omega$           | For $\leq \pm 0.5^{\circ}\text{C}$ additional error, $C_P = 0\text{ F}$                                             |
| Maximum Parallel Capacitance for External Diode <sup>2</sup> | $C_P$          |      |         | 1        | nF                 | $R_S = 0\ \Omega$                                                                                                   |
| SPI DIGITAL INPUTS (SPI_SS, MCLK, MDAT)                      |                |      |         |          |                    | Compatible with SPI Mode 0; MDAT is the output data pin; output is high impedance when not transmitting             |
| Input High Voltage                                           | $V_{IH}$       | 2.0  |         |          | V                  |                                                                                                                     |
| Input Low Voltage                                            | $V_{IL}$       |      |         | 0.8      | V                  |                                                                                                                     |
| Output Low Voltage                                           | $V_{OL}$       |      |         | 0.4      | V                  | $I_{OL} = 4\text{ mA}$                                                                                              |
| Leakage Current                                              |                |      |         | 1        | $\mu\text{A}$      |                                                                                                                     |
| Data Rate                                                    |                |      |         | 1        | MHz                |                                                                                                                     |
| SERIAL BUS DIGITAL INPUTS (SDA, SCL)                         |                |      |         |          |                    |                                                                                                                     |
| Input High Voltage                                           | $V_{IH}$       | 1.1  |         |          | V                  |                                                                                                                     |
| Input Low Voltage                                            | $V_{IL}$       |      |         | 0.8      | V                  |                                                                                                                     |
| Output Low Voltage                                           | $V_{OL}$       |      |         | 0.4      | V                  | $I_{OL} = 4\text{ mA}$                                                                                              |
| Input Leakage                                                | $I_{LEAK-PIN}$ | -10  |         | +10      | $\mu\text{A}$      |                                                                                                                     |
|                                                              |                | -5   |         | +5       | $\mu\text{A}$      | Device is not powered                                                                                               |

| Parameter <sup>1</sup>        | Symbol           | Min | Typ | Max | Unit | Test Conditions/Comments |
|-------------------------------|------------------|-----|-----|-----|------|--------------------------|
| Nominal Bus Voltage           | V <sub>DD</sub>  | 2.7 |     | 5.5 | V    | 3 V to 5 V ± 10%         |
| Capacitance for SDA, SCL Pins | C <sub>PIN</sub> |     | 5   |     | pF   |                          |
| Input Glitch Filter           | t <sub>SP</sub>  | 0   |     | 50  | ns   |                          |

<sup>1</sup> Dual function pin names are referenced by the relevant function only (see the Pin Configurations and Function Descriptions section for full pin mnemonics and descriptions).

<sup>2</sup> Sampled during initial release to ensure compliance, but not subject to production testing.

## POWER MONITORING ACCURACY SPECIFICATIONS

Table 3.

| Parameter                      | AA Grade |       |       | A Grade |       |      | B Grade |     |      | Unit | Test Conditions/Comments                                                                                       |
|--------------------------------|----------|-------|-------|---------|-------|------|---------|-----|------|------|----------------------------------------------------------------------------------------------------------------|
|                                | Min      | Typ   | Max   | Min     | Typ   | Max  | Min     | Typ | Max  |      |                                                                                                                |
| CURRENT AND VOLTAGE MONITORING |          |       |       |         |       |      |         |     |      |      |                                                                                                                |
| Current Sense                  |          |       |       |         |       |      |         |     |      |      | V <sub>CC</sub> = 4.5 V to 15 V; V <sub>MO+</sub> = 2 V to 15 V, 128-sample averaging (unless otherwise noted) |
| Absolute Error                 |          |       | ±0.25 |         |       | ±0.7 |         |     | ±1.0 | %    | V <sub>SENSE_MO</sub> = 25 mV                                                                                  |
|                                |          | ±0.04 | ±0.3  |         | ±0.04 | ±0.7 |         |     | ±1.0 | %    | V <sub>SENSE_MO</sub> = 20 mV                                                                                  |
|                                |          |       | ±0.5  |         |       | ±1.0 |         |     | ±1.5 | %    | V <sub>SENSE_MO</sub> = 20 mV; 16-sample averaging                                                             |
|                                |          |       | ±1.5  |         |       | ±2.8 |         |     | ±4.0 | %    | V <sub>SENSE_MO</sub> = 20 mV; one-sample averaging                                                            |
|                                |          |       | ±0.3  |         |       | ±0.8 |         |     | ±1.1 | %    | V <sub>SENSE_MO</sub> = 15 mV                                                                                  |
|                                |          |       | ±0.4  |         |       | ±1.1 |         |     | ±1.5 | %    | V <sub>SENSE_MO</sub> = 10 mV                                                                                  |
|                                |          |       | ±0.75 |         |       | ±2.0 |         |     | ±3.0 | %    | V <sub>SENSE_MO</sub> = 5 mV                                                                                   |
|                                |          |       | ±1.6  |         |       | ±4.3 |         |     | ±6.2 | %    | V <sub>SENSE_MO</sub> = 2.5 mV                                                                                 |
| HS+/VOUT                       |          |       | ±0.35 |         |       | ±1.0 |         |     | ±1.5 | %    | V <sub>HS+</sub> , V <sub>OUT</sub> = 10 V to 20 V                                                             |
| Absolute Error                 |          |       |       |         |       |      |         |     |      |      |                                                                                                                |
|                                |          |       | ±0.5  |         |       | ±1.0 |         |     | ±1.5 | %    | V <sub>HS+</sub> , V <sub>OUT</sub> = 5 V                                                                      |
| Power Absolute Error           |          |       | ±0.65 |         |       | ±1.7 |         |     | ±2.5 | %    | V <sub>SENSE_MO</sub> = 20 mV, V <sub>HS+</sub> = 12 V                                                         |

## SERIAL BUS TIMING CHARACTERISTICS

Table 4.

| Parameter                   | Description        | Min | Typ | Max | Unit |
|-----------------------------|--------------------|-----|-----|-----|------|
| f <sub>SCLK</sub>           | Clock frequency    |     |     | 400 | kHz  |
| t <sub>BUF</sub>            | Bus free time      | 1.3 |     |     | μs   |
| t <sub>HD;STA</sub>         | Start hold time    | 0.6 |     |     | μs   |
| t <sub>SU;STA</sub>         | Start setup time   | 0.6 |     |     | μs   |
| t <sub>SU;STO</sub>         | Stop setup time    | 0.6 |     |     | μs   |
| t <sub>HD;DAT</sub>         | SDA hold time      | 300 |     | 900 | ns   |
| t <sub>SU;DAT</sub>         | SDA setup time     | 100 |     |     | ns   |
| t <sub>LOW</sub>            | SCL low time       | 1.3 |     |     | μs   |
| t <sub>HIGH</sub>           | SCL high time      | 0.6 |     |     | μs   |
| t <sub>R</sub> <sup>1</sup> | SCL, SDA rise time | 20  |     | 300 | ns   |
| t <sub>F</sub> <sup>1</sup> | SCL, SDA fall time | 20  |     | 300 | ns   |

<sup>1</sup> t<sub>R</sub> = (V<sub>IL(MAX)</sub> - 0.15) to (V<sub>IH3V3</sub> + 0.15) and t<sub>F</sub> = 0.9 V<sub>DD</sub> to (V<sub>IL(MAX)</sub> - 0.15); where V<sub>IH3V3</sub> = 2.1 V, and V<sub>DD</sub> = 3.3 V. V<sub>IH3V3</sub> is the input high voltage when V<sub>DD</sub> = 3.3 V.

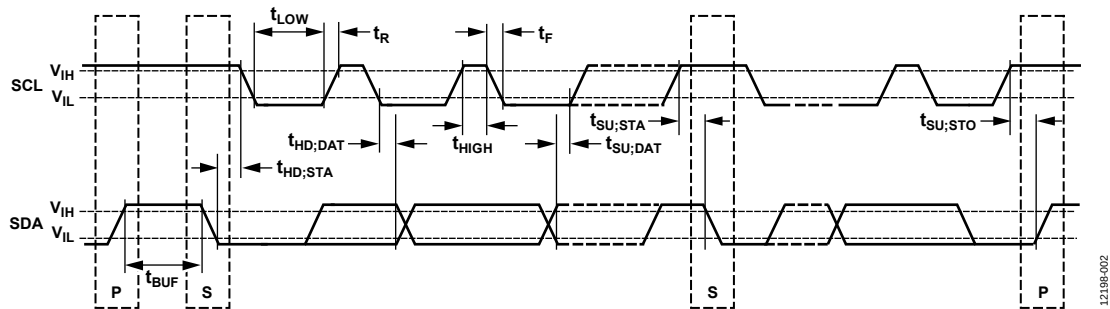


Figure 2. Serial Bus Timing Diagram

12198-002

## SPI TIMING CHARACTERISTICS (ADM1278-2)

Table 5.

| Parameter    | Description                                                | Min | Typ | Max | Unit    | Test Conditions/Comments                    |
|--------------|------------------------------------------------------------|-----|-----|-----|---------|---------------------------------------------|
| $t_s^1$      | SPI_SS falling edge to MCLK rising edge setup time         | 50  |     |     | ns      |                                             |
| $t_{HIGH}^1$ | MCLK high time                                             | 180 |     |     | ns      |                                             |
| $t_{LOW}^1$  | MCLK low time                                              | 180 |     |     | ns      |                                             |
| $t_{CLK}^1$  | MCLK cycle time                                            | 1   |     |     | $\mu s$ |                                             |
| $t_H^1$      | Hold time between $\overline{SPI\_SS}$ and MCLK            | 1   |     |     | $\mu s$ |                                             |
| $t_v$        | Hold time between new data valid and MCLK falling edge     | 110 |     | 260 | ns      | Track capacitance = 120 pF; $I_{OL} = 4$ mA |
| $t_{ON}$     | $\overline{SPI\_SS}$ falling edge to MDAT active time      | 130 |     | 240 | ns      | Track capacitance = 120 pF; $I_{OL} = 4$ mA |
| $t_{OFF}$    | Bus relinquish time after $\overline{SPI\_SS}$ rising edge | 130 |     | 280 | ns      | Track capacitance = 120 pF; $I_{OL} = 4$ mA |

<sup>1</sup> Guaranteed by design, but not production tested.

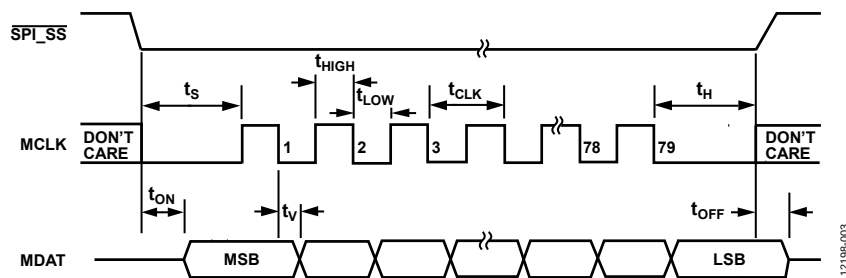


Figure 3. SPI Timing Diagram

12198-003

## ABSOLUTE MAXIMUM RATINGS

Table 6.

| Parameter                                                    | Rating                 |
|--------------------------------------------------------------|------------------------|
| VCC Pin                                                      | −0.3 V to +25 V        |
| UV Pin                                                       | −0.3 V to +4 V         |
| OV Pin                                                       | −0.3 V to +4 V         |
| ISTART Pin                                                   | −0.3 V to +4 V         |
| TIMER Pin                                                    | −0.3 V to VCAP + 0.3 V |
| TEMP Pin                                                     | −0.3 V to VCAP + 0.3 V |
| VCAP Pin                                                     | −0.3 V to +4 V         |
| ISSET Pin                                                    | −0.3 V to +4 V         |
| PSET Pin                                                     | −0.3 V to +4 V         |
| FAULT Pin                                                    | −0.3 V to +25 V        |
| RETRY Pin                                                    | −0.3 V to +4 V         |
| PWGIN Pin                                                    | −0.3 V to +4 V         |
| SCL Pin                                                      | −0.3 V to +6.5 V       |
| SDA Pin                                                      | −0.3 V to +6.5 V       |
| SPI_SS Pin                                                   | −0.3 V to +4 V         |
| MCLK Pin                                                     | −0.3 V to +4 V         |
| MDAT Pin                                                     | −0.3 V to +4 V         |
| ADR1 Pin                                                     | −0.3 V to +6.5 V       |
| ADR2 Pin                                                     | −0.3 V to +6.5 V       |
| ENABLE Pin                                                   | −0.3 V to +25 V        |
| GPO1/ALERT1/CONV Pin                                         | −0.3 V to +25 V        |
| GPO2/ALERT2 Pin                                              | −0.3 V to +25 V        |
| PWRGD Pin                                                    | −0.3 V to +25 V        |
| VOOUT Pin                                                    | −0.3 V to +25 V        |
| GATE Pin (Internal Supply Only) <sup>1</sup>                 | −0.3 V to +36 V        |
| HS+ Pin                                                      | −0.3 V to +25 V        |
| HS− Pin                                                      | −0.3 V to +25 V        |
| MO+ Pin                                                      | −0.3 V to +25 V        |
| MO− Pin                                                      | −0.3 V to +25 V        |
| PGND                                                         | ±0.3 V                 |
| V <sub>SENSE_HS</sub> (V <sub>HS+</sub> − V <sub>HS−</sub> ) | ±0.3 V                 |
| V <sub>SENSE_MO</sub> (V <sub>MO+</sub> − V <sub>MO−</sub> ) | ±0.3 V                 |
| CSOUT Short-Circuit Duration                                 | Indefinite             |
| Continuous Current into Any Pin                              | ±10 mA                 |
| Storage Temperature Range                                    | −65°C to +125°C        |
| Operating Temperature Range                                  | −40°C to +85°C         |
| Lead Temperature, Soldering (10 sec)                         | 300°C                  |
| Junction Temperature                                         | 105°C                  |

<sup>1</sup> The GATE pin has internal clamping circuits to prevent the GATE pin voltage from exceeding the maximum ratings of a MOSFET with gain to source voltage, V<sub>GSMAX</sub> = 20 V, and internal process limits. Applying a voltage source to this pin externally may cause irreversible damage.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### THERMAL CHARACTERISTICS

θ<sub>JA</sub> is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 7. Thermal Resistance

| Package Type | θ <sub>JA</sub> | Unit |
|--------------|-----------------|------|
| CP-32-13     | 32.5            | °C/W |

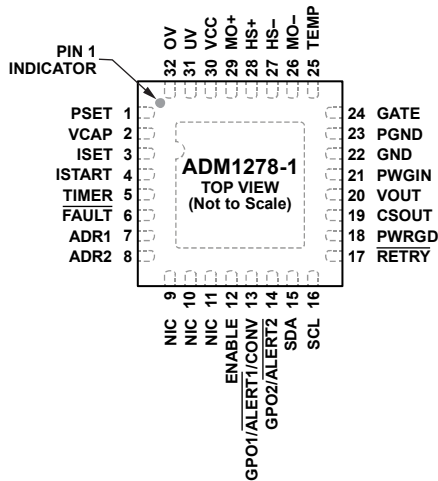
### ESD CAUTION



#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

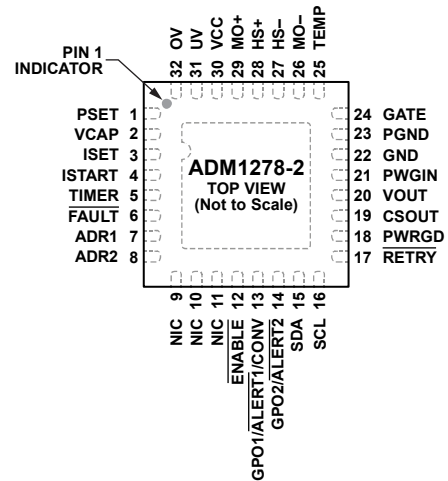


## NOTES

1. NIC = NOT INTERNALLY CONNECTED.
2. SOLDER THE EXPOSED PAD TO THE BOARD TO IMPROVE THERMAL DISSIPATION. THE EXPOSED PAD CAN BE CONNECTED TO GROUND.

Figure 4. ADM1278-1 Pin Configuration

12198-004



## NOTES

1. NIC = NOT INTERNALLY CONNECTED.
2. SOLDER THE EXPOSED PAD TO THE BOARD TO IMPROVE THERMAL DISSIPATION. THE EXPOSED PAD CAN BE CONNECTED TO GROUND.

Figure 5. ADM1278-3 Pin Configuration

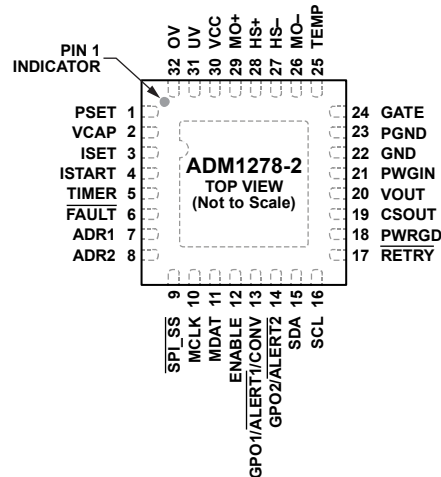
12198-106

Table 8. ADM1278-1 and ADM1278-3 Pin Function Descriptions

| Pin No.   | Mnemonic   |            | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|-----------|------------|------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|           | ADM1278-1  | ADM1278-3  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| 1         | PSET       | PSET       | Power Limit. This pin allows the constant power limit to be programmed. The current limit is dynamically adjusted to ensure that the maximum power dissipation in the FET never exceeds this limit during any operating condition. The power limit can be adjusted to a user defined value using a resistor divider from VCAP. An external reference can also be used. The FET power is limited to $(V_{PSET} \times 8)/(50 \times R_{SENSE})$ .                                                                                                                                                                                                                                    |
| 2         | VCAP       | VCAP       | Internal Regulated Supply. Place a capacitor with a value of 1 $\mu$ F or greater on this pin to maintain accuracy. This pin can be used as a reference to program the ISET pin voltage.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 3         | ISET       | ISET       | Current Limit. This pin allows the current-limit threshold to be programmed. The default limit is set when this pin is connected directly to VCAP. To achieve a user defined sense voltage, the current limit can be adjusted using a resistor divider from VCAP. An external reference can also be used.                                                                                                                                                                                                                                                                                                                                                                           |
| 4         | ISTART     | ISTART     | Start-Up Current Limit. This pin allows a separate start-up current limit to be set for dv/dt power-up mode. When powering up in dv/dt mode, the current charging the capacitor is constant and is typically much smaller than the normal load current. The ISTART pin sets the start-up current limit in a similar manner as ISET is used to set the normal current limit. The start-up current limit is only active while PWRGD is low. The start-up current limit can also be set over PMBus with the STRT_UP_IOUT_LIM register. Start-up current limit = $V_{ISET} \times (\text{STRT\_UP\_IOUT\_LIM}/16)$ . The lowest of all the active current limits always takes priority. |
| 5         | TIMER      | TIMER      | Timer. An external capacitor, $C_{TIMER}$ , sets an initial timing cycle delay and a fault delay. The GATE pin is pulled low when the voltage on the TIMER pin exceeds the upper threshold.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 6         | FAULT      | FAULT      | Fault. This pin asserts low and latches after a fault has occurred. The faults that can trigger this pin include an overcurrent fault resulting in the TIMER pin voltage exceeding the upper threshold, an overtemperature fault, and an FET health fault. This is an open-drain output pin.                                                                                                                                                                                                                                                                                                                                                                                        |
| 7, 8      | ADR1, ADR2 | ADR1, ADR2 | PMBus Address. These pins can be tied to GND, tied to VCAP, left floating, or tied low through a resistor for a total of 16 unique PMBus device addresses (see the Device Addressing section).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 9, 10, 11 | NIC        | NIC        | Not Internally Connected.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |

| Pin No. | Mnemonic                                   |                                            | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|---------|--------------------------------------------|--------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         | ADM1278-1                                  | ADM1278-3                                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 12      | ENABLE                                     | ENABLE                                     | Enable. On the <a href="#">ADM1278-1</a> , the ENABLE pin is an active high digital input pin. This input must be high to allow the <a href="#">ADM1278-1</a> hot swap controller to begin a power-up sequence. If the ENABLE pin is held low, the <a href="#">ADM1278-1</a> is prevented from initiating a hot swap attempt. On the <a href="#">ADM1278-3</a> , the $\overline{\text{ENABLE}}$ pin is an active low digital input pin. This input must be low to allow the <a href="#">ADM1278-3</a> hot swap controller to begin a power-up sequence. If the $\overline{\text{ENABLE}}$ pin is held high, the <a href="#">ADM1278-3</a> is prevented from initiating a hot swap attempt. |
| 13      | GPO1/ $\overline{\text{ALERT1}}$ /<br>CONV | GPO1/ $\overline{\text{ALERT1}}$ /<br>CONV | General-Purpose Digital Output (GPO1).<br>Alert ( $\overline{\text{ALERT1}}$ ). This pin can be configured to generate an alert signal when one or more fault or warning conditions are detected.<br>Conversion (CONV). This pin can be used as an input signal to control when a power monitor ADC sampling cycle begins.<br>The GPO1/ $\overline{\text{ALERT1}}$ /CONV pin defaults to an alert output at power-up. This is an open-drain output pin.                                                                                                                                                                                                                                    |
| 14      | GPO2/ $\overline{\text{ALERT2}}$           | GPO2/ $\overline{\text{ALERT2}}$           | General-Purpose Digital Output (GPO2).<br>Alert ( $\overline{\text{ALERT2}}$ ). This pin can be configured to generate an alert signal when one or more fault or warning conditions are detected.<br>The GPO2/ $\overline{\text{ALERT2}}$ pin defaults to an alert output at power-up. This is an open-drain output pin.                                                                                                                                                                                                                                                                                                                                                                   |
| 15      | SDA                                        | SDA                                        | Serial Data Input/Output. Open-drain input/output. Requires an external pull-up resistor. If the I <sup>2</sup> C pins, SDA and SCL, are not used, tie them to GND or via a resistor pull-up to VCAP or another supply. This avoids any glitches on the I <sup>2</sup> C pins being interpreted as I <sup>2</sup> C transactions.                                                                                                                                                                                                                                                                                                                                                          |
| 16      | SCL                                        | SCL                                        | Serial Clock. Open-drain input. Requires an external pull-up resistor. If the I <sup>2</sup> C pins, SDA and SCL, are not used, tie them to GND or via a pull-up resistor to VCAP or another supply. This avoids any glitches on the I <sup>2</sup> C pins being interpreted as I <sup>2</sup> C transactions.                                                                                                                                                                                                                                                                                                                                                                             |
| 17      | $\overline{\text{RETRY}}$                  | $\overline{\text{RETRY}}$                  | Retry. The $\overline{\text{RETRY}}$ pin has an internal pull-up resistor; therefore, it can be left floating to enable the default latch off mode after an overcurrent fault. This pin can be pulled low to enable a 10 second autoretry following an overcurrent fault.                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 18      | PWRGD                                      | PWRGD                                      | Power-Good Signal. This pin indicates that the supply is within tolerance (PWGIN input), no faults have been detected, and the <a href="#">ADM1278-1</a> hot swap is enabled with the gate fully enhanced. This is an open-drain output pin.                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 19      | CSOUT                                      | CSOUT                                      | Current Sense Output. The $V_{\text{SENSE\_HS}}$ voltage is amplified to give an output voltage corresponding to the load current.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 20      | VOUT                                       | VOUT                                       | Output Voltage. VOUT is an input pin and is used to read back the output voltage using the internal ADC. Insert a 1 k $\Omega$ resistor in series between the source of a FET and the VOUT pin. This pin is also used along with HS– to calculate the drain to source voltage ( $V_{\text{DS}}$ ) of the FET for constant power foldback operation.                                                                                                                                                                                                                                                                                                                                        |
| 21      | PWGIN                                      | PWGIN                                      | Power-Good Input. This pin sets the power-good input threshold. The user can set an accurate power-good threshold with a resistor divider from the source of the FET (VOUT). The PWRGD output signal is not asserted high until the output voltage is above the threshold set by this pin.                                                                                                                                                                                                                                                                                                                                                                                                 |
| 22      | GND                                        | GND                                        | Ground. This pin is the ground connection for all of the sensitive analog nodes. Take care to isolate this ground connection from the main high current path and any large transients. A good technique for this is to create a ground island around the <a href="#">ADM1278-1</a> device and the supporting small signal components. Connect this ground island to the main ground plane at a single point as close to the <a href="#">ADM1278-1</a> GND pin as possible. See the <a href="#">ADM1278</a> evaluation board ( <a href="#">EVAL-ADM1278EBZ</a> ) as an example.                                                                                                             |
| 23      | PGND                                       | PGND                                       | Power Ground. This pin is the ground return path for the strong gate pull-down current. It is also the ground return for the external transistor used for temperature measurements.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 24      | GATE                                       | GATE                                       | Gate Output. This pin is the high-side gate drive of an external N-channel FET. This pin is driven by the FET drive controller, which uses a charge pump to provide a pull-up current to charge the FET gate pin. The FET drive controller regulates to a maximum load current by regulating the GATE pin. GATE is held low when the supply is below the undervoltage lockout threshold (UVLO).                                                                                                                                                                                                                                                                                            |
| 25      | TEMP                                       | TEMP                                       | Temperature Input. An external NPN device can be placed close to the MOSFETs and connected back to the TEMP pin to report temperature. The voltage at the TEMP pin is measured by the internal ADC.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |

| Pin No. | Mnemonic  |           | Description                                                                                                                                                                                                                                                                                                                                                                          |
|---------|-----------|-----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         | ADM1278-1 | ADM1278-3 |                                                                                                                                                                                                                                                                                                                                                                                      |
| 26      | MO–       | MO–       | Negative Power Monitor Input. A sense resistor between the MO+ pin and the MO– pin sets the sense voltage that is used by the ADC internally to measure load current. Extra filtering can be added between the MO+ and MO– pins if required.                                                                                                                                         |
| 27      | HS–       | HS–       | Negative Current Sense Input. A sense resistor between the HS+ pin and the HS– pin sets the analog current limit. The hot swap operation of the <a href="#">ADM1278-1</a> controls the external FET gate to maintain the sense voltage ( $V_{HS+} - V_{HS-}$ ).                                                                                                                      |
| 28      | HS+       | HS+       | Positive Current Sense Input. This pin connects to the main supply input. A sense resistor between the HS+ pin and the HS– pin sets the analog current limit. The hot swap operation of the <a href="#">ADM1278-1</a> controls the external FET gate to maintain the sense voltage ( $V_{HS+} - V_{HS-}$ ). This pin is also used to measure the supply input voltage using the ADC. |
| 29      | MO+       | MO+       | Positive Power Monitor Input. A sense resistor between the MO+ pin and the MO– pin sets the sense voltage that is used by the ADC internally to measure load current. Extra filtering can be added between the MO+ and MO– pins if required.                                                                                                                                         |
| 30      | VCC       | VCC       | Positive Supply Input. A UVLO circuit resets the device when a low supply voltage is detected. GATE is held low when the supply is below UVLO. During normal operation, it is recommended that this pin be greater than or equal to HS+ and MO+ to ensure that specifications are adhered to. No sequencing is required.                                                             |
| 31      | UV        | UV        | Undervoltage Input. An external resistor divider is configured from the input supply to this pin to allow an internal comparator to detect whether the supply is below the UV limit.                                                                                                                                                                                                 |
| 32      | OV        | OV        | Overvoltage Input. An external resistor divider is configured from the input supply to this pin to allow an internal comparator to detect whether the supply is above the OV limit.                                                                                                                                                                                                  |
|         | EPAD      | EPAD      | Exposed Pad. Solder the exposed pad to the board to improve thermal dissipation. The exposed pad can be connected to ground.                                                                                                                                                                                                                                                         |



NOTES  
1. SOLDER THE EXPOSED PAD TO THE BOARD TO IMPROVE THERMAL DISSIPATION. THE EXPOSED PAD CAN BE CONNECTED TO GROUND.

12198-105

Figure 6. ADM1278-2 Pin Configuration

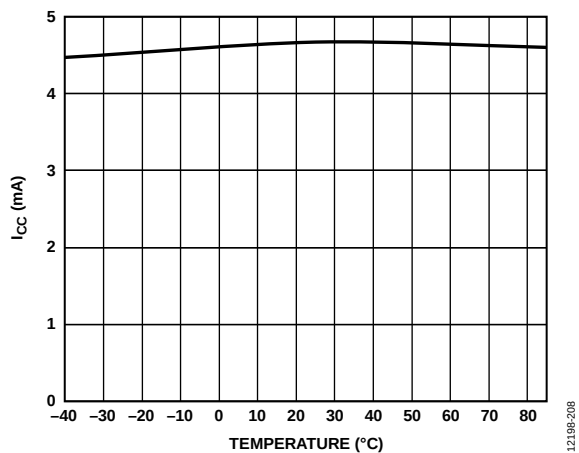
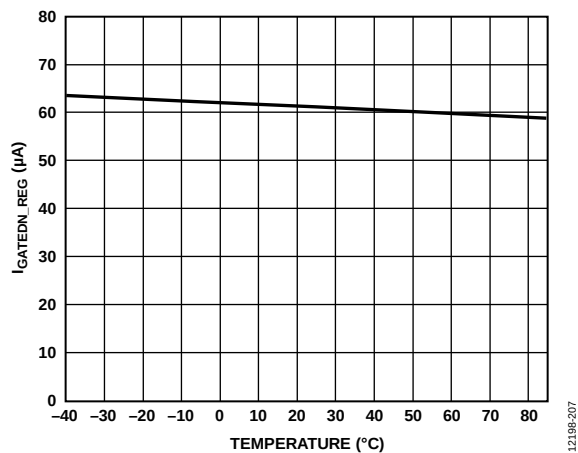
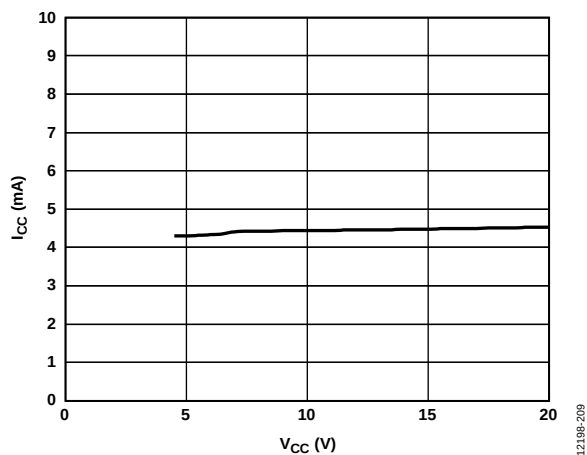
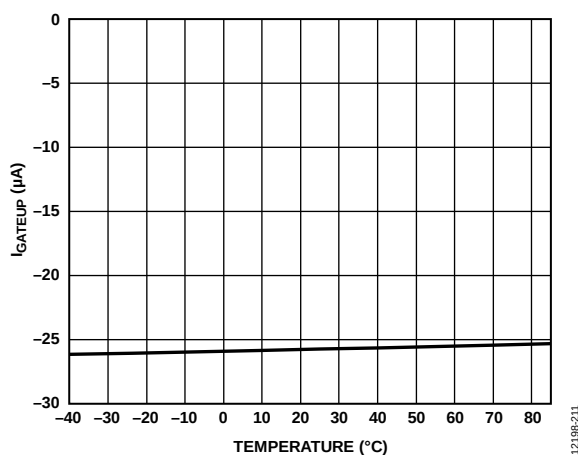
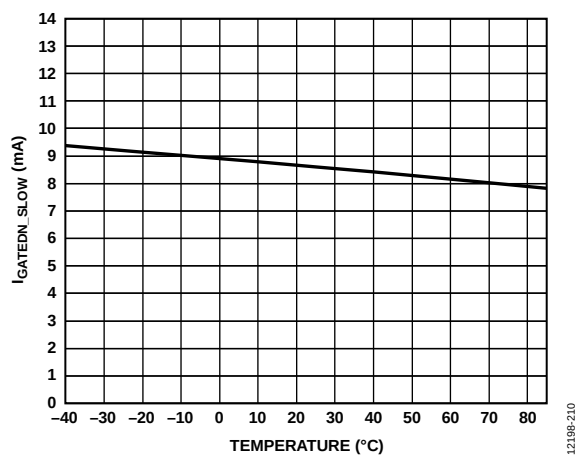
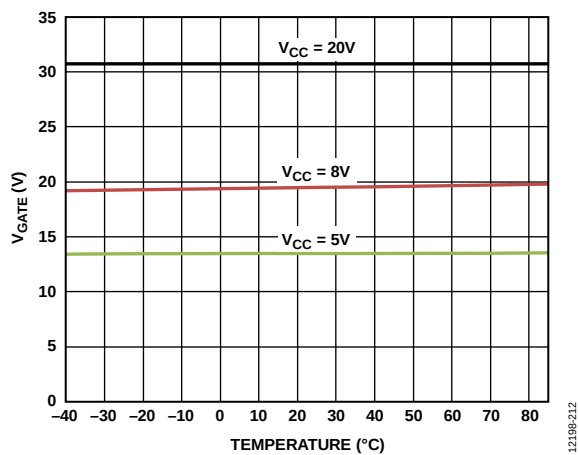
Table 9. ADM1278-2 Pin Function Descriptions

| Pin No. | Mnemonic                    | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|---------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1       | PSET                        | Power Limit. This pin allows the constant power limit to be programmed. The current limit is dynamically adjusted to ensure that the maximum power dissipation in the FET never exceeds this limit during any operating condition. The power limit can be adjusted to a user defined value using a resistor divider from VCAP. An external reference can also be used. The FET power is limited to $(V_{PSET} \times 8)/(50 \times R_{SENSE})$ .                                                                                                                                                                                                                                    |
| 2       | VCAP                        | Internal Regulated Supply. Place a capacitor with a value of 1 $\mu$ F or greater on this pin to maintain accuracy. This pin can be used as a reference to program the ISET pin voltage.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 3       | ISET                        | Current Limit. This pin allows the current-limit threshold to be programmed. The default limit is set when this pin is connected directly to VCAP. To achieve a user defined sense voltage, the current limit can be adjusted using a resistor divider from VCAP. An external reference can also be used.                                                                                                                                                                                                                                                                                                                                                                           |
| 4       | ISTART                      | Start-Up Current Limit. This pin allows a separate start-up current limit to be set for dv/dt power-up mode. When powering up in dv/dt mode, the current charging the capacitor is constant and is typically much smaller than the normal load current. The ISTART pin sets the start-up current limit in a similar manner as ISET is used to set the normal current limit. The start-up current limit is only active while PWRGD is low. The start-up current limit can also be set over PMBus with the STRT_UP_IOUT_LIM register. Start-up current limit = $V_{ISET} \times (\text{STRT\_UP\_IOUT\_LIM}/16)$ . The lowest of all the active current limits always takes priority. |
| 5       | TIMER                       | Timer. An external capacitor, $C_{TIMER}$ , sets an initial timing cycle delay and a fault delay. The GATE pin is pulled low when the voltage on the TIMER pin exceeds the upper threshold.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 6       | FAULT                       | Fault. This pin asserts low and latches after a fault has occurred. The faults that can trigger this pin include an overcurrent fault resulting in the TIMER pin voltage exceeding the upper threshold, an overtemperature fault, and an FET health fault. This is an open-drain output pin.                                                                                                                                                                                                                                                                                                                                                                                        |
| 7, 8    | ADR1, ADR2                  | PMBus Address. These pins can be tied to GND, tied to VCAP, left floating, or tied low through a resistor for a total of 16 unique PMBus device addresses (see the Device Addressing section).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 9       | $\overline{\text{SPI\_SS}}$ | Slave Select. When pulled low, this pin begins to transfer data on the MDAT line.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 10      | MCLK                        | Master Clock. The MCLK signal outputs data on the MDAT line. This pin is clocked by an external device.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 11      | MDAT                        | Master Data Output. Open-drain output. Requires an external pull-up resistor. The MDAT pin is an output only pin and can be used to stream data from the ADC. There is a fixed format for the current, voltage, and temperature data, and no header information is required. This pin is high impedance when not transmitting data.                                                                                                                                                                                                                                                                                                                                                 |
| 12      | ENABLE                      | Enable. This pin is an active high digital input pin. This input must be high to allow the ADM1278-2 hot swap controller to begin a power-up sequence. If this pin is held low, the ADM1278-2 is prevented from initiating a hot swap attempt.                                                                                                                                                                                                                                                                                                                                                                                                                                      |

| Pin No. | Mnemonic                  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|---------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 13      | GPO1/ <u>ALERT1</u> /CONV | General-Purpose Digital Output (GPO1).<br>Alert ( <u>ALERT1</u> ). This pin can be configured to generate an alert signal when one or more fault or warning conditions are detected.<br>Conversion (CONV). This pin can be used as an input signal to control when a power monitor ADC sampling cycle begins.<br>The GPO1/ <u>ALERT1</u> /CONV pin defaults to an alert output at power-up. This is an open-drain output pin.                                                                                                                                                  |
| 14      | GPO2/ <u>ALERT2</u>       | General-Purpose Digital Output (GPO2).<br>Alert ( <u>ALERT2</u> ). This pin can be configured to generate an alert signal when one or more fault or warning conditions are detected.<br>The GPO2/ <u>ALERT2</u> pin defaults to an alert output at power-up. This is an open-drain output pin.                                                                                                                                                                                                                                                                                 |
| 15      | SDA                       | Serial Data Input/Output. Open-drain input/output. Requires an external pull-up resistor. If the I <sup>2</sup> C pins, SDA and SCL, are not used, tie them to GND or via a resistor pull-up to VCAP or another supply. This avoids any glitches on the I <sup>2</sup> C pins being interpreted as I <sup>2</sup> C transactions.                                                                                                                                                                                                                                              |
| 16      | SCL                       | Serial Clock. Open-drain input. Requires an external pull-up resistor. If the I <sup>2</sup> C pins, SDA and SCL, are not used, tie them to GND or via a resistor pull-up to VCAP or another supply. This avoids any glitches on the I <sup>2</sup> C pins being interpreted as I <sup>2</sup> C transactions.                                                                                                                                                                                                                                                                 |
| 17      | <u>RETRY</u>              | Retry. The <u>RETRY</u> pin has an internal pull-up resistor; therefore, it can be left floating to enable the default latch off mode after an overcurrent fault. This pin can be pulled low to enable a 10 second autoretry following an overcurrent fault.                                                                                                                                                                                                                                                                                                                   |
| 18      | PWRGD                     | Power-Good Signal. This pin indicates that the supply is within tolerance (PWGIN input), no faults have been detected, and the <a href="#">ADM1278-2</a> hot swap is enabled with the gate fully enhanced. This is an open drain output pin.                                                                                                                                                                                                                                                                                                                                   |
| 19      | CSOUT                     | Current Sense Output. The V <sub>SENSE_HS</sub> voltage is amplified to give an output voltage corresponding to the load current.                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 20      | VOUT                      | Output Voltage. VOUT is an input pin and is used to read back the output voltage using the internal ADC. Insert a 1 kΩ resistor in series between the source of a FET and the VOUT pin. This pin is also used along with HS– to calculate the drain to source voltage (V <sub>DS</sub> ) of the FET for constant power foldback operation.                                                                                                                                                                                                                                     |
| 21      | PWGIN                     | Power-Good Input. This pin sets the power-good input threshold. The user can set an accurate power-good threshold with a resistor divider from the source of the FET (VOUT). The PWRGD output signal is not asserted high until the output voltage is above the threshold set by this pin.                                                                                                                                                                                                                                                                                     |
| 22      | GND                       | Ground. This pin is the ground connection for all of the sensitive analog nodes. Take care to isolate this ground connection from the main high current path and any large transients. A good technique for this is to create a ground island around the <a href="#">ADM1278-2</a> device and the supporting small signal components. Connect this ground island to the main ground plane at a single point as close to the <a href="#">ADM1278-2</a> GND pin as possible. See the <a href="#">ADM1278</a> evaluation board ( <a href="#">EVAL-ADM1278EBZ</a> ) as an example. |
| 23      | PGND                      | Power Ground. This is the ground return path for the strong gate pull-down current. It is also the ground return for the external transistor used for temperature measurements.                                                                                                                                                                                                                                                                                                                                                                                                |
| 24      | GATE                      | Gate Output. This pin is the high-side gate drive of an external N-channel FET. This pin is driven by the FET drive controller, which uses a charge pump to provide a pull-up current to charge the FET gate pin. The FET drive controller regulates to a maximum load current by regulating the GATE pin. GATE is held low when the supply is below the UVLO threshold.                                                                                                                                                                                                       |
| 25      | TEMP                      | Temperature Input. An external NPN device can be placed close to the MOSFETs and connected back to the TEMP pin to report temperature. The voltage at the TEMP pin is measured by the internal ADC.                                                                                                                                                                                                                                                                                                                                                                            |
| 26      | MO–                       | Negative Power Monitor Input. A sense resistor between the MO+ pin and the MO– pin sets the sense voltage that is used by the ADC internally to measure load current. Extra filtering can be added between the MO+ and MO– pins if required.                                                                                                                                                                                                                                                                                                                                   |
| 27      | HS–                       | Negative Current Sense Input. A sense resistor between the HS+ pin and the HS– pin sets the analog current limit. The hot swap operation of the <a href="#">ADM1278-2</a> controls the external FET gate to maintain the sense voltage (V <sub>HS+</sub> – V <sub>HS–</sub> ).                                                                                                                                                                                                                                                                                                 |
| 28      | HS+                       | Positive Current Sense Input. This pin connects to the main supply input. A sense resistor between the HS+ pin and the HS– pin sets the analog current limit. The hot swap operation of the <a href="#">ADM1278-2</a> controls the external FET gate to maintain the sense voltage (V <sub>HS+</sub> – V <sub>HS–</sub> ). This pin is also used to measure the supply input voltage using the ADC.                                                                                                                                                                            |
| 29      | MO+                       | Positive Power Monitor Input. A sense resistor between the MO+ pin and the MO– pin sets the sense voltage that is used by the ADC internally to measure load current. Extra filtering can be added between the MO+ and MO– pins if required.                                                                                                                                                                                                                                                                                                                                   |

| Pin No. | Mnemonic | Description                                                                                                                                                                                                                                                                                                              |
|---------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 30      | VCC      | Positive Supply Input. A UVLO circuit resets the device when a low supply voltage is detected. GATE is held low when the supply is below UVLO. During normal operation, it is recommended that this pin be greater than or equal to HS+ and MO+ to ensure that specifications are adhered to. No sequencing is required. |
| 31      | UV       | Undervoltage Input. An external resistor divider is configured from the input supply to this pin to allow an internal comparator to detect whether the supply is below the UV limit.                                                                                                                                     |
| 32      | OV       | Overvoltage Input. An external resistor divider is configured from the input supply to this pin to allow an internal comparator to detect whether the supply is above the OV limit.                                                                                                                                      |
|         | EPAD     | Exposed Pad. Solder the exposed pad to the board to improve thermal dissipation. The exposed pad can be connected to ground.                                                                                                                                                                                             |

## TYPICAL PERFORMANCE CHARACTERISTICS

Figure 7. Supply Current ( $I_{CC}$ ) vs. TemperatureFigure 10. GATE Pull-Down Current ( $I_{GATEDN\_REG}$ ) vs. TemperatureFigure 8. Supply Current ( $I_{CC}$ ) vs.  $V_{CC}$ Figure 11. GATE Pull-Up Current ( $I_{GATEUP}$ ) vs. TemperatureFigure 9. GATE Pull-Down Current ( $I_{GATEDN\_SLOW}$ ) vs. TemperatureFigure 12.  $V_{GATE}$  (5 µA Load) vs. Temperature

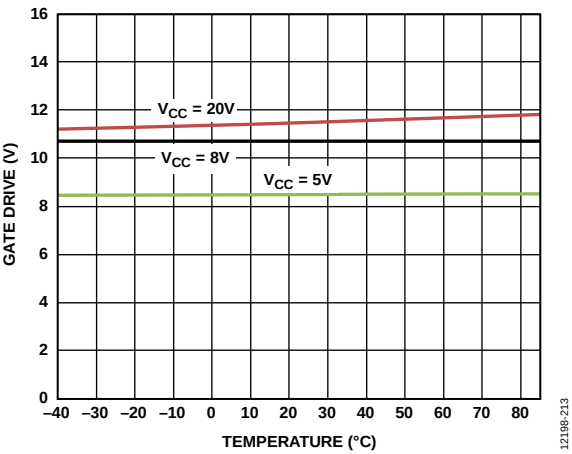


Figure 13. GATE Drive (5  $\mu$ A Load) vs. Temperature

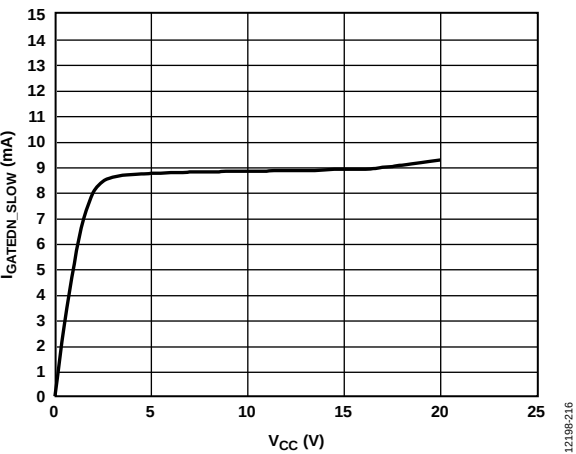


Figure 16. I<sub>GATEDN\_SLOW</sub> vs. V<sub>CC</sub>

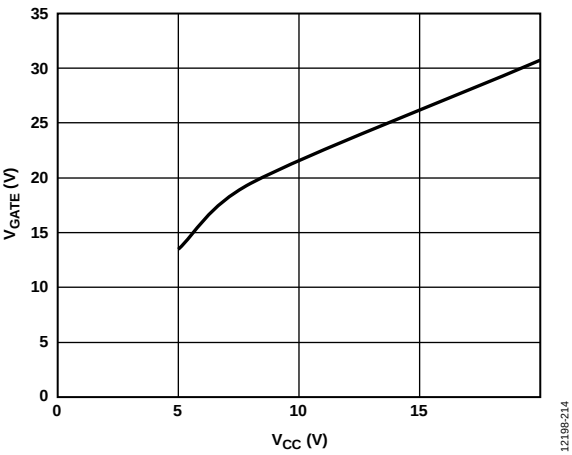


Figure 14. V<sub>GATE</sub> (5  $\mu$ A Load) vs. V<sub>CC</sub>

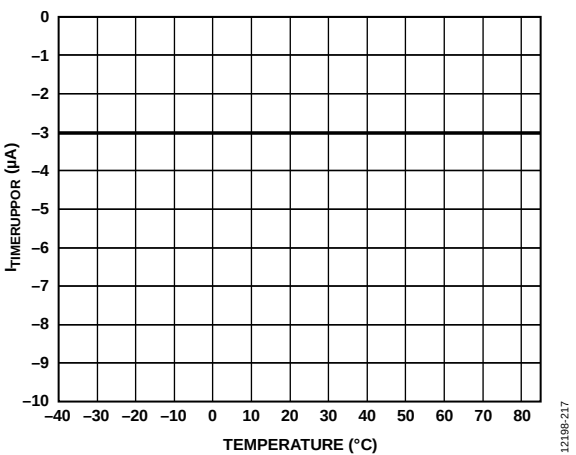


Figure 17. TIMER Pull-Up Current POR (I<sub>TIMERUPPOR</sub>) vs. Temperature

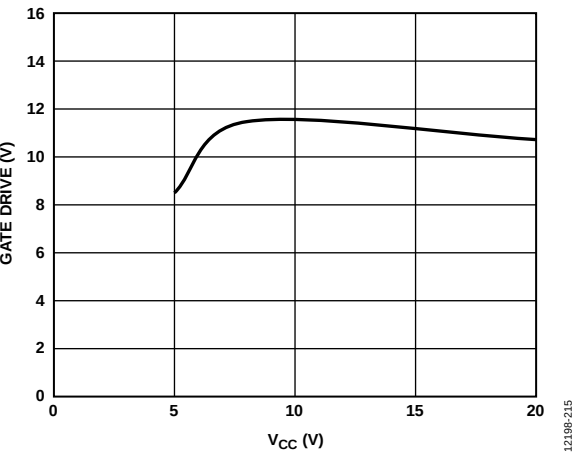


Figure 15. GATE Drive vs. V<sub>CC</sub>

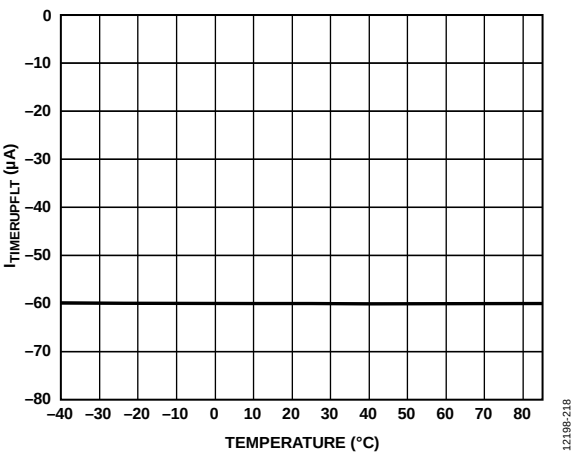
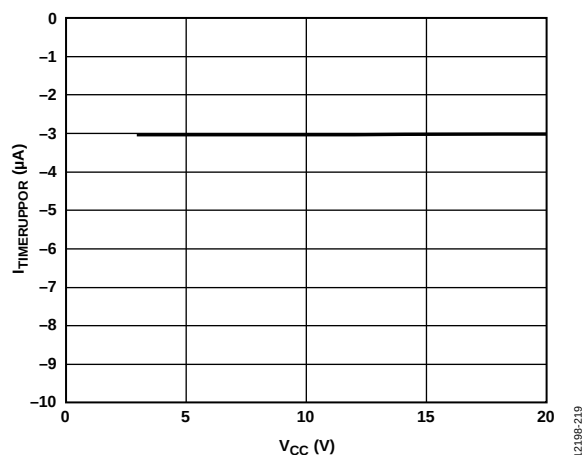
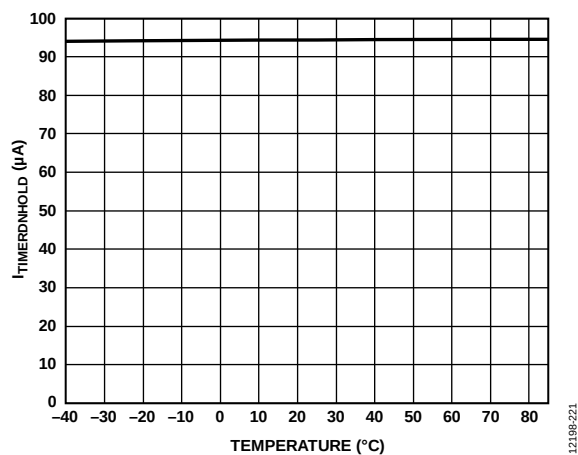
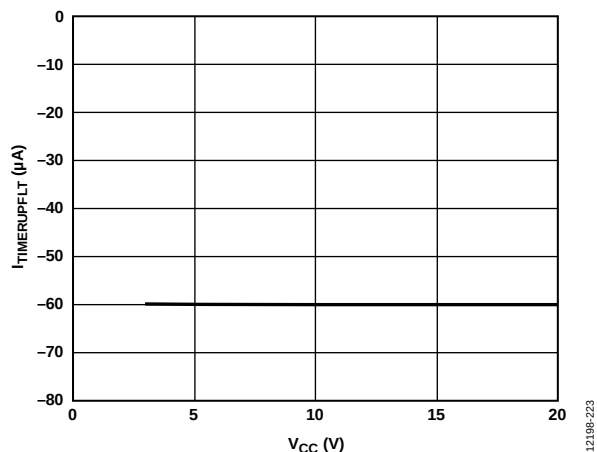
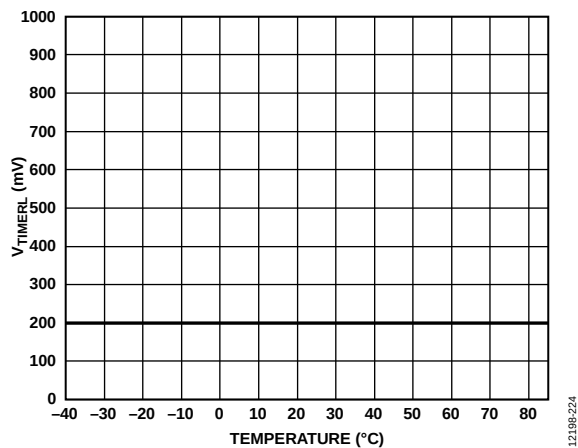
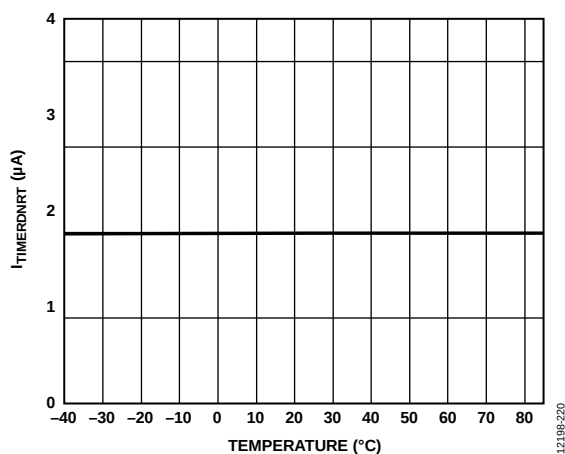
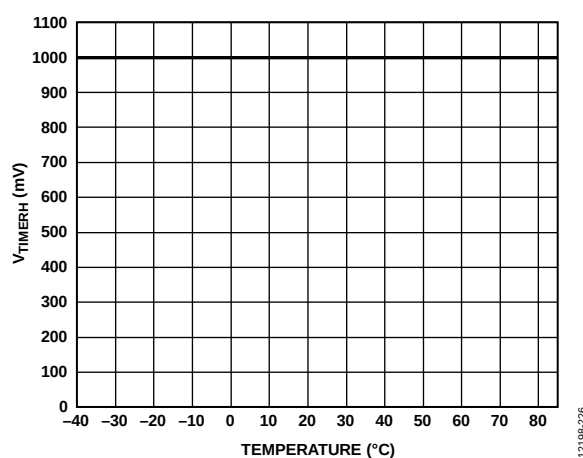


Figure 18. TIMER Pull-Up Current OC Fault (I<sub>TIMERUPFLT</sub>) vs. Temperature

Figure 19. TIMER Pull-Up Current POR ( $I_{T\text{IMERUPPOR}}$ ) vs.  $V_{CC}$ Figure 22. TIMER Pull-Down Current Hold ( $I_{T\text{IMERDNHOLD}}$ ) vs. TemperatureFigure 20. TIMER Pull-Up Current OC Fault ( $I_{T\text{IMERUPFLT}}$ ) vs.  $V_{CC}$ Figure 23. TIMER Low Threshold ( $V_{T\text{IMERL}}$ ) vs. TemperatureFigure 21. TIMER Pull-Down Current Retry ( $I_{T\text{IMERDNRT}}$ ) vs. TemperatureFigure 24. TIMER High Threshold ( $V_{T\text{IMERH}}$ ) vs. Temperature

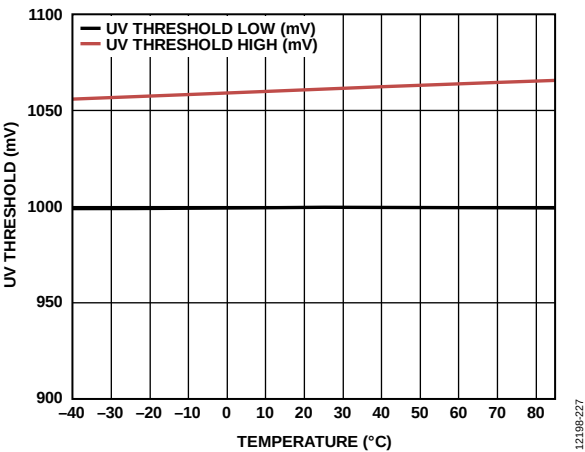


Figure 25. UV Threshold vs. Temperature

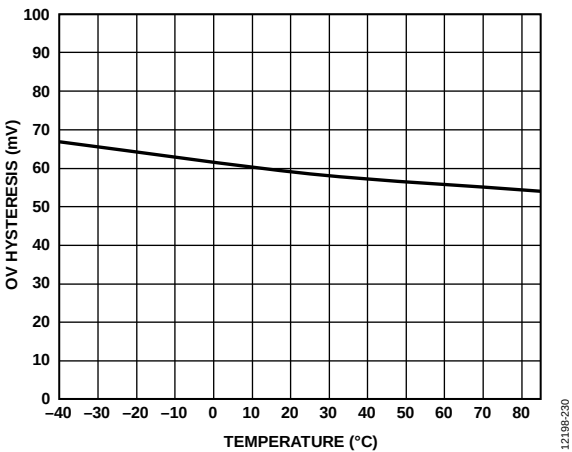


Figure 28. OV Hysteresis vs. Temperature

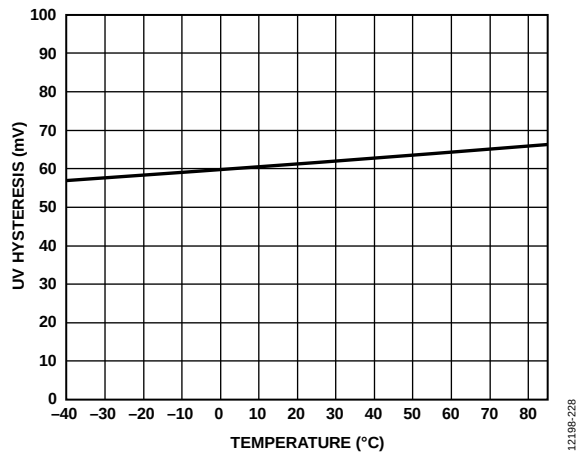


Figure 26. UV Hysteresis vs. Temperature

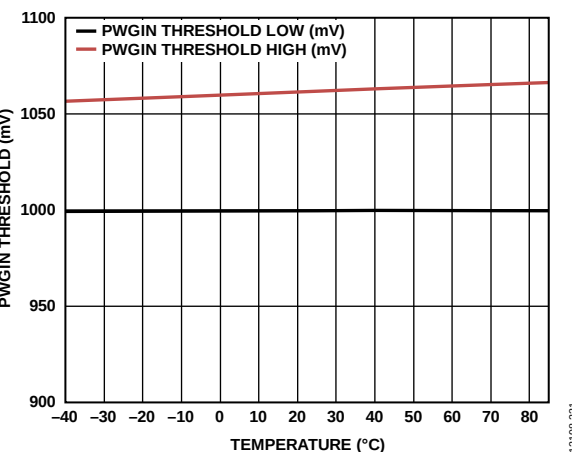


Figure 29. PWGIN Threshold vs. Temperature

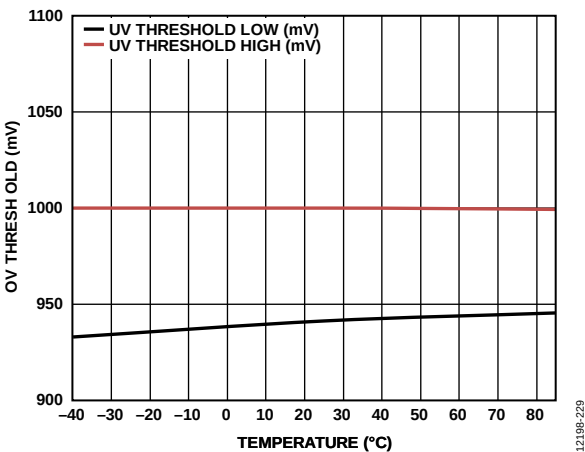


Figure 27. OV Threshold vs. Temperature

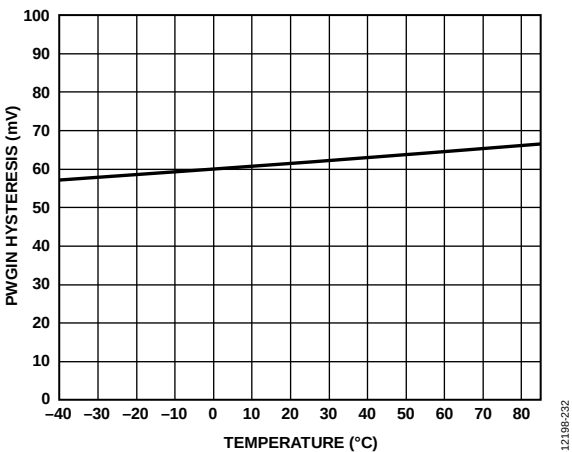


Figure 30. PGIN Hysteresis vs. Temperature

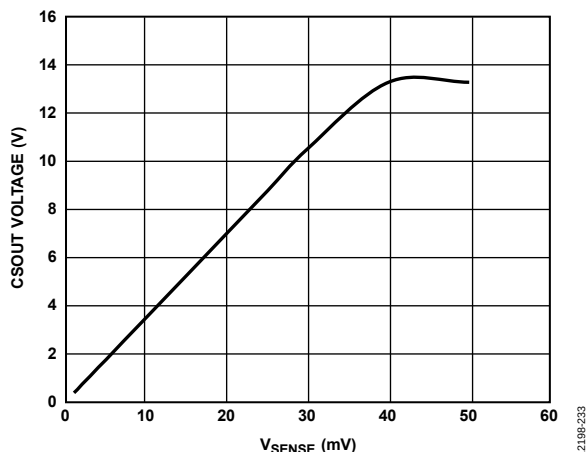
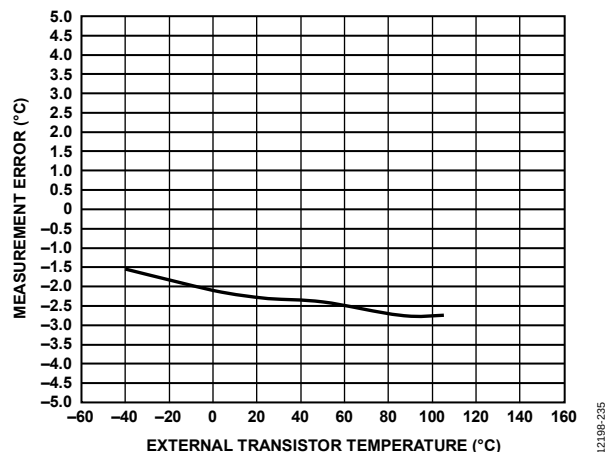
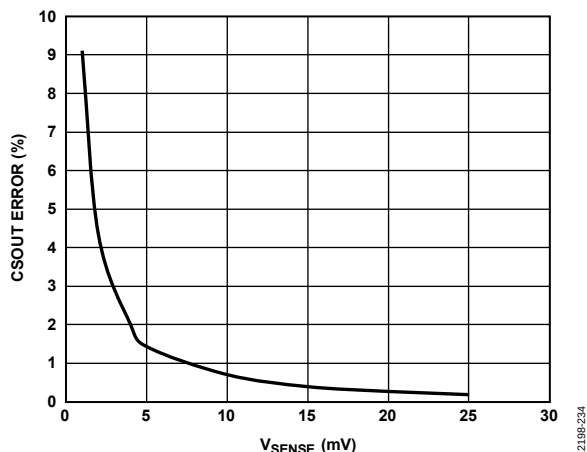
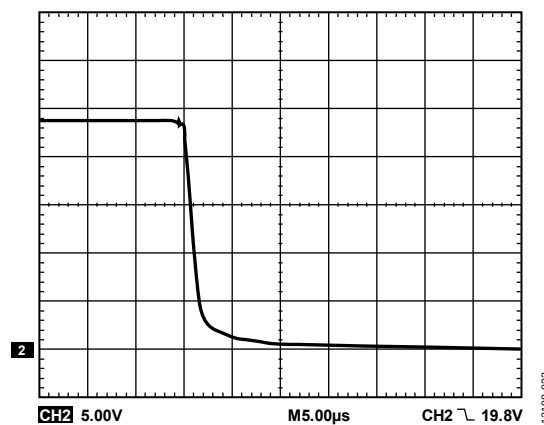
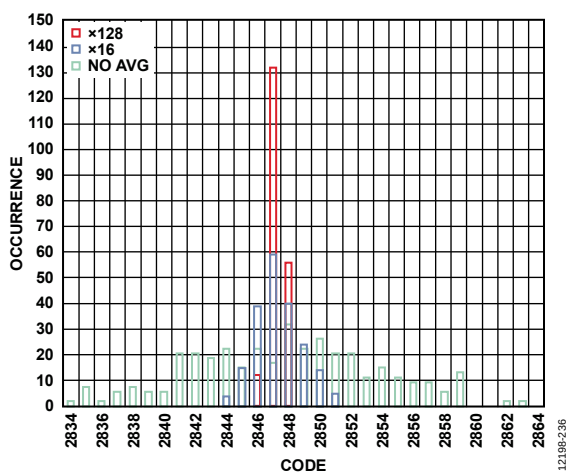
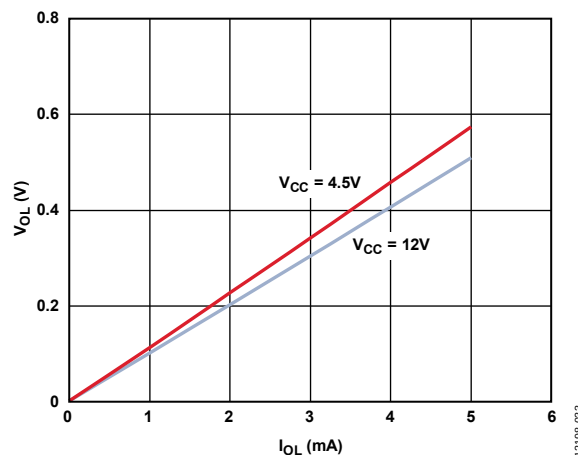
Figure 31. CSOUT Voltage vs.  $V_{SENSE}$ 

Figure 34. Measurement Error vs. External Transistor Temperature

Figure 32. CSOUT Error vs.  $V_{SENSE}$ Figure 35.  $V_{GATE}$  Response to Severe Overcurrent Event (GATE Fast Pull-Down)Figure 33. ADC Code Histogram ( $V_{SENSE} = 10$  mV, 200 Measurements)Figure 36. PWGD Pin,  $V_{OL}$  vs.  $I_{OL}$

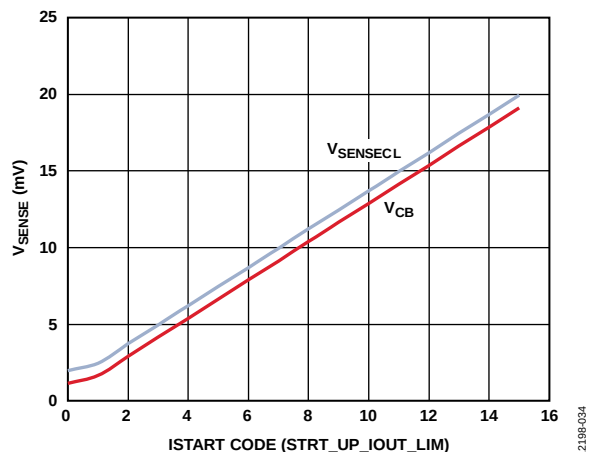


Figure 37.  $V_{SENSE}$  vs. ISTART Code (STRT\_UP\_IOUT\_LIM)

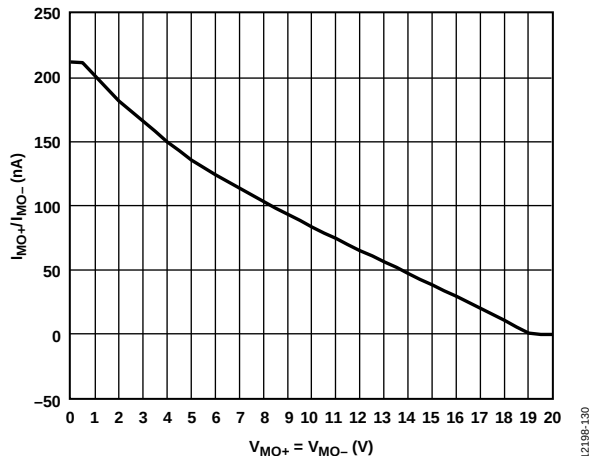


Figure 40.  $I_{MO+}/I_{MO-}$  vs.  $V_{MO+}/V_{MO-}$  with  $V_{CC} = 20\text{ V}$

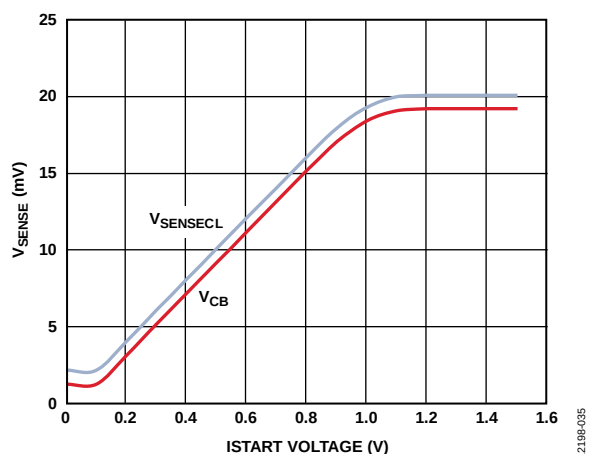


Figure 38.  $V_{SENSE}$  vs. ISTART Voltage

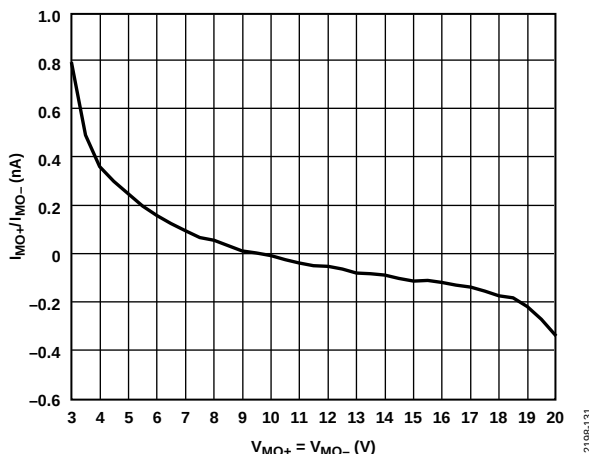


Figure 41.  $I_{MO+}/I_{MO-}$  vs.  $V_{MO+}/V_{MO-}$  with  $V_{CC} = V_{MO+} = V_{MO-}$

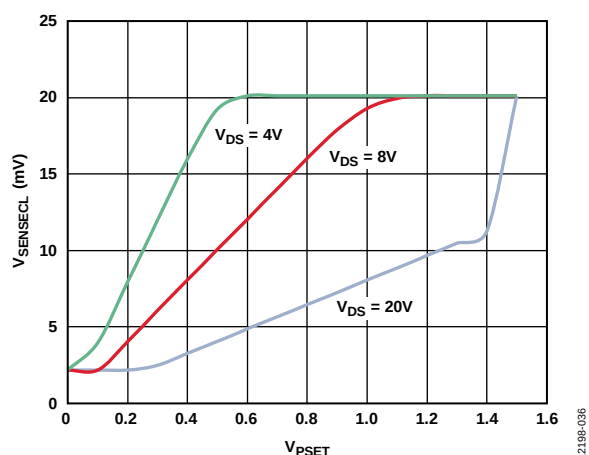


Figure 39.  $V_{SENSECL}$  vs.  $V_{PSET}$

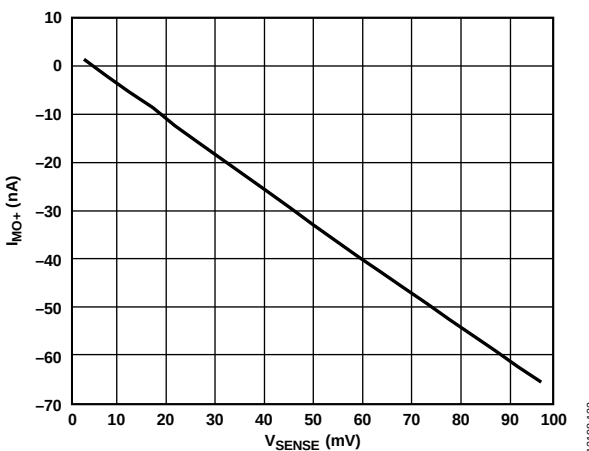


Figure 42.  $I_{MO+}$  vs.  $V_{SENSE}$  with  $V_{CC} = V_{MO+} = 20\text{ V}$

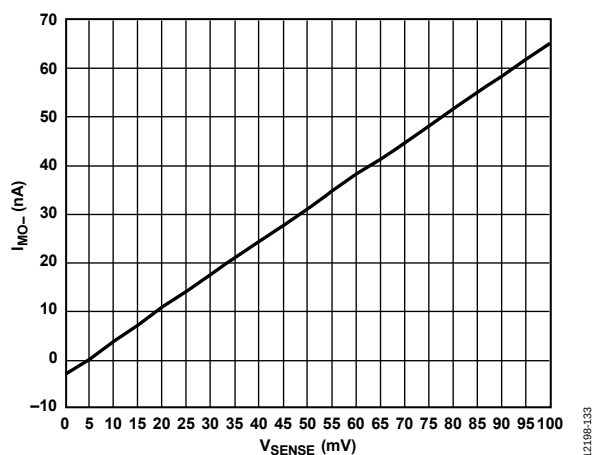


Figure 43.  $I_{MO-}$  vs.  $V_{SENSE}$  with  $V_{CC} = V_{MO+} = 20$  V

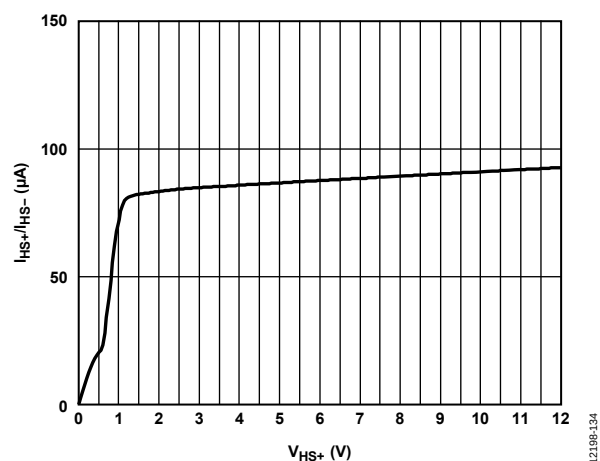


Figure 44.  $I_{HS+}/I_{HS-}$  vs.  $V_{HS+}$

## THEORY OF OPERATION

When circuit boards are inserted into a live backplane, discharged supply bypass capacitors draw large transient currents from the backplane power bus as they charge. These transient currents can cause permanent damage to connector pins, as well as dips on the backplane supply that can reset other boards in the system.

The ADM1278 is designed to control the powering on and off of a system in a controlled manner, allowing a board to be removed from, or inserted into, a live backplane by protecting it from excess currents. The ADM1278 can reside on the backplane or on the removable board.

### POWERING THE ADM1278

A supply voltage from 4.5 V to 20 V is required to power the ADM1278 via the VCC pin. The VCC pin provides the majority of the bias current for the device; the remainder of the current needed to control the gate drive and to best regulate the  $V_{GS}$  voltage is supplied by the HS+ pin.

To ensure correct operation of the ADM1278, the voltage on the VCC pin must be greater than or equal to the voltage on the HS+ and MO+ pins. No sequencing of the VCC and HS+ rails is necessary. The HS+ pin can be as low as 2 V for normal operation, provided that a voltage of at least 4.5 V is connected to the VCC pin. In most applications, both the VCC and HS+ pins are connected to the same voltage rail, but they are connected via separate traces to prevent accuracy loss in the sense voltage measurement (see Figure 45).

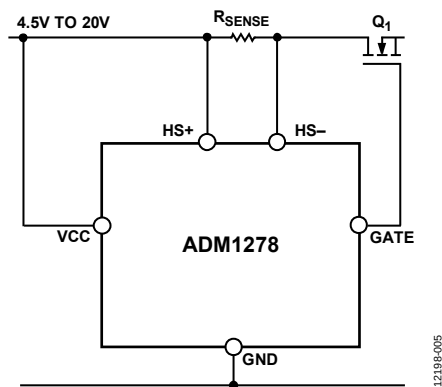


Figure 45. Powering the ADM1278

To protect the ADM1278 from unnecessary resets due to transient supply glitches, an external resistor and capacitor can be added, as shown in Figure 46. Choose the values of these components such that a time constant is provided that can filter any expected glitches. However, use a resistor that is small enough to keep voltage drops caused by quiescent current to a minimum. Unless a resistor is used to limit the inrush current, do not place a supply decoupling capacitor on the rail before the FET.

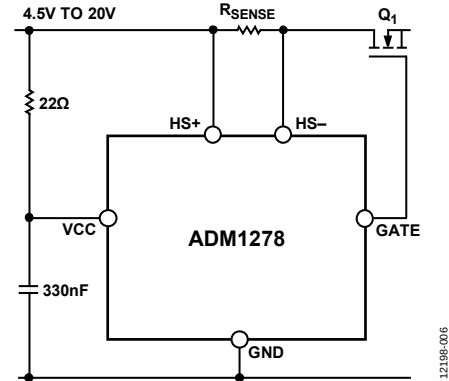


Figure 46. Transient Glitch Protection Using an RC Network

### HOT SWAP CURRENT SENSE INPUTS

The load current is monitored by measuring the voltage drop across an external sense resistor,  $R_{SENSE}$  (see Figure 47). An internal current sense amplifier provides a gain of 50 to the voltage drop detected across  $R_{SENSE}$ . The result is compared to an internal reference and used by the hot swap control logic to detect when an overcurrent condition occurs.

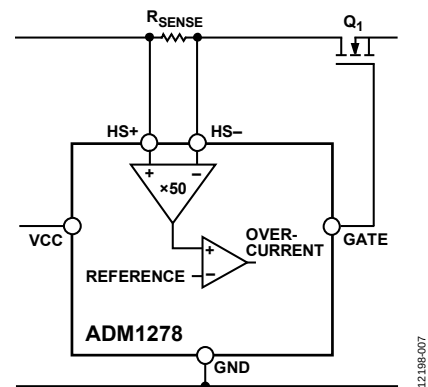


Figure 47. Hot Swap Current Sense Amplifier

The HS± inputs can be connected to multiple parallel sense resistors, which can affect the voltage drop detected by the ADM1278. The current flowing through the sense resistors creates an offset, resulting in reduced accuracy.

To achieve better accuracy, averaging resistors can be used to sum the current from the nodes of each sense resistor, as shown in Figure 48. A typical value for the averaging resistors is 10 Ω. The input current to each sense pin is matched to within 5 μA. This ensures that the same offset is observed by both sense inputs.

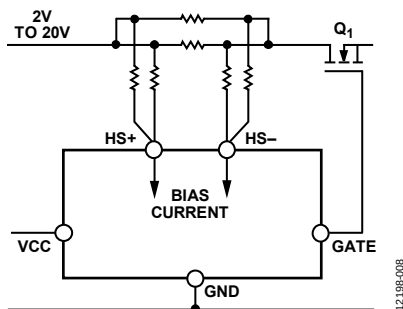


Figure 48. Connection of Multiple Sense Resistors to the HS± Pins

## POWER MONITOR CURRENT SENSE INPUTS

The internal ADC uses separate current sense input pins for measuring the load current from those used by the hot swap circuitry. This allows additional filtering on the power monitor pins without affecting the response time of the hot swap to an overcurrent event.

The same external sense resistor,  $R_{SENSE}$ , is used for hot swap control and ADC measurements. If additional external filtering is not required, the HS± and MO± pins can be tied together, close to the device under test, as shown in Figure 49.

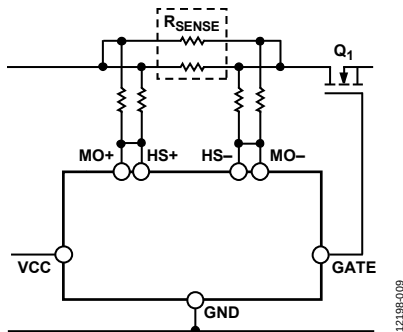


Figure 49. Power Monitor, No External Filtering

If additional antialiasing filtering is required, filtering components can be added, as shown in Figure 50, without affecting the hot swap performance.

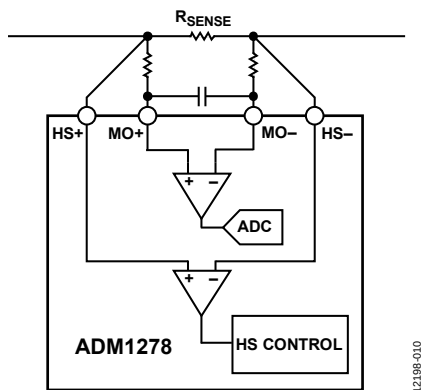


Figure 50. Power Monitor Current Sense Filtering

## CURRENT-LIMIT REFERENCE

The current-limit reference voltage determines the load current level to which the ADM1278 limits the current during an over-current event. This reference voltage is compared to the amplified current sense voltage to determine whether the limit is reached.

An internal current-limit reference selector block continuously compares the ISET and PSET voltages to determine which voltage reference is the lowest at any given time; the lowest voltage is used as the current-limit reference. The ISTART pin is also monitored while PWRGD is inactive. This ensures that the programmed current limit, ISET, is used in normal operation, and that the start-up current limit and foldback features reduce the current limit when required during startup and/or fault conditions.

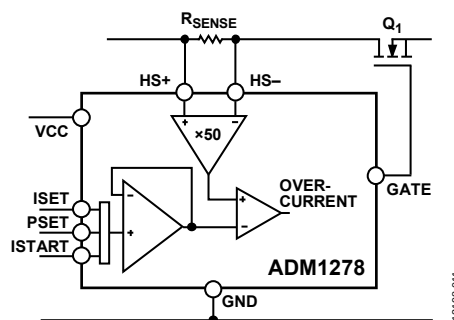


Figure 51. Current-Limit Reference Selection

The foldback and start-up current-limit voltage inputs to the internal comparator are clamped to minimum levels of 100 mV (that is,  $V_{SENSECL} = 2 \text{ mV}$ ) to prevent zero current flow caused by the current limit being too low. Figure 52 provides an example of how the ISTART, PSET, and ISET voltages interact during startup as the ADM1278 is enhancing the FET and charging the output load capacitance.

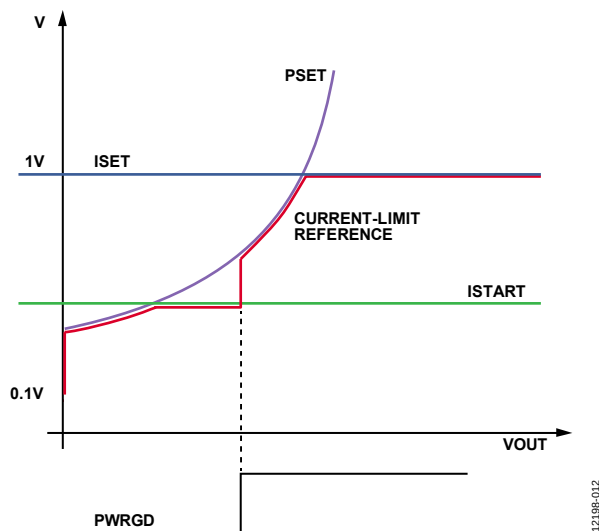


Figure 52. Interaction of ISTART, PSET, and ISET Current Limits

## SETTING THE CURRENT LIMIT (ISET)

The maximum current limit is partially determined by selecting a sense resistor to match the current sense voltage limit on the controller for the desired load current. However, as currents become larger, the sense resistor requirements become smaller, and resolution can be difficult to achieve when selecting the appropriate sense resistor. The ADM1278 provides an adjustable current sense voltage limit to manage this issue. The device allows the user to program the required current sense voltage limit from 5 mV to 25 mV.

The default value of 20 mV is achieved by connecting the ISET pin directly to the VCAP pin. This connection configures the device to use an internal 1 V reference, which equates to 20 mV at the sense inputs (see Figure 53).

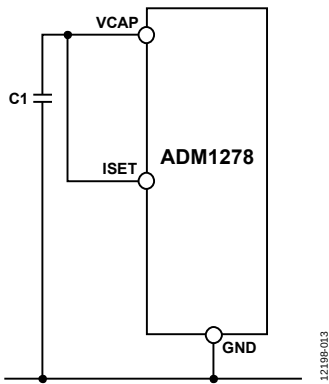


Figure 53. Fixed 20 mV Current Sense Limit

To program the sense voltage from 5 mV to 25 mV, a resistor divider is used to set a reference voltage on the ISET pin (see Figure 54).

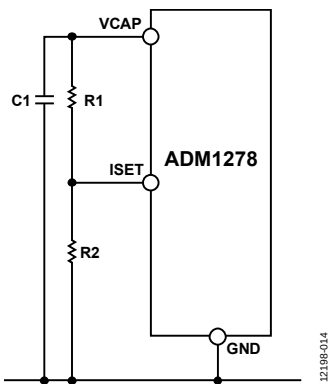


Figure 54. Adjustable 5 mV to 25 mV Current Sense Limit

The VCAP pin has a 2.7 V internal generated voltage that can be used to set a voltage at the ISET pin. Assuming that  $V_{ISET}$  equals the voltage on the ISET pin, size the resistor divider to set the ISET voltage as follows:

$$V_{ISET} = V_{SENSECL} \times 20$$

where  $V_{SENSECL}$  is the current sense voltage limit.

The VCAP rail can also be used as the pull-up supply for the resistor divider on the PSET and ISTART pins and for setting the I<sup>2</sup>C address. Do not use the VCAP pin for any other purpose. To guarantee accuracy specifications, do not load the VCAP pin by more than 100  $\mu$ A.

## SETTING A LINEAR OUTPUT VOLTAGE RAMP AT POWER-UP

The ADM1278 standard method of power-up in a server application is to configure a single linear voltage ramp on the output, which allows a constant inrush current into the load capacitance. This method has the advantage of setting very low inrush currents where required by a combination of large output capacitance and FET SOA limitations.

The object of such a design is to allow a linear monotonic power-up event without the restrictions of the system fault timer. To achieve this, a power-up ramp is set such that the inrush is low enough not to reach the active circuit breaker current limit. This allows the power-up to continue without the timer running. When using this method, ensure that the power in the MOSFET during this event meets the SOA requirements. An extra component,  $C_{GATE}$ , is required on the GATE pin as shown in Figure 55.

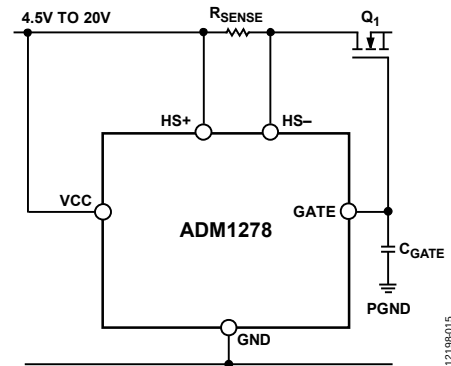


Figure 55. DV/DT Power-Up Configuration

To ensure that the inrush current does not approach or exceed the active current-limit level, the output voltage ramp can be set by selecting the appropriate value for  $C_{GD}$  as follows:

$$C_{GATE} = (I_{GATEUP}/I_{INRUSH}) \times C_{LOAD}$$

where  $I_{GATEUP}$  is the gate pull-up current specified.

Add margin and tolerance as necessary to ensure a robust design. Subtract any parasitic  $C_{GD}$  of the MOSFETs from the total to determine the additional external capacitance required.

Next, the power-up ramp time can be approximated by

$$t_{RAMP} = (V_{IN} \times C_{LOAD})/I_{INRUSH} = (V_{IN} \times C_{GATE})/I_{GATEUP}$$

Check the SOA of the MOSFET for conditions and the duration of this power-up ramp. TIMER regulation period can be minimized to provide a simple fault filtering solution.

The diagram in Figure 56 shows a typical hot swap power-up with a gate capacitor configured for a linear output voltage ramp.

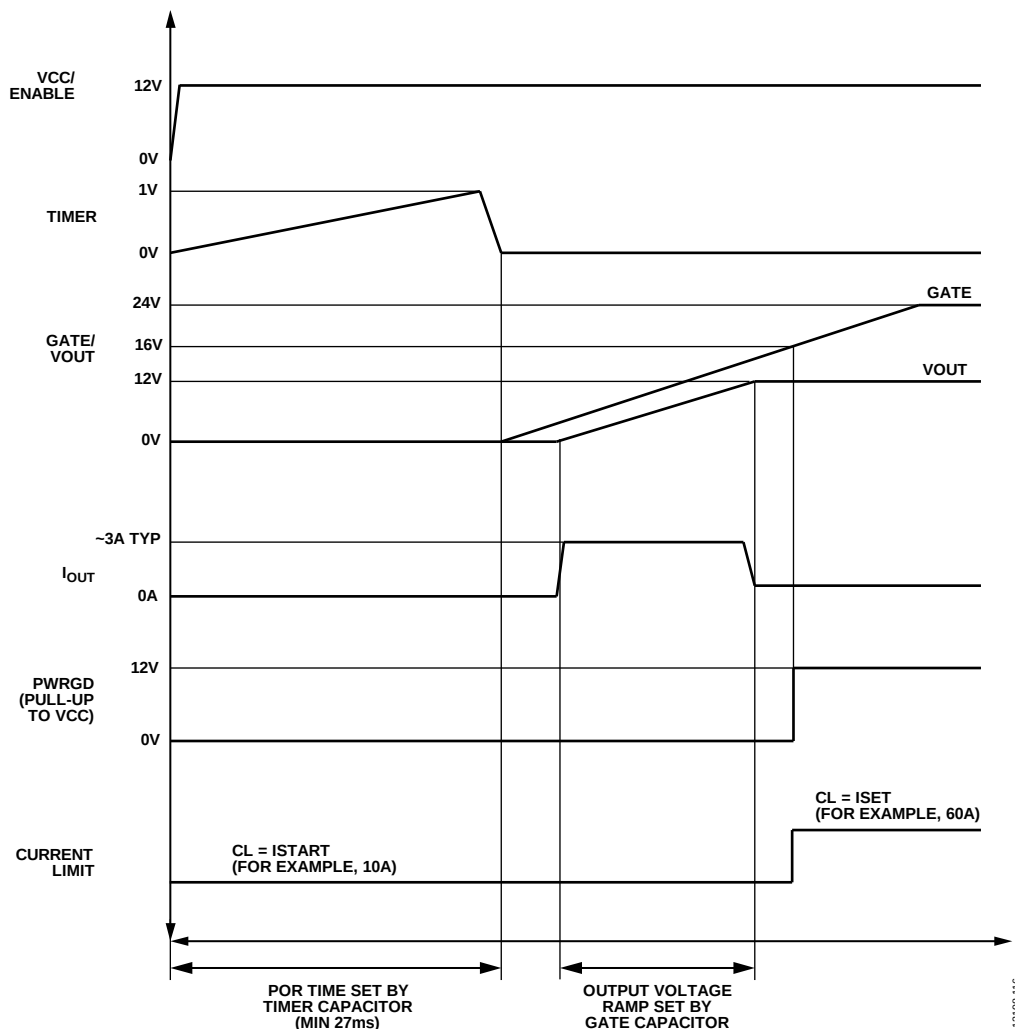


Figure 56. Linear Voltage Ramp Power-Up

### START-UP CURRENT LIMIT

When powering up in dv/dt mode, the inrush current is typically configured to be in the order of <5 A. The other active current limits (PSET and ISET) may be much higher than this. The start-up current limit is intended as an extra level of protection during this initial power-up stage. It helps catch a resistive type fault that causes the inrush to be higher than expected.

The start-up current limit is only active during power-up. It is enabled while PWRGD is deasserted and is disabled when PWRGD is asserted.

The start-up current limit can be programmed via the ISTART pin or via the PMBus register, STRT\_UP\_IOUT\_LIM (Register 0xF6). If both are configured, the lowest current limit is selected as the active current limit. The clamp level in both cases is a 2 mV  $V_{SENSE}$  current limit.

When configuring with the ISTART pin, the current limit is

$$Startup\_CL = \frac{V_{ISTART}}{50 \times R_{SENSE}}$$

More importantly, the circuit breaker level can be calculated using the following equation:

$$Startup\_CB = \frac{\left( \frac{V_{ISTART}}{50} - 0.88 \text{ mV} \right)}{R_{SENSE}}$$

To prevent the start-up current limit from being triggered during a normal dv/dt power-up, set the circuit breaker level above the maximum expected inrush current.

The ISTART pin can be tied to VCAP to disable the start-up current limit. The start-up current limit PMBus register is set to the maximum by default; therefore, it is effectively disabled by default.

If configuring the start-up current limit with the PMBus register, the start-up current limit is set as a fraction of the ISET current limit. There are four register bits so that the start-up current limit can be set from  $1/16^{\text{th}}$  to  $16/16^{\text{th}}$  of the normal current limit. The effective ISTART voltage can be calculated as

$$V_{ISTART} = V_{ISET} \times \left( \frac{(STRT\_UP\_IOUT\_LIM) + 1}{16} \right)$$

The start-up circuit breaker and current limits can then be calculated from this effective ISTART voltage.

### CONSTANT POWER FOLDBACK

Foldback is a method that actively reduces the current limit as the voltage drop across the FET increases. It keeps the power across the FET below the programmed value during power-up, overcurrent, or short-circuit events. This allows a smaller FET to be used, resulting in board size savings and cost savings. The foldback method used is a constant power foldback scheme, meaning power in the FET is held constant, regardless of the  $V_{DS}$  of the FET. This simplifies the task of ensuring that the FET is always operating within the SOA limits.

The ADM1278 detects the  $V_{DS}$  voltage drop across the FET by sensing the HS+ and VOUT pins. The foldback current limit dynamically changes as the  $V_{DS}$  voltage changes to maintain a constant power level in the MOSFET. For example, as  $V_{OUT}$  drops, the current-limit reference follows  $V_{PSET}$  after it becomes the lowest voltage input to the current-limit reference selector block. This results in a reduction of the current limit and, therefore, the regulated load current. To prevent complete current flow restriction, a clamp becomes active when the current-limit reference reaches 100 mV. The current limit cannot drop below this level.

The maximum FET power level is configured with a resistor divider on the PSET pin

$$FET\ Power\ Limit = \frac{(V_{PSET} \times 8)}{(50 \times R_{SENSE})}$$

Therefore, after determining the desired FET power limit and  $R_{SENSE}$  values, the required PSET voltage can be calculated. Set this voltage with a resistor divider from the VCAP pin.

### TIMER

The TIMER pin handles several timing functions with an external capacitor,  $C_{TIMER}$ . The two comparator thresholds are  $V_{TIMERL}$  (0.2 V) and  $V_{TIMERH}$  (1 V). There are four timing current sources: a 3  $\mu A$  pull-up, a 60  $\mu A$  pull-up, a 2  $\mu A$  pull-down, and a 100  $\mu A$  pull-down.

These current and voltage levels, together with the value of  $C_{TIMER}$  chosen by the user, determine the initial timing cycle time and the fault regulation time. The TIMER pin capacitor value is determined using the following equation:

$$C_{TIMER} = (t_{ON} \times 60 \mu A) / V_{TIMERH}$$

where  $t_{ON}$  is the time that the FET is allowed to spend in regulation at the set current limit.

The choice of FET is based on matching this time with the SOA requirements of the FET. Foldback can be used to simplify the selection.

When VCC is connected to the backplane supply, the internal supply of the ADM1278 must be charged up. In a very short time, the internal supply is fully charged up and, because the UVLO voltage is exceeded at VCC, the device emerges from

reset. During this first short reset period, the GATE and TIMER pins are both held low.

The ADM1278 then goes through an initial timing cycle. The TIMER pin is pulled high with 3  $\mu A$ . When the TIMER pin reaches the  $V_{TIMERH}$  threshold (1.0 V), the first portion of the initial timing cycle is complete. The initial timing cycle is a minimum of approximately 27 ms to allow FET health checks to be completed. If the initial TIMER cycle is set shorter than 27 ms by the TIMER capacitor, the TIMER pin continues to be pulled up to the VCAP voltage level until the 27 ms has expired. The 100  $\mu A$  current source then pulls down the TIMER pin until it reaches  $V_{TIMERL}$  (0.2 V). The initial timing cycle duration is related to  $C_{TIMER}$  by the following equation:

$$t_{INITIAL} = \frac{V_{TIMERH} \times C_{TIMER}}{3 \mu A} + \frac{(V_{TIMERH} - V_{TIMERL}) \times C_{TIMER}}{100 \mu A}$$

where  $t_{INITIAL} \geq 27$  ms, regardless of  $C_{TIMER}$  value.

For example, a 100 nF capacitor results in an initial insertion delay of approximately 34 ms. If the UV and OV inputs indicate that the supply is within the defined window of operation when the initial timing cycle terminates, the device is ready to start a hot swap operation.

When the voltage across the sense resistor reaches the circuit breaker trip voltage,  $V_{CB}$ , the 60  $\mu A$  TIMER pull-up current is activated, and the gate begins to regulate the current at the current limit. This initiates a ramp-up on the TIMER pin. If the sense voltage falls below this circuit breaker trip voltage before the TIMER pin reaches  $V_{TIMERH}$ , the 60  $\mu A$  pull-up is disabled and the 2  $\mu A$  pull-down is enabled.

The circuit breaker trip voltage is not the same as the hot swap sense voltage current limit. There is a small circuit breaker offset,  $V_{CBOS}$ , which means that the TIMER pin actually starts ramping a short time before the current reaches the defined current limit.

However, if the overcurrent condition is continuous and the sense voltage remains above the circuit breaker trip voltage, the 60  $\mu A$  pull-up current remains active and the FET remains in regulation.

This allows the TIMER pin to reach  $V_{TIMERH}$  and to initiate the GATE shutdown. On the ADM1278, the  $\overline{FAULT}$  pin is pulled low immediately and PWRGD is deasserted.

In latch-off mode, the TIMER pin is switched to the 2  $\mu A$  pull-down current when it reaches the  $V_{TIMERH}$  threshold. While the TIMER pin is being pulled down, the hot swap controller remains off and cannot be turned back on.

When the voltage on the TIMER pin goes below the  $V_{TIMERL}$  threshold, the hot swap controller can be reenabled by toggling the UV pin or by using the PMBus OPERATION command to toggle the on bit from on to off and then on again.

## HOT SWAP RETRY

The  $\overline{\text{RETRY}}$  pin is used to configure latch-off or autoretry mode. The  $\overline{\text{RETRY}}$  pin has an internal pull-up current; therefore, it can be left floating to enable latch-off mode after an overcurrent fault. The  $\overline{\text{RETRY}}$  pin can be pulled low to enable a 10 second autoretry following an overcurrent fault.

## FET GATE DRIVE CLAMPS

The charge pump used on the GATE pin is capable of driving the pin to  $V_{CC} + (2 \times V_{CC})$ , but it is clamped to less than 14 V above the HS $\pm$  pins and less than 31 V. These clamps ensure that the maximum  $V_{GS}$  rating of the FET is not exceeded.

## FAST RESPONSE TO SEVERE OVERCURRENT

The ADM1278 features a separate high bandwidth current sense amplifier that detects a severe overcurrent that is indicative of a short-circuit condition. A fast response time allows the ADM1278 to handle events of this type that may otherwise cause catastrophic damage if not detected and acted on very quickly. The fast response circuit ensures that the ADM1278 can detect an overcurrent event at approximately 125% to 225% of the normal current limit (ISET) and can respond to and control the current within 1  $\mu\text{s}$ , in most cases.

There are four severe overcurrent threshold options and two severe overcurrent glitch filter options selectable via the PMBus registers.

## UNDERVOLTAGE AND OVERVOLTAGE

The ADM1278 monitors the supply voltage for undervoltage (UV) and overvoltage (OV) conditions. The UV and OV pins are connected to the input of an internal voltage comparator, and its voltage level is internally compared with a 1 V voltage reference.

Figure 57 illustrates the voltage monitoring input connections. An external resistor network divides the supply voltage for monitoring. An undervoltage event is detected when the voltage connected to the UV pin falls below 1 V, and the gate is shut down using the 10 mA pull-down device. Similarly, when an overvoltage event occurs and the voltage on the OV pin exceeds 1 V, the gate is shut down using the 10 mA pull-down device. There is a fixed 60 mV hysteresis on the UV and OV pin thresholds.

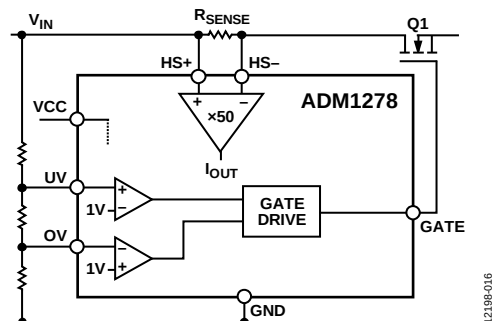


Figure 57. Undervoltage and Overvoltage Supply Monitoring

## POWER GOOD

The power-good (PWRGD) output can be used to indicate whether the output voltage is above a user defined threshold and can, therefore, be considered good. A resistor divider on the PWGIN pin sets an accurate power-good threshold on the output voltage.

The PWRGD pin is an open-drain output that pulls low when the voltage at the PWGIN pin is lower than 1.0 V (power bad). When the voltage at the PWGIN pin is above this threshold plus a fixed hysteresis of 60 mV, output power is considered to be good.

However, PWRGD asserts only when the following conditions are met:

- PWGIN is above the rising threshold voltage.
- Hot swap is enabled, that is, the ENABLE pin is high ( $\overline{\text{ENABLE}}$  pin is low), and UV and OV are within range.
- There is no active fault condition, that is, the  $\overline{\text{FAULT}}$  pin has been cleared following any fault condition.
- The MOSFET is fully enhanced (gate voltage  $> V_{\text{MOSFET\_DRAIN}} + 4 \text{ V}$ ).

After all of these conditions are met, the open-drain pull-down current is disabled, allowing PWRGD to be pulled high. PWRGD is guaranteed to be in a valid state for  $V_{CC} \geq 1 \text{ V}$ .

If the gate voltage drops below  $V_{\text{MOSFET\_DRAIN}} + 4 \text{ V}$  (that is, no longer meets MOSFET fully enhanced condition), PWRGD still remains asserted for 100 ms. If the condition persists for longer than 100 ms, PWRGD is deasserted and an FET health fault is signaled.

If any of the other conditions for PWRGD are no longer met, PWRGD is deasserted immediately.

## FAULT PIN

The  $\overline{\text{FAULT}}$  pin asserts when one of the following faults causes the hot swap to shut down:

- FET health fault
- Overcurrent fault
- Overtemperature fault

The  $\overline{\text{FAULT}}$  pin is latched, and it can only be cleared by a rising edge on the ENABLE pin (falling edge on the  $\overline{\text{ENABLE}}$  pin), a PMBus OPERATION on command from the off state, or a POWER\_CYCLE command, assuming no faults are still active. The fault registers are not cleared by the ENABLE/ $\overline{\text{ENABLE}}$  pin or the POWER\_CYCLE command; they can only be cleared by a PMBus OPERATION off to on command or a CLEAR\_FAULTS command.

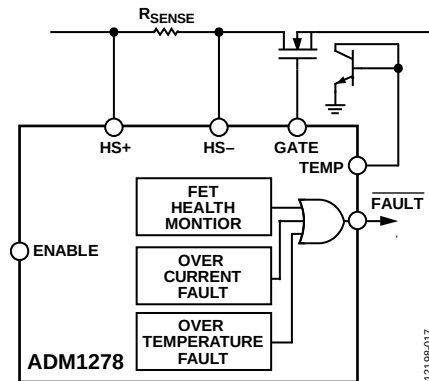


Figure 58. FAULT Pin Operation

## ENABLE/ENABLE INPUT

The ADM1278 provides a dedicated ENABLE/ENABLE digital input pin. The ADM1278-1 and ADM1278-2 have an active high ENABLE pin whereas the ADM1278-3 has an active low ENABLE pin. The ENABLE/ENABLE pin allows the ADM1278 to remain off by using a hardware signal, even when the voltage on the UV pin is greater than 1.0 V and the voltage on the OV pin is less than 1.0 V. Although the UV pin can be used to provide a digital enable signal, using the ENABLE/ENABLE pin for this purpose means that the ability to monitor for undervoltage conditions is not lost.

In addition to the conditions for the UV and OV pins, the ADM1278 ENABLE/ENABLE input pin must be asserted for the device to begin a power-up sequence.

## CURRENT SENSE OUTPUT (CSOUT)

The ADM1278 provides a CSOUT pin voltage output that is proportional to the  $V_{SENSE\_HS}$  voltage.

$$CSOUT = V_{SENSE\_HS} \times 350$$

The CSOUT voltage is an analog representation of the main system current flowing through  $R_{SENSE}$ . A resistor divider can be added to CSOUT to clamp the voltage output to any downstream devices, provided the maximum load conditions described in Table 2 are not exceeded.

The response time of the CSOUT pin to a change in  $V_{SENSE}$  voltage is very fast; therefore, it can be used when fast response time is required, for example, power throttling. The CSOUT response time to a 10 mV step in  $V_{SENSE}$  voltage is typically 10  $\mu$ s.

## REMOTE TEMPERATURE SENSING

The ADM1278 provides the capability to measure temperature at a remote location with a single discrete NPN or PNP transistor. The temperature measurements can be read back over the PMBus interface. Warning and fault thresholds can also be set on the temperature measurement. Exceeding a fault threshold causes the controller to turn off the pass MOSFET, deassert the PWRGD pin, and assert the FAULT pin.

The external transistor is typically placed close to the main pass MOSFETs to provide an additional level of protection. The

controller can then monitor and respond to an elevated MOSFET operating temperature. It is not possible to measure temperature at more than one location on the board.

Place the transistor close to the MOSFET for best accuracy. If the transistor is placed on the opposite side of the PCB, use multiple vias to ensure the optimum transfer of heat from the MOSFET to the transistor.

## Temperature Measurement Method

A simple method of measuring temperature is to exploit the negative temperature coefficient of a diode by measuring the base-emitter voltage ( $V_{BE}$ ) of a transistor operated at constant current. However, this technique requires calibration to null the effect of the absolute value of  $V_{BE}$ , which varies from device to device.

The technique used in the ADM1278 is to measure the change in  $V_{BE}$  when the device is operated at three different currents. The use of a third current allows automatic cancellation of resistances in series with the external temperature sensor.

The temperature sensor takes control of the ADC for 64  $\mu$ s (typical) every 6 ms. It takes 12 ms to obtain a new temperature measurement from the ADC.

## Remote Sensing Diode

The ADM1278 is designed to work with discrete transistors. The transistor can be either a PNP or NPN connected as a diode (base shorted to the collector). If an NPN transistor is used, the collector and base are connected to the TEMP pin and the emitter to PGND. If a PNP transistor is used, the collector and base are connected to PGND and the emitter to TEMP.

The best accuracy is obtained by choosing devices according to the following criteria:

- Base-emitter voltage greater than 0.25 V at 6  $\mu$ A, at the highest operating temperature.
- Base-emitter voltage less than 0.95 V at 100  $\mu$ A, at the lowest operating temperature.
- Base resistance less than 100  $\Omega$ .
- Small variation in  $h_{FE}$  (50 to 150) that indicates tight control of  $V_{BE}$  characteristics.

Transistors, such as the 2N3904, 2N3906, or equivalent in SOT-23 packages are suitable devices to use.

## Noise Filtering

For temperature sensors operating in noisy environments, the industry standard practice has been to place a capacitor across the temperature pins to mitigate the effects of noise. However, large capacitances affect the accuracy of the temperature measurement, leading to a recommended maximum capacitor value of 1000 pF. Although this capacitor reduces the noise, it does not eliminate it, making it difficult to use the sensor in a very noisy environment.

The ADM1278 has a major advantage over other devices for eliminating the effects of noise on the external sensor. The

series resistance cancellation feature allows a filter to be constructed between the external temperature sensor and the device. The effect of any filter resistance seen in series with the remote sensor is automatically cancelled from the temperature result.

The construction of a filter allows the ADM1278 and the remote temperature sensor to operate in noisy environments. Figure 59 shows a low-pass R-C-R filter with the following values:  $R = 100\ \Omega$  and  $C = 1\ \text{nF}$ . This filtering reduces both common-mode noise and differential noise.

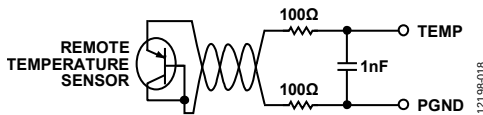


Figure 59. Filter Between Remote Sensor and ADM1278

## SPI INTERFACE

The serial peripheral interface (SPI) allows the user to output a stream of raw data from the ADC as soon as new data is available, removing the bandwidth limitations of the PMBus interface for data readback. The PMBus remains as an active data bus and all configuration and register access must still be completed over the PMBus interface. However, the SPI interface can be used at the same time to serially output the ADC monitoring data. It is a 3-pin serial interface capable of operating at speeds of up to 1 MHz.

The SPI pins are only available on the ADM1278-2 model. If the ADM1278-2 model is used but the SPI pins are not required, tie the SPI input pins (SPI\_SS, MCLK) to VCAP and the SPI output pin (MDAT) can be left floating or tied to GND.

SPI\_SS is the slave select pin, and when it is held low, the MCLK pin can be used to clock data out on the MDAT serial output pin. The SPI\_SS pin is also used to frame the output data. The SPI pins are compatible with SPI Mode 0 (CPOL = CPHA = 0),

but it is also possible to launch and capture data on the same clock edge for extra timing margin if required.

The interface has the following characteristics:

- MDAT is driven by the ADM1278 (master input, slave output). SPI\_SS and MCLK are driven by the user, for example, a baseboard management controller (BMC).
- No header or ID information required. The 80-bit data format is fixed regardless of ADC sampling selection (see Figure 60).
- The falling edge of SPI\_SS activates the serial interface, at which point MCLK can be used to clock out data on MDAT. The time between SPI\_SS falling edges must be greater than or equal to the maximum ADC sampling time to avoid duplicate data.
- Select single shot mode to allow the falling edge of SPI\_SS to trigger ADC sampling (ADC convert start signal).
- Maximum clock speed (MCLK) is approximately 1 MHz.
- The output stream can be stopped at any point in the output frame via a rising edge on the SPI\_SS pin.
- The MSB of each sample is output first.
- The output data line is high impedance when not transmitting.

For example, if configuring the SPI interface to read back ADC current samples (16 bits), 15 MCLK falling edges are required to clock out all of the bits after the initial falling edge on SPI\_SS. These bits can be clocked out at 1 MHz; therefore, with an ADC sample time of approximately 165  $\mu\text{s}$ , the latency between sample and data is 181  $\mu\text{s}$ . See Figure 3 for SPI timing information.

Note that the MDAT output samples are offset by one sample from the ADC.

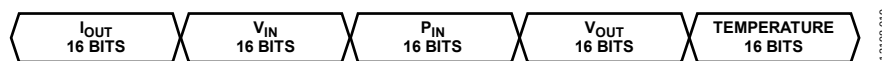


Figure 60. Output Data Format

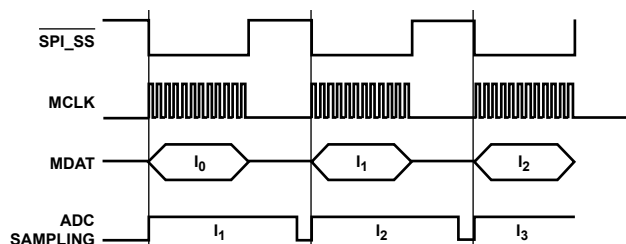


Figure 61. Streaming Current Data Only

## V<sub>OUT</sub> MEASUREMENT

The V<sub>OUT</sub> pin measures the output voltage after the FET. This voltage is used by the device to determine the V<sub>DS</sub> of the MOSFET for foldback operation. Add a 1 kΩ resistor in series between the source of the FET and the V<sub>OUT</sub> pin. This resistor provides some separation between the ADM1278 and the FET source during a fault condition; thus, ADM1278 operation is not affected.

The V<sub>OUT</sub> pin on the ADM1278 can also be used to provide an alternate voltage for the power monitor to measure. The user can choose to measure the input voltage at the HS+ pin and/or the output voltage at the V<sub>OUT</sub> pin.

## FET HEALTH

The ADM1278 provides a comprehensive method of detecting a faulty pass MOSFET. When a faulty FET is detected, the following occurs:

- PWRGD is deasserted.
- FAULT is asserted and latched low.
- FET health PMBus status bits are asserted and latched.

This detection feature ensures that any downstream dc-to-dc converters are disabled, limiting the power dissipation in any faulty or overheating FETs until the user clears the fault, which can be critical to avoid any catastrophic events due to faulty FETs.

A gate to source or gate to drain short is a common type of FET failure. This type of failure is detected by the ADM1278 at any time during operation.

A less common failure is a drain to source short. This normally occurs due to a board manufacturing defect such as a solder short. This type of failure is detected during the initial power-on reset cycle after power-up or after a 10 second autoretry attempt.

There is also an option to disable FET health detection via the PMBus.

## POWER THROTTLING

The ADM1278 provides a number of methods for initiating power throttling of a processor. The simplest method is to configure one of the alert pins for HS\_INLIM\_ENx (Alert 1 and Alert 2 configuration registers, Bit 4). A latched alert is then generated within a few microseconds after the circuit breaker threshold is exceeded (that is, when the TIMER pin starts ramping). This signal throttles the processor in an attempt to reduce the system current level below the circuit breaker threshold before the TIMER regulation period expires.

The CSOUT pin can be used for the purposes of power throttling as well. The response time of the CSOUT pin to a V<sub>SENSE</sub> step of 10 mV is approximately 10 μs. The CSOUT pin can then be fed into a comparator (via a resistor divider) to set a programmable analog threshold for the system current. The output of the comparator can be used to throttle the processor after the configured threshold has been exceeded. The advantage of using the CSOUT pin is that the threshold for

power throttling can be configured independently of the active hot swap current limit. However, the accuracy of the CSOUT pin has to be taken into account when setting the power throttling threshold.

The latest Intel® processors have a fast processor hot (fast PROCHOT) input/output pin that can be used for power throttling. Asserting this pin initiates a deep throttle of the processor. This is usually used as a last attempt at throttling to avoid a card shutting down when all else has failed. The HS\_INLIM\_FAULT alert signal or the CSOUT pin can be used to drive this fast PROCHOT pin to achieve power throttling.

## POWER MONITOR

The ADM1278 features an integrated ADC that accurately measures the current sense voltage, the input voltage, and optionally, the output voltage and temperature at an external transistor. The measured input voltage and current being delivered to the load are multiplied together to give a power value that can be read back. Each power value is also added to an energy accumulator that can be read back to allow an external device to calculate the energy consumption of the load.

The ADM1278 reports the measured current, input voltage, output voltage, and temperature. The PEAK\_IOUT, PEAK\_VIN, PEAK\_VOUT, PEAK\_PIN, and PEAK\_TEMPERATURE commands can be used to read the highest readings since the value was last cleared.

An averaging function is provided for voltage, current, and power that allows a number of samples to be averaged together by the ADM1278. This function reduces the need for postprocessing of sampled data by the host processor. The number of samples that can be averaged is 2<sup>N</sup>, where N is in the range of 0 to 7.

The power monitor current sense amplifier is bipolar and measures both positive and negative currents. The power monitor amplifier has an input range of ±25 mV.

The two basic modes of operation for the power monitor are single shot and continuous. In single shot mode, the ADC samples the input voltage and current a number of times, depending on the averaging value selected by the user. The ADM1278 returns a single value corresponding to the average voltage and current measured. When configured for continuous mode, the power monitor continuously samples the voltage and current, making the most recent sample available to be read.

The single shot mode can be triggered in a number of ways. The simplest method is by selecting the single shot mode using the PMON\_CONFIG command and writing to the convert bit using the PMON\_CONTROL command. The convert bit can also be written as part of a PMBus group command. Using a group command allows multiple devices to be written to as part of the same I<sup>2</sup>C bus transaction, with all devices executing the command when the stop condition appears on the bus. In this way, several devices can be triggered to sample at the same time.

Each time current sense and input voltage measurements are taken, a power calculation is performed, multiplying the two measurements together. This can be read from the device using the READ\_PIN command, returning the input power.

At the same time, the calculated power value is added to a power accumulator register that may increment a rollover counter if the value exceeds the maximum accumulator value. The power accumulator register also increments a power sample counter.

The power accumulator and power sample counter are read using the same READ\_EIN command to ensure that the accumulated value and sample count are from the same point in time. The bus host reading the data assigns a time stamp when the data is read. By calculating the time difference between consecutive uses of READ\_EIN and determining the delta in power consumed, it is possible for the host to determine the total energy consumed over that period.

## PMBUS INTERFACE

The I<sup>2</sup>C bus is a common, simple serial bus used by many devices to communicate. It defines the electrical specifications, the bus timing, the physical layer, and some basic protocol rules.

SMBus is based on I<sup>2</sup>C and aims to provide a more robust and fault tolerant bus. Functions such as bus timeout and packet error checking are added to help achieve this robustness, together with more specific definitions of the bus messages used to read and write data to devices on the bus.

PMBus is layered on top of SMBus and, in turn, on I<sup>2</sup>C. Using the SMBus defined bus messages, PMBus defines a set of standard commands that can be used to control a device that is part of a power chain.

The [ADM1278](#) command set is based on the *PMBus™ Power System Management Protocol Specification*, Part I and Part II, Revision 1.2. This version of the standard is intended to provide a common set of commands for communicating with dc-to-dc type devices. However, many of the standard PMBus commands can be mapped directly to the functions of a hot swap controller.

Part I and Part II of the PMBus standard describe the basic commands and their use in a typical PMBus setup. The following sections describe how the PMBus standard and the [ADM1278](#) specific commands are used.

### DEVICE ADDRESSING

The [ADM1278](#) is available in three A grade models: the [ADM1278-1](#), [ADM1278-2](#), and [ADM1278-3](#). There is also an AA grade version of the [ADM1278-1](#) with improved power monitoring accuracy and a B grade version with lower power monitoring accuracy.

The PMBus device address is seven bits in size. There are no default addresses for any of the models; any device can be programmed to any of 16 possible addresses. Two quad level ADRx pins map to the 16 possible device addresses.

**Table 10. ADRx Pin Connections**

| ADRx State | ADRx Pin Connection      |
|------------|--------------------------|
| Low        | Connect to GND           |
| Resistor   | 150 kΩ resistor to GND   |
| High-Z     | No connection (floating) |
| High       | Connect to VCAP          |

**Table 11. PMBus Address Decode (7-Bit Address)**

| ADR2 State | ADR1 State | Device Address (Hex) |
|------------|------------|----------------------|
| Low        | Low        | 0x10                 |
| Low        | Resistor   | 0x11                 |
| Low        | High-Z     | 0x12                 |
| Low        | High       | 0x13                 |
| Resistor   | Low        | 0x40                 |
| Resistor   | Resistor   | 0x41                 |
| Resistor   | High-Z     | 0x42                 |
| Resistor   | High       | 0x43                 |
| High-Z     | Low        | 0x44                 |
| High-Z     | Resistor   | 0x45                 |
| High-Z     | High-Z     | 0x46                 |
| High-Z     | High       | 0x47                 |
| High       | Low        | 0x50                 |
| High       | Resistor   | 0x51                 |
| High       | High-Z     | 0x52                 |
| High       | High       | 0x53                 |

### SMBUS PROTOCOL USAGE

All I<sup>2</sup>C transactions on the [ADM1278](#) are performed using SMBus defined bus protocols. The following SMBus protocols are implemented by the [ADM1278](#):

- Send byte
- Receive byte
- Write byte
- Read byte
- Write word
- Read word
- Block read

### PACKET ERROR CHECKING

The [ADM1278](#) PMBus interface supports the use of the packet error checking (PEC) byte that is defined in the SMBus standard. The PEC byte is transmitted by the [ADM1278](#) during a read transaction or sent by the bus host to the [ADM1278](#) during a write transaction. The [ADM1278](#) supports the use of PEC with all the SMBus protocols that it implements.

The use of the PEC byte is optional. The bus host can decide whether to use the PEC byte with the [ADM1278](#) on a message by message basis. There is no need to enable or disable PEC in the [ADM1278](#).

The PEC byte is used by the bus host or the [ADM1278](#) to detect errors during a bus transaction, depending on whether the transaction is a read or a write. If the host determines that the PEC byte read during a read transaction is incorrect, it can decide to repeat the read if necessary. If the [ADM1278](#) determines that the PEC byte sent during a write transaction is incorrect, it ignores the command (does not execute it) and sets a status flag.

Within a group command, the host can choose whether to send a PEC byte as part of the message to the ADM1278.

### PARTIAL TRANSACTIONS ON I<sup>2</sup>C BUS

If there is a partial transaction on the I<sup>2</sup>C bus (for example, spurious data interpreted as a start command), the ADM1278 I<sup>2</sup>C bus is not locked up, thinking it is in the middle of an I<sup>2</sup>C transaction. A new start command is recognized even in the middle of another transaction.

### SMBUS MESSAGE FORMATS

Figure 62 to Figure 70 show all the SMBus protocols supported by the ADM1278, along with the PEC variant. In these figures, unshaded cells indicate that the bus host is actively driving the bus; shaded cells indicate that the ADM1278 is driving the bus.

Figure 62 to Figure 70 use the following abbreviations:

- S is the start condition.
- Sr is the repeated start condition.
- P is the stop condition.
- $\overline{R}$  is the read bit.
- $\overline{W}$  is the write bit.
- $\overline{A}$  is the acknowledge bit (0).
- $\overline{A}$  is the acknowledge bit (1).

A, the acknowledge bit, is typically active low (Logic 0) when the transmitted byte is successfully received by a device. However, when the receiving device is the bus master, the acknowledge bit for the last byte read is a Logic 1, indicated by  $\overline{A}$ .

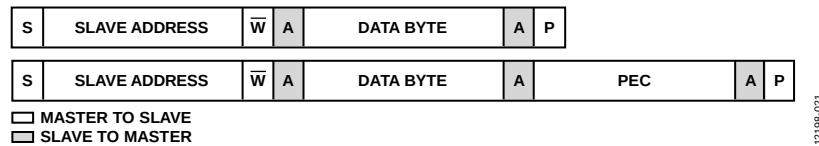


Figure 62. Send Byte and Send Byte with PEC

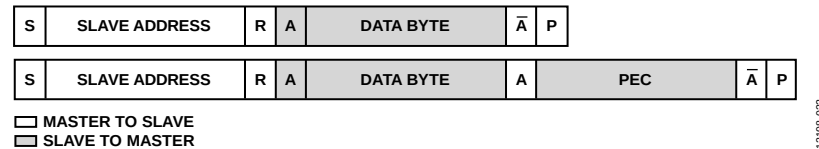


Figure 63. Receive Byte and Receive Byte with PEC

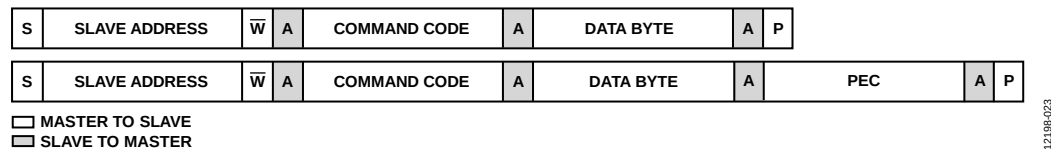


Figure 64. Write Byte and Write Byte with PEC

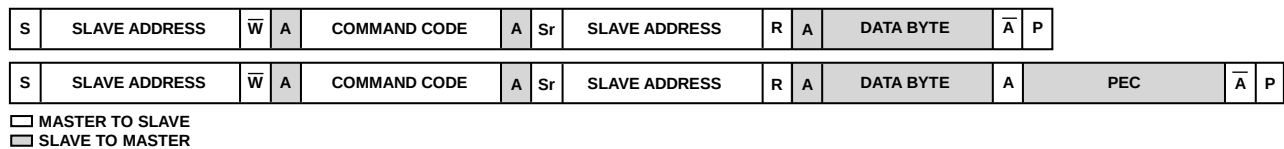


Figure 65. Read Byte and Read Byte with PEC

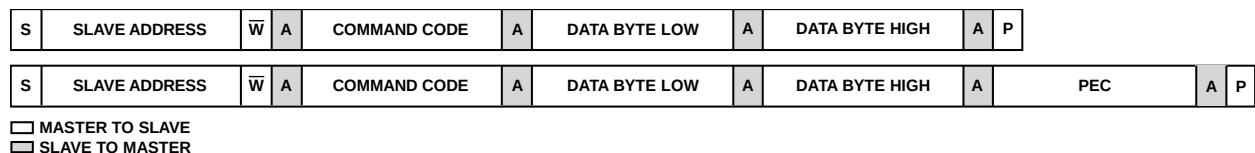


Figure 66. Write Word and Write Word with PEC

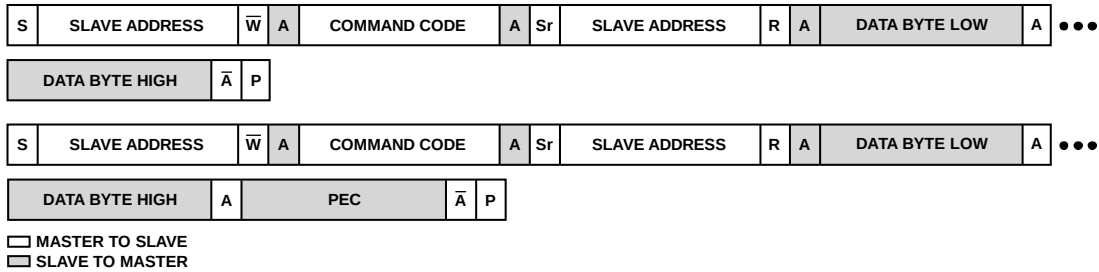


Figure 67. Read Word and Read Word with PEC

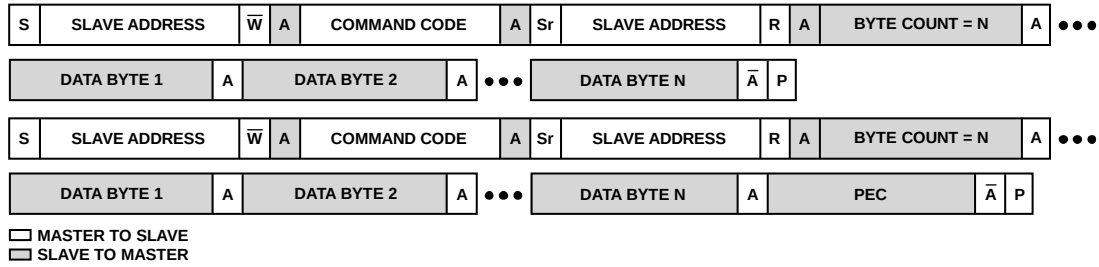


Figure 68. Block Read and Block Read with PEC

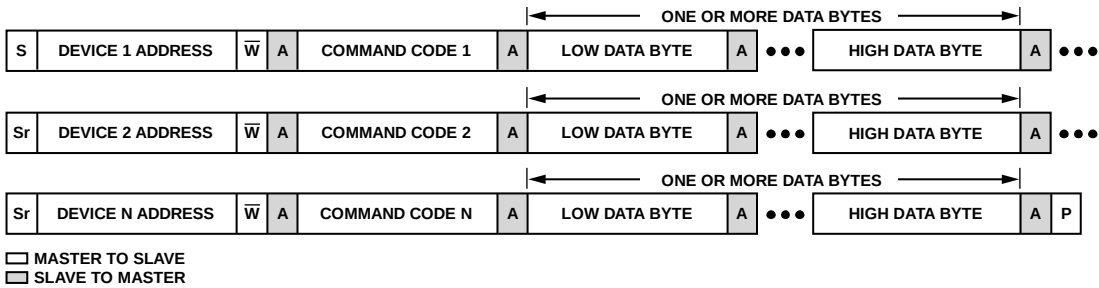


Figure 69. Group Command

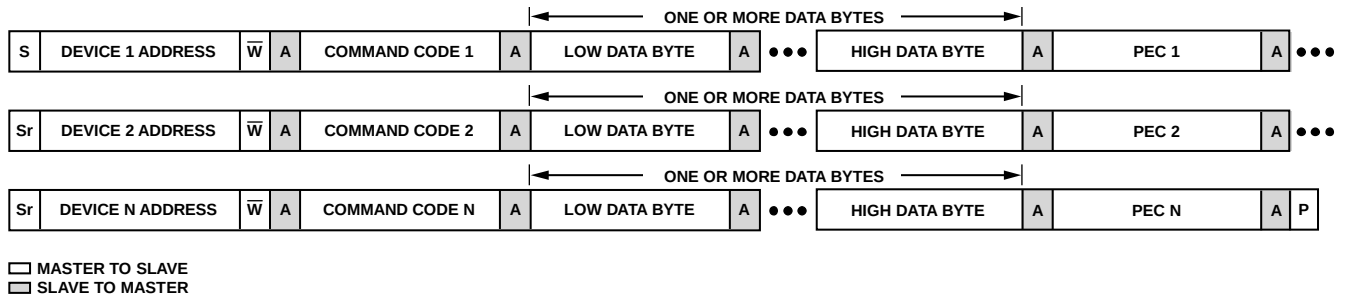


Figure 70. Group Command with PEC

## GROUP COMMANDS

The PMBus standard defines what are known as group commands. Group commands are single bus transactions that send commands or data to more than one device at the same time. Each device is addressed separately, using its own address; there is no special group command address. A group command transaction can contain only write commands that send data to a device. It is not possible to use a group command to read data from devices.

From an I<sup>2</sup>C protocol point of view, a normal write command consists of the following:

- I<sup>2</sup>C start condition.
- Slave address bits and a write bit (followed by an acknowledge from the slave device).
- One or more data bytes (each of which is followed by an acknowledge from the slave device).
- I<sup>2</sup>C stop condition to end the transaction.

A group command differs from a nongroup command in that after the data is written to one slave device, a repeated start condition is placed on the bus followed by the address of the next slave device and data. This continues until all of the devices have been written to, at which point the stop condition is placed on the bus by the master device.

The format of a group command and a group command with PEC is shown in Figure 69 and Figure 70, respectively.

Each device that is written to as part of the group command does not immediately execute the command written. The device must wait until the stop condition appears on the bus. At that point, all devices execute their commands at the same time.

Using a group command, it is possible, for example, to turn multiple PMBus devices on or off simultaneously. In the case of the ADM1278, it is also possible to issue a power monitor command that initiates a conversion, causing multiple ADM1278 devices to sample together at the same time.

## HOT SWAP CONTROL COMMANDS

### OPERATION Command

The GATE pin that drives the FET is controlled by a dedicated hot swap state machine. The UV and OV input pins, the TIMER, PWGIN, and ENABLE pins, and the current sense all feed into the state machine, and they control when and how strongly the gate is turned off.

It is also possible to control the hot swap GATE output using commands over the PMBus interface. The OPERATION command can be used to request the hot swap output to turn on. However, if the UV pin indicates that the input supply is less than required, the hot swap output is not turned on, even if the OPERATION command requests that the output be enabled.

If the OPERATION command is used to disable the hot swap output, the GATE pin is held low, even if all hot swap state machine control inputs indicate that it can be enabled.

The default state of Bit 7 (also named the ON bit) of the OPERATION command is 1; therefore, the hot swap output is always enabled when the ADM1278 emerges from UVLO. If the on bit is never changed, the UV input or the ENABLE/ENABLE input is the hot swap master on/off control signal.

If the on bit is set to 0 while the UV signal is high, the hot swap output is turned off. If the UV signal is low or if the OV signal is high, the hot swap output is already off and the status of the on bit has no effect.

If the on bit is set to 1, the hot swap output is requested to turn on. If the UV signal is low or if the OV signal is high, setting the on bit to 1 has no effect, and the hot swap output remains off.

It is possible to determine at any time whether the hot swap output is enabled using the STATUS\_BYTE or the STATUS\_WORD command (see the Status Commands section).

The OPERATION command can also clear any latched faults in the status registers. To clear latched faults, set the on bit to 0 and then reset it to 1. This also clears the latched FAULT pin.

### DEVICE\_CONFIG Command

The DEVICE\_CONFIG command configures certain settings within the ADM1278, for example, enabling or disabling FET health detection, general-purpose output pin configuration, and modifying the duration of the severe overcurrent settings.

### POWER\_CYCLE Command

The POWER\_CYCLE command can be used to request that the ADM1278 be turned off for approximately five seconds and then turned back on. This command is useful if the processor that controls the ADM1278 is also powered off when the ADM1278 is turned off. This command allows the processor to request that the ADM1278 turn off and on again as part of a single command.

## ADM1278 INFORMATION COMMANDS

### CAPABILITY Command

The CAPABILITY command can be used by host processors to determine the I<sup>2</sup>C bus features that are supported by the ADM1278. The features that can be reported include the maximum bus speed, whether the device supports the packet error checking (PEC) byte, and the SMBAlert reporting function.

### PMBUS\_REVISION Command

The PMBUS\_REVISION command reports the version of Part I and Part II of the PMBus standard.

### MFR\_ID, MFR\_MODEL, and MFR\_REVISION Commands

The MFR\_ID, MFR\_MODEL, and MFR\_REVISION commands return ASCII strings that can be used to facilitate detection and identification of the ADM1278 on the bus.

These commands are read using the SMBus block read message type. This message type requires that the ADM1278 return a byte count corresponding to the length of the string data that is to be read back.

## STATUS COMMANDS

The [ADM1278](#) provides a number of status bits to report faults and warnings from the hot swap controller and the power monitor. These status bits are located in six different registers that are arranged in a hierarchy. The STATUS\_BYTE and STATUS\_WORD commands provide 8 bits and 16 bits of high level information, respectively. The STATUS\_BYTE and STATUS\_WORD commands contain the most important status bits, as well as pointer bits that indicate whether any of the five other status registers need to be read for more detailed status information.

In the [ADM1278](#), a particular distinction is made between faults and warnings. A fault is always generated by the hot swap controller and is typically defined by hardware component values. Events that can generate a fault are

- Overcurrent condition that causes the hot swap timer to time out
- Overvoltage condition on the OV pin
- Undervoltage condition on the UV pin
- Overtemperature condition
- FET health issue detected

When a fault occurs, the hot swap controller always takes some action, usually to turn off the GATE pin, which is driving the FET. The FAULT pin is asserted, and the PWRGD pin is deasserted. A fault can also generate an SMBAlert on the GPO2/ALERT2 pin.

All warnings in the [ADM1278](#) are generated by the power monitor, which samples the voltage, current, and temperature and then compares these measurements to the threshold values set by the various limit commands. A warning has no effect on the hot swap controller, but it may generate an SMBAlert on one or both of the GPOx/ALERTx output pins.

When a status bit is set, it always means that the status condition—fault or warning—is active or was active at some point in the past. When a fault or warning bit is set, it is latched until it is explicitly cleared using either the OPERATION or the CLEAR\_FAULTS command. Some other status bits are live, that is, they always reflect a status condition and are never latched.

### STATUS\_BYTE and STATUS\_WORD Commands

The STATUS\_BYTE and STATUS\_WORD commands obtain a snapshot of the overall device status. These commands indicate whether it is necessary to read more detailed information using the other status commands.

The low byte of the word returned by the STATUS\_WORD command is the same byte returned by the STATUS\_BYTE command. The high byte of the word returned by the STATUS\_WORD command provides a number of bits that determine which of the other status commands needs to be issued to obtain all active status bits. The status bits for FET health and power good are also found in the high byte of STATUS\_WORD.

### STATUS\_INPUT Command

The STATUS\_INPUT command returns a number of bits relating to voltage faults and warnings on the input supply as well as the overpower warning.

### STATUS\_VOUT Command

The STATUS\_VOUT command returns a number of bits relating to voltage warnings on the output supply.

### STATUS\_IOUT Command

The STATUS\_IOUT command returns a number of bits relating to current faults and warnings on the output supply.

### STATUS\_TEMPERATURE Command

The STATUS\_TEMPERATURE command returns a number of bits relating to temperature faults and warnings at the external transistor.

### STATUS\_MFR\_SPECIFIC Command

The STATUS\_MFR\_SPECIFIC command is a standard PMBus command, but the contents of the byte returned are specific to the [ADM1278](#).

### CLEAR\_FAULTS Command

The CLEAR\_FAULTS command clears fault and warnings bits when they are set. Fault and warnings bits are latched when they are set. In this way, a host can read the bits any time after the fault or warning condition occurs and determine which problem actually occurred.

If the CLEAR\_FAULTS command is issued and the fault or warning condition is no longer active, the status bit is cleared. If the condition is still active—for example, if an input voltage is below the undervoltage threshold of the UV pin—the CLEAR\_FAULTS command attempts to clear the status bit, but that status bit is immediately set again.

## GPO AND ALERT PIN SETUP COMMANDS

Two multipurpose pins are provided on the [ADM1278](#): GPO1/ALERT1/CONV and GPO2/ALERT2.

These pins can be configured over the PMBus in one of three output modes, as follows:

- General-purpose digital output
- Output for generating an SMBAlert when one or more fault/warning status bits become active in the PMBus status registers
- Digital comparator

In digital comparator mode, the current, voltage, power and temperature warning thresholds are compared to the values read or calculated by the [ADM1278](#). The comparison result sets the output high or low according to whether the value is greater or less than the warning threshold that has been set.

For an example of how to configure these pins to generate an SMBAlert and how to respond and clear the condition, see the Example Use of SMBus ARA section.

**ALERT1\_CONFIG and ALERT2\_CONFIG Commands**

Using combinations of bit masks, the ALERT1\_CONFIG and ALERT2\_CONFIG commands select the status bits that, when set, generate an SMBAlert signal to a processor, or control the digital comparator mode. Pin 13 and Pin 14 (GPO1/ALERT1/CONV and GPO2/ALERT2) must be configured in SMBAlert or digital comparator mode in the DEVICE\_CONFIG register.

When Pin 13 or Pin 14 is configured in GPO mode, the pin is under software control. If this mode is set, the SMBAlert masking bits are ignored.

**POWER MONITOR COMMANDS**

The ADM1278 provides a high accuracy, 12-bit current, voltage, and temperature power monitor. The power monitor can be configured in a number of different modes of operation and can run in either continuous mode or single shot mode with different sample averaging options.

The power monitor can measure the following quantities:

- Input voltage ( $V_{IN}$ )
- Output voltage ( $V_{OUT}$ )
- Output current ( $I_{OUT}$ )
- External temperature

The following quantities are then calculated:

- Input power ( $P_{IN}$ )
- Input energy ( $E_{IN}$ )

**PMON\_CONFIG Command**

The power monitor can run in a variety of modes. The PMON\_CONFIG command sets up the power monitor.

The settings that can be configured are as follows:

- Single shot or continuous sampling
- $V_{IN}/V_{OUT}$ /temperature sampling enable/disable
- Current and voltage sample averaging
- Power sample averaging
- Simultaneous sampling enable/disable
- Temperature sensor filter enable/disable

Modifying the power monitor settings while the power monitor is sampling is not recommended. To ensure correct operation of the device and to avoid any potential spurious data or the generation of status alerts, stop the power monitor before any of these settings are changed.

**PMON\_CONTROL Command**

Power monitor sampling can be initiated via hardware or via software using the PMON\_CONTROL command. This command can be used with single shot or continuous mode.

**READ\_VIN, READ\_VOUT, and READ\_IOUT Commands**

The ADM1278 power monitor always measures the voltage developed across the sense resistor to provide a current measurement. The input voltage measurement from the HS+ pin is also enabled by default. The output voltage present

on the VOUT pin is available if enabled with the PMON\_CONFIG command.

**READ\_TEMPERATURE\_1 Command**

Temperature measurement at an external transistor can also be enabled with the PMON\_CONFIG command. If enabled, the temperature sensor takes over the ADC for 64  $\mu$ s (typical) every 6 ms and returns a measurement every 12 ms.

**READ\_PIN, READ\_PIN\_EXT, READ\_EIN, and READ\_EIN\_EXT Commands**

The 12-bit input voltage ( $V_{IN}$ ) and 12-bit current ( $I_{OUT}$ ) measurement values are multiplied by the ADM1278 to give the input power value. This is accomplished by using fixed point arithmetic, and produces a 24-bit value. It is assumed that the numbers are in the 12.0 format, meaning that there is no fractional part. Note that only positive  $I_{OUT}$  values are used to avoid returning a negative power.

This 24-bit value can be read from the ADM1278 using the READ\_PIN\_EXT command, where the most significant bit (MSB) is always a zero because PIN\_EXT is a two's complement binary value that is always positive.

The 16 most significant bits of the 24-bit value are used as the value for  $P_{IN}$ . The MSB of the 16-bit  $P_{IN}$  word is always zero, because  $P_{IN}$  is a two's complement binary value that is always positive.

Each time a power calculation is completed, the 24-bit power value is added to a 24-bit energy accumulator register. This is a two's complement representation as well; therefore, the MSB is always zero. Each time this energy accumulator register rolls over from 0x7FFFFFFF to 0x000000, a 16-bit rollover counter is incremented. The rollover counter is straight binary, with a maximum value of 0xFFFF before it rolls over.

A 24-bit straight binary power sample counter is also incremented by 1 each time a power value is calculated and added to the energy accumulator.

These registers can be read back using one of two commands, depending on the level of accuracy required for the energy accumulator and the desire to limit the frequency of reads from the ADM1278.

A bus host can read these values, and by calculating the delta in the energy accumulated, the delta in the number of samples, and the time delta since the last read, the host can calculate the average power since the last read, as well as the energy consumed since then.

The time delta is calculated by the bus host based on when it sends its commands to read from the device, and is not provided by the ADM1278.

To avoid loss of data, the bus host must read at a rate that ensures the rollover counter does not wrap around more than once, and if the counter does wrap around, that the next value read for  $P_{IN}$  is less than the previous one.

The READ\_EIN command returns the top 16 bits of the energy accumulator, the lower 8 bits of the rollover counter, and the full 24 bits of the sample counter.

The READ\_EIN\_EXT command returns the full 24 bits of the energy accumulator, the full 16 bits of the rollover counter, and the full 24 bits of the sample counter. The use of the longer rollover counter means that the time interval between reads of the device can be increased from seconds to minutes without losing any data.

#### **PEAK\_IOUT, PEAK\_VIN, PEAK\_VOUT, PEAK\_PIN, and PEAK\_TEMPERATURE Commands**

In addition to the standard PMBus commands for reading voltage and current, the [ADM1278](#) provides commands that can report the maximum peak voltage, current, power, or temperature value since the peak value was last cleared.

The peak values are updated only after the power monitor has sampled and averaged the current and voltage measurements. Individual peak values are cleared by writing a 0 value with the corresponding command.

#### **WARNING LIMIT SETUP COMMANDS**

The [ADM1278](#) power monitor can monitor a number of different warning conditions simultaneously and report any current, voltage, power, or temperature values that exceed the user defined thresholds using the status commands.

All comparisons performed by the power monitor require the measured value to be strictly greater or less than the threshold value.

At power-up, all threshold limits are set to either minimum scale (for undervoltage or undercurrent conditions) or to maximum scale (for overvoltage, overcurrent, overpower, or overtemperature conditions). This effectively disables the generation of any status warnings by default; warning bits are not set in the status registers until the user explicitly sets the threshold values.

#### **VIN\_OV\_WARN\_LIMIT and VIN\_UV\_WARN\_LIMIT Commands**

The VIN\_OV\_WARN\_LIMIT and VIN\_UV\_WARN\_LIMIT commands set the OV and UV thresholds on the input voltage, as measured at the HS+ pin.

#### **VOUT\_OV\_WARN\_LIMIT and VOUT\_UV\_WARN\_LIMIT Commands**

The VOUT\_OV\_WARN\_LIMIT and VOUT\_UV\_WARN\_LIMIT commands set the OV and UV thresholds on the output voltage, as measured at the VOUT pin.

#### **IOUT\_OC\_WARN\_LIMIT Command**

The IOUT\_OC\_WARN\_LIMIT command sets the OC threshold for the current flowing through the sense resistor.

#### **OT\_WARN\_LIMIT Command**

The OT\_WARN\_LIMIT command sets the overtemperature threshold for the temperature measured at the external transistor.

#### **PIN\_OP\_WARN\_LIMIT Command**

The PIN\_OP\_WARN\_LIMIT command sets the overpower threshold for the power delivered to the load.

#### **PMBUS DIRECT FORMAT CONVERSION**

The [ADM1278](#) uses the PMBus direct format to represent real-world quantities such as voltage, current, and power values. A direct format number takes the form of a 2-byte, twos complement, binary integer value.

It is possible to convert between direct format value and real-world quantities using the following equations. Equation 1 converts from real-world quantities to PMBus direct values, and Equation 2 converts PMBus direct format values to real-world values.

$$Y = (mX + b) \times 10^R \quad (1)$$

$$X = 1/m \times (Y \times 10^{-R} - b) \quad (2)$$

where:

Y is the value in PMBus direct format.

X is the real-world value.

m is the slope coefficient, a 2-byte, twos complement integer.

b is the offset, a 2-byte, twos complement integer.

R is a scaling exponent, a 1-byte, twos complement integer.

The same equations are used for voltage, current, power, and temperature conversions, the only difference being the values of the m, b, and R coefficients that are used. Table 12 lists all the coefficients required for the [ADM1278](#). The current and power coefficients shown are dependent on the value of the external sense resistor used in a given application. This means that an additional calculation must be performed to take the sense resistor value into account to obtain the coefficients for a specific sense resistor value.

The sense resistor value used in the calculations to obtain the coefficients is expressed in milliohms. The m coefficients are defined as 2-byte, twos complement numbers in the PMBus standard; therefore, the maximum positive value that can be represented is 32,767. If the m value is greater than that, and is to be stored in PMBus standard form, then divide the m coefficients by 10, and increase the R coefficient by a value of 1. For example, if a 10 mΩ sense resistor is used, the m coefficient for power is 6123, and the R coefficient is -1.

Example 1: IOUT\_OC\_WARN\_LIMIT requires a current-limit value expressed in direct format.

If the required current limit is 10 A and the sense resistor is 2 mΩ, the first step is to determine the voltage coefficient. This is simply  $m = 800 \times 2$ , giving 1600.

Using Equation 1, and expressing X, in units of amperes,

$$Y = ((1600 \times 10) + 20,475) \times 10^{-1}$$

$$Y = 3647.5 = 3648 \text{ (rounded up to integer form)}$$

Writing a value of 3648 with the IOUT\_OC\_WARN\_LIMIT command sets an overcurrent warning at 10 A.

Example 2: the READ\_IOUT command returns a direct format value of 3339 representing the current flowing through a sense resistor of 1 mΩ.

To convert this value to the current flowing, use Equation 2, with  $m = 800 \times 1$ .

$$X = 1/800 \times (3339 \times 10^1 - 20,475)$$

$$X = 16.14 \text{ A}$$

This means that, when READ\_IOUT returns a value of 3339, 16.14 A is flowing in the sense resistor.

Note that the same calculations that are used to convert power values also apply to the energy accumulator value returned by the READ\_EIN command because the energy accumulator is a summation of multiple power values.

The READ\_PIN\_EXT and READ\_EIN\_EXT commands return 24-bit extended precision versions of the 16-bit values returned by READ\_PIN and READ\_EIN. The direct format values must be divided by 256 prior to being converted with the coefficients shown in Table 12.

Example 3: The PIN\_OP\_WARN\_LIMIT command requires a power limit value expressed in direct format.

If the required power limit is 350 W and the sense resistor is 1 mΩ, the first step is to determine the m coefficient, that is,  $m = 6123 \times 1$ , which is 6123.

Using Equation 1,

$$Y = ((6123 \times 350) \times 10^{-2})$$

$$Y = 21,430.5 = 21,431 \text{ (rounded up to integer form)}$$

Writing a value of 21,431 with the PIN\_OP\_WARN\_LIMIT command sets an overpower warning at 350 W.

## VOLTAGE AND CURRENT CONVERSION USING LSB VALUES

The direct format voltage and current values returned by the READ\_VIN, READ\_VOUT, and READ\_IOUT commands and the corresponding peak versions are the data output directly by the [ADM1278](#) ADC. Because the voltages and currents are 12-bit ADC output codes, they can also be converted to real-world values when there is knowledge of the size of the LSB on the ADC.

Table 12. PMBus Conversion to Real-World Coefficients

| Coefficient | Voltage (V) | Current (A)                    | Power (W)                       | Temperature (°C) |
|-------------|-------------|--------------------------------|---------------------------------|------------------|
| m           | +19,599     | $+800 \times R_{\text{SENSE}}$ | $+6123 \times R_{\text{SENSE}}$ | +42              |
| b           | 0           | +20,475                        | 0                               | +31,880          |
| R           | -2          | -1                             | -2                              | -1               |

The m, b, and R coefficients defined for the PMBus conversion are required to be whole integers by the standard and have, therefore, been rounded slightly. Using this alternative method, with the exact LSB values, can provide somewhat more accurate numerical conversions.

To convert an ADC code to current in amperes, use the following formulas:

$$V_{\text{SENSE\_MO}} = \text{LSB}_{\text{CURRENT}} \times (I_{\text{ADC}} - 2048)$$

$$I_{\text{OUT}} = V_{\text{SENSE\_MO}} / (R_{\text{SENSE}} \times 0.001)$$

where:

$$V_{\text{SENSE\_MO}} = (V_{\text{MO+}}) - (V_{\text{MO-}}).$$

$$\text{LSB}_{\text{CURRENT}} = 12.51 \mu\text{V}.$$

$I_{\text{ADC}}$  is the 12-bit ADC code.

$I_{\text{OUT}}$  is the measured current value in amperes.

$R_{\text{SENSE}}$  is the value of the sense resistor in milliohms.

To convert an ADC code to a voltage, use the following formula:

$$V_M = \text{LSB}_{\text{VOLTAGE}} \times (V_{\text{ADC}} + 0.5)$$

where:

$V_M$  is the measured value in volts.

$$\text{LSB}_{\text{VOLTAGE}} = 5.104 \text{ mV}.$$

$V_{\text{ADC}}$  is the 12-bit ADC code.

To convert a current in amperes to a 12-bit value, use the following formula (round the result to the nearest integer):

$$V_{\text{SENSE\_MO}} = I_A \times R_{\text{SENSE}} \times 0.001$$

$$I_{\text{CODE}} = 2048 + (V_{\text{SENSE\_MO}} / \text{LSB}_{\text{CURRENT}})$$

where:

$$V_{\text{SENSE\_MO}} = (V_{\text{MO+}}) - (V_{\text{MO-}}).$$

$I_A$  is the current value in amperes.

$R_{\text{SENSE}}$  is the value of the sense resistor in milliohms.

$I_{\text{CODE}}$  is the 12-bit ADC code.

$$\text{LSB}_{\text{CURRENT}} = 12.51 \mu\text{V}.$$

To convert a voltage to a 12-bit value, the following formula can be used (round the result to the nearest integer):

$$V_{\text{CODE}} = (V_A / \text{LSB}_{\text{VOLTAGE}}) - 0.5$$

where:

$V_{\text{CODE}}$  is the 12-bit ADC code.

$V_A$  is the voltage value in volts.

$$\text{LSB}_{\text{VOLTAGE}} = 5.104 \text{ mV}.$$

## ALERT PIN BEHAVIOR

The [ADM1278](#) provides a very flexible alert system, whereby one or more fault/warning conditions can be indicated to an external device.

### FAULTS AND WARNINGS

A PMBus fault on the [ADM1278](#) is typically generated due to an analog event (the exception being a temperature fault) and causes a change in state in the hot swap output, turning it off. The defined fault sources are as follows:

- Undervoltage (UV) event detected on the UV pin.
- Overvoltage (OV) event detected on the OV pin.
- Overcurrent (OC) event that causes a hot swap timeout.
- Overtemperature (OT) event detected at the external transistor.
- Fault detected with the pass MOSFET.

Faults are continuously monitored, and, as long as power is applied to the device, they cannot be disabled. When a fault occurs, a corresponding status bit is set in one or more STATUS\_XXX registers.

A value of 1 in a status register bit field always indicates a fault or warning condition. Fault and warning bits in the status registers are latched when set to 1. To clear a latched bit to 0—provided that the fault condition is no longer active—use the CLEAR\_FAULTS command or use the OPERATION command to turn the hot swap output off and then on again.

A warning is less severe than a fault and never causes a change in the state of the hot swap controller. The sources of a warning are defined as follows:

- CML: a communications error occurred on the I<sup>2</sup>C bus.
- HS\_INLIM\_FAULT: the circuit breaker threshold was tripped and the TIMER pin started ramping, but did not necessarily shut the system down.
- I<sub>OUT</sub> OC warning from the ADC.
- V<sub>IN</sub> UV warning from the ADC.
- V<sub>IN</sub> OV warning from the ADC.
- V<sub>OUT</sub> UV warning from the ADC.
- V<sub>OUT</sub> OV warning from the ADC.
- P<sub>IN</sub> overpower (OP) warning from the V<sub>IN</sub> × I<sub>OUT</sub> calculation.
- OT warning from the ADC.
- Hysteretic output warning from the ADC.

### GENERATING AN ALERT

A host device can periodically poll the [ADM1278](#) using the status commands to determine whether a fault/warning is active. However, this polling is very inefficient in terms of software and processor resources. The [ADM1278](#) has two output pins (GPO1/ALERT1/CONV and GPO2/ALERT2) that can be used to generate interrupts to a host processor.

By default at power-up, the open-drain GPO1/ALERT1/CONV and GPO2/ALERT2 outputs are high impedance; therefore, the pins can be pulled high through a resistor. The GPO1/ALERT1/CONV and GPO2/ALERT2 pins are disabled by default on the [ADM1278](#).

Any one or more of the faults and warnings listed in the Faults and Warnings section can be enabled and cause an alert, making the corresponding GPO1/ALERT1/CONV or GPO2/ALERT2 pin active. By default, the active state of the GPO1/ALERT1/CONV and GPO2/ALERT2 pins are low.

For example, to use GPO2/ALERT2 to monitor the V<sub>OUT</sub> UV warning from the ADC, the followings steps must be performed:

1. Set a threshold level with the VOUT\_UV\_WARN\_LIMIT command.
2. Set the VOUT\_UV\_WARN\_EN2 bit in the ALERT2\_CONFIG register.
3. Start the power monitor sampling on V<sub>OUT</sub> (ensure the power monitor is configured to sample V<sub>OUT</sub> in the PMON\_CONFIG register).

If a V<sub>OUT</sub> sample is taken that is below the configured V<sub>OUT</sub> UV value, the GPO2/ALERT2 pin is pulled low, signaling an interrupt to a processor.

### HANDLING/CLEARING AN ALERT

When faults/warnings are configured on the GPO1/ALERT1/CONV or GPO2/ALERT2 pins, the pin becomes active to signal an interrupt to the processor. (The pin is active low, unless inversion is enabled.) The GPO1/ALERT1/CONV or GPO2/ALERT2 signal performs the functions of an SMBAlert.

Note that the GPO1/ALERT1/CONV and GPO2/ALERT2 pins can become active independently but they are always made inactive together.

A processor can respond to the interrupt in one of two ways, depending on whether there is a single or multiple devices on the bus.

#### Single Device on Bus

When there is only one device on the bus, the processor simply reads the status bytes and issues a CLEAR\_FAULTS command to clear all the status bits, which causes the deassertion of the GPO1/ALERT1/CONV or GPO2/ALERT2 line. If there is a persistent fault (for example, an undervoltage on the input), the status bits remain set after the CLEAR\_FAULTS command is executed because the fault has not been removed. However, the GPO1/ALERT1/CONV or GPO2/ALERT2 line is not pulled low unless a new fault or warning becomes active. If the cause of the SMBAlert is a power monitor generated warning and the power monitor is running continuously, the next sample generates a new SMBAlert after the CLEAR\_FAULTS command is issued.

### Multiple Devices on Bus

When there are several devices on the bus, the processor issues an SMBus alert response address (ARA) command to find out which device asserted the SMBAlert line. The processor reads the status bytes from that device and issues a CLEAR\_FAULTS command.

### SMBUS ALERT RESPONSE ADDRESS

The SMBus ARA is a special address that can be used by the bus host to locate any devices that need to communicate with the bus host. A host typically uses a hardware interrupt pin to monitor the SMBus alert pins of multiple devices. When the host interrupt occurs, the host issues a message on the bus using the SMBus receive byte or receive byte with PEC protocol.

The special address used by the host is 0x0C. Any devices that have an SMB alert signal return their own 7-bit address as the seven MSBs of the data byte. The LSB value is not used and can be either 1 or 0. The host reads the device address from the received data byte and proceeds to handle the alert condition.

More than one device may have an active SMBAlert signal and attempt to communicate with the host. In this case, the device with the lowest address dominates the bus and succeeds in transmitting its address to the host. The device that succeeds disables its SMBus alert signal. If the host sees that the SMBus alert signal is still low, it continues to read addresses until all devices that need to communicate have successfully transmitted their addresses.

### EXAMPLE USE OF SMBUS ARA

The full sequence of steps that occurs when an SMBAlert is generated and cleared is as follows:

1. A fault or warning is enabled using the ALERT2\_CONFIG command, and the corresponding status bit for the fault or warning changes from 0 to 1, indicating that the fault or warning has just become active.
2. The GPO2/ALERT2 pin becomes active (set low) to signal that an SMBAlert is active.
3. The host processor issues an SMBus ARA command to determine which device has an active alert.
4. If there are no other active alerts from devices with lower I2C addresses, this device makes the GPO2/ALERT2 pin inactive (set high) during the no acknowledge bit period after it sends its address to the host processor.
5. If the GPO2/ALERT2 pin stays low, the host processor must continue to issue SMBus ARA commands to devices to determine the addresses of all devices that require a status check.
6. The ADM1278 continues to operate with the GPO2/ALERT2 pin inactive and the contents of the status bytes unchanged until the host reads the status bytes and clears them, or until a new fault occurs. That is, if a status bit for a fault/warning that is enabled on the GPO2/ALERT2 pin and that was not already active (equal to 1) changes from 0 to 1, a new alert is generated, causing the GPO2/ALERT2 pin to become active again.

### DIGITAL COMPARATOR MODE

The GPO1/ALERT1/CONV and GPO2/ALERT2 pins can be configured to indicate if a user defined threshold for voltage, current, or power is being exceeded. In this mode, the output pin is live and is not latched when a warning threshold is exceeded. In effect, the pin acts as a digital comparator, where the threshold is set using the warning limit threshold commands.

The ALERTx\_CONFIG command is used, as for the SMBAlert configuration, to select the specific warning threshold to be monitored. The GPO1/ALERT1/CONV or GPO2/ALERT2 pin then indicates if the measured value is above or below the threshold.

### TYPICAL APPLICATION CIRCUITS

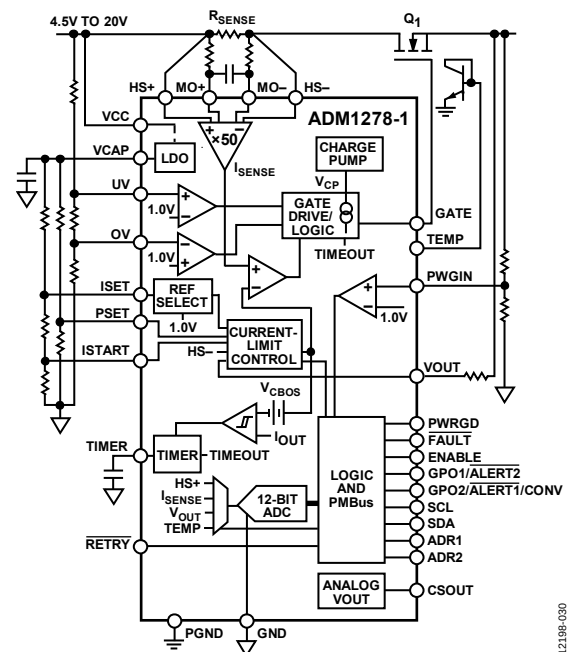


Figure 71. ADM1278-1 Typical Application Circuit



Figure 72. **ADM1278-2** Typical Application Circuit



Figure 73. **ADM1278-3** Typical Application Circuit

## PMBUS COMMAND REFERENCE

Register addresses are in hexadecimal format.

Table 13. PMBus Command Summary

| Address | Name                | SMBus Transaction Type | Number of Data Bytes | Reset              |
|---------|---------------------|------------------------|----------------------|--------------------|
| 0x01    | OPERATION           | Read/write byte        | 1                    | 0x80               |
| 0x03    | CLEAR_FAULTS        | Send byte              | 0                    | Not applicable     |
| 0x19    | CAPABILITY          | Read byte              | 1                    | 0xB0               |
| 0x42    | VOUT_OV_WARN_LIMIT  | Read/write word        | 2                    | 0x0FFF             |
| 0x43    | VOUT_UV_WARN_LIMIT  | Read/write word        | 2                    | 0x0000             |
| 0x4A    | IOUT_OC_WARN_LIMIT  | Read/write word        | 2                    | 0x0FFF             |
| 0x4F    | OT_FAULT_LIMIT      | Read/write word        | 2                    | 0x0FFF             |
| 0x51    | OT_WARN_LIMIT       | Read/write word        | 2                    | 0x0FFF             |
| 0x57    | VIN_OV_WARN_LIMIT   | Read/write word        | 2                    | 0x0FFF             |
| 0x58    | VIN_UV_WARN_LIMIT   | Read/write word        | 2                    | 0x0000             |
| 0x6B    | PIN_OP_WARN_LIMIT   | Read/write word        | 2                    | 0x7FFF             |
| 0x78    | STATUS_BYTE         | Read byte              | 1                    | 0x00               |
| 0x79    | STATUS_WORD         | Read word              | 2                    | 0x0000             |
| 0x7A    | STATUS_VOUT         | Read byte              | 1                    | 0x00               |
| 0x7B    | STATUS_IOUT         | Read byte              | 1                    | 0x00               |
| 0x7C    | STATUS_INPUT        | Read byte              | 1                    | 0x00               |
| 0x7D    | STATUS_TEMPERATURE  | Read byte              | 1                    | 0x00               |
| 0x80    | STATUS_MFR_SPECIFIC | Read byte              | 1                    | 0x00               |
| 0x86    | READ_EIN            | Block read             | 6                    | 0x000000000000     |
| 0x88    | READ_VIN            | Read word              | 2                    | 0x0000             |
| 0x8B    | READ_VOUT           | Read word              | 2                    | 0x0000             |
| 0x8C    | READ_IOUT           | Read word              | 2                    | 0x0000             |
| 0x8D    | READ_TEMPERATURE_1  | Read word              | 2                    | 0x0000             |
| 0x97    | READ_PIN            | Read word              | 2                    | 0x0000             |
| 0x98    | PMBUS_REVISION      | Read byte              | 1                    | 0x22               |
| 0x99    | MFR_ID              | Block read             | 3                    | ASCII = ADI        |
| 0x9A    | MFR_MODEL           | Block read             | 10                   | ASCII = ADM1278-xy |
| 0x9B    | MFR_REVISION        | Block read             | 1                    | 0x33               |
| 0x9D    | MFR_DATE            | Block read             | 6                    | ASCII = YYMMDD     |
| 0xD0    | PEAK_IOUT           | Read/write word        | 2                    | 0x0000             |
| 0xD1    | PEAK_VIN            | Read/write word        | 2                    | 0x0000             |
| 0xD2    | PEAK_VOUT           | Read/write word        | 2                    | 0x0000             |
| 0xD3    | PMON_CONTROL        | Read/write byte        | 1                    | 0x01               |
| 0xD4    | PMON_CONFIG         | Read/write word        | 2                    | 0x0714             |
| 0xD5    | ALERT1_CONFIG       | Read/write word        | 2                    | 0x0000             |
| 0xD6    | ALERT2_CONFIG       | Read/write word        | 2                    | 0x0000             |
| 0xD7    | PEAK_TEMPERATURE    | Read/write word        | 2                    | 0x0000             |
| 0xD8    | DEVICE_CONFIG       | Read/write word        | 2                    | 0x000D             |
| 0xD9    | POWER_CYCLE         | Send byte              | 0                    | Not applicable     |
| 0xDA    | PEAK_PIN            | Read/write word        | 2                    | 0x0000             |
| 0xDB    | READ_PIN_EXT        | Block read             | 3                    | 0x000000           |
| 0xDC    | READ_EIN_EXT        | Block read             | 8                    | 0x0000000000000000 |
| 0xF2    | HYSTERESIS_LOW      | Read/write word        | 2                    | 0x0000             |
| 0xF3    | HYSTERESIS_HIGH     | Read/write word        | 2                    | 0xFFFF             |
| 0xF4    | STATUS_HYSTERESIS   | Read byte              | 1                    | 0x00               |
| 0xF6    | STRT_UP_IOUT_LIM    | Read/write word        | 2                    | 0x000F             |

## REGISTER DETAILS

### OPERATION REGISTER

Address: 0x01, Reset: 0x80, Name: OPERATION

This command requests the hot swap turn on and turn off. When turning the hot swap on, it clears status bits for any faults or warnings that are not active.

Table 14. Bit Descriptions for OPERATION

| Bits  | Bit Name | Settings | Description                                                               | Reset | Access   |
|-------|----------|----------|---------------------------------------------------------------------------|-------|----------|
| 7     | ON       | 0<br>1   | Hot swap enable.<br>Hot swap output disabled.<br>Hot swap output enabled. | 0x1   | RW       |
| [6:0] | RESERVED |          | Always reads as 0000000.                                                  | 0x00  | RESERVED |

### CLEAR FAULTS REGISTER

Address: 0x03, Send Byte, No Data, Name: CLEAR\_FAULTS

This command clears fault and warning bits in all the status registers. Any faults that are still active are not cleared and remain set. Any warnings and the OT\_FAULT that are generated by the power monitor are cleared, but may be asserted again if they remain active following the next power monitor conversion cycle.

This command does not require any data.

### PMBUS CAPABILITY REGISTER

Address: 0x19, Reset: 0xB0, Name: CAPABILITY

Allows the host system to determine the SMBus interface capabilities of the device.

Table 15. Bit Descriptions for CAPABILITY

| Bits  | Bit Name         | Settings | Description                                                                                 | Reset | Access   |
|-------|------------------|----------|---------------------------------------------------------------------------------------------|-------|----------|
| 7     | PEC_SUPPORT      | 1        | Packet error correction (PEC) support.<br>Always reads as 1. PEC is supported.              | 0x1   | R        |
| [6:5] | MAX_BUS_SPEED    | 01       | Maximum bus interface speed.<br>Always reads as 01. Maximum supported bus speed is 400 kHz. | 0x1   | R        |
| 4     | SMBALERT_SUPPORT | 1        | SMBAlert support.<br>Always reads as 1. Device supports SMBAlert and ARA.                   | 0x1   | R        |
| [3:0] | RESERVED         |          | Always reads as 0000.                                                                       | 0x0   | RESERVED |

### V<sub>OUT</sub> OV WARNING LIMIT REGISTER

Address: 0x42, Reset: 0x0FFF, Name: VOUT\_OV\_WARN\_LIMIT

This register sets the overvoltage warning limit for the voltage measured on the VOUT pin.

Table 16. Bit Descriptions for VOUT\_OV\_WARN\_LIMIT

| Bits    | Bit Name           | Settings | Description                                                                             | Reset  | Access   |
|---------|--------------------|----------|-----------------------------------------------------------------------------------------|--------|----------|
| [15:12] | RESERVED           |          | Always reads as 0000.                                                                   | 0x0    | RESERVED |
| [11:0]  | VOUT_OV_WARN_LIMIT |          | Overvoltage warning threshold for the VOUT pin measurement, expressed in direct format. | 0xFFFF | RW       |

**V<sub>OUT</sub> UV WARNING LIMIT REGISTER**

Address: 0x43, Reset: 0x0000, Name: VOUT\_UV\_WARN\_LIMIT

This register sets the undervoltage warning limit for the voltage measured on the VOUT pin.

Table 17. Bit Descriptions for VOUT\_UV\_WARN\_LIMIT

| Bits    | Bit Name           | Settings | Description                                                                              | Reset | Access   |
|---------|--------------------|----------|------------------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED           |          | Always reads as 0000.                                                                    | 0x0   | RESERVED |
| [11:0]  | VOUT_UV_WARN_LIMIT |          | Undervoltage warning threshold for the VOUT pin measurement, expressed in direct format. | 0x000 | RW       |

**I<sub>OUT</sub> OC WARNING LIMIT REGISTER**

Address: 0x4A, Reset: 0x0FFF, Name: IOUT\_OC\_WARN\_LIMIT

This register sets the overcurrent warning limit for the current measured between the MO+ and the MO– pins.

Table 18. Bit Descriptions for IOUT\_OC\_WARN\_LIMIT

| Bits    | Bit Name           | Settings | Description                                                                                     | Reset  | Access   |
|---------|--------------------|----------|-------------------------------------------------------------------------------------------------|--------|----------|
| [15:12] | RESERVED           |          | Always reads as 0000.                                                                           | 0x0    | RESERVED |
| [11:0]  | IOUT_OC_WARN_LIMIT |          | Overcurrent warning threshold for the I <sub>OUT</sub> measurement, expressed in direct format. | 0xFFFF | RW       |

**OT FAULT LIMIT REGISTER**

Address: 0x4F, Reset: 0x0FFF, Name: OT\_FAULT\_LIMIT

This register sets the overtemperature fault limit for the temperature measured on the TEMP pin.

Table 19. Bit Descriptions for OT\_FAULT\_LIMIT

| Bits    | Bit Name       | Settings | Description                                                                               | Reset  | Access   |
|---------|----------------|----------|-------------------------------------------------------------------------------------------|--------|----------|
| [15:12] | RESERVED       |          | Always reads as 0000.                                                                     | 0x0    | RESERVED |
| [11:0]  | OT_FAULT_LIMIT |          | Overtemperature fault threshold for the TEMP pin measurement, expressed in direct format. | 0xFFFF | RW       |

**OT WARNING LIMIT REGISTER**

Address: 0x51, Reset: 0x0FFF, Name: OT\_WARN\_LIMIT

This register sets the overtemperature warning limit for the temperature measured on the TEMP pin.

Table 20. Bit Descriptions for OT\_WARN\_LIMIT

| Bits    | Bit Name      | Settings | Description                                                                                 | Reset  | Access   |
|---------|---------------|----------|---------------------------------------------------------------------------------------------|--------|----------|
| [15:12] | RESERVED      |          | Always reads as 0000.                                                                       | 0x0    | RESERVED |
| [11:0]  | OT_WARN_LIMIT |          | Overtemperature warning threshold for the TEMP pin measurement, expressed in direct format. | 0xFFFF | RW       |

**V<sub>IN</sub> OV WARNING LIMIT REGISTER**

Address: 0x57, Reset: 0x0FFF, Name: VIN\_OV\_WARN\_LIMIT

This register sets the overvoltage warning limit for the voltage measured on the HS+ pin.

Table 21. Bit Descriptions for VIN\_OV\_WARN\_LIMIT

| Bits    | Bit Name          | Settings | Description                                                                            | Reset  | Access   |
|---------|-------------------|----------|----------------------------------------------------------------------------------------|--------|----------|
| [15:12] | RESERVED          |          | Always reads as 0000.                                                                  | 0x0    | RESERVED |
| [11:0]  | VIN_OV_WARN_LIMIT |          | Overvoltage warning threshold for the HS+ pin measurement, expressed in direct format. | 0xFFFF | RW       |

**V<sub>IN</sub> UV WARNING LIMIT REGISTER**

Address: 0x58, Reset: 0x0000, Name: VIN\_UV\_WARN\_LIMIT

This register sets the undervoltage warning limit for the voltage measured on the HS+ pin.

Table 22. Bit Descriptions for VIN\_UV\_WARN\_LIMIT

| Bits    | Bit Name          | Settings | Description                                                                             | Reset | Access   |
|---------|-------------------|----------|-----------------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED          |          | Always reads as 0000.                                                                   | 0x0   | RESERVED |
| [11:0]  | VIN_UV_WARN_LIMIT |          | Undervoltage warning threshold for the HS+ pin measurement, expressed in direct format. | 0x000 | RW       |

**P<sub>IN</sub> OP WARNING LIMIT REGISTER**

Address: 0x6B, Reset: 0x7FFF, Name: PIN\_OP\_WARN\_LIMIT

This register sets the overpower warning limit for the power calculated based on  $V_{IN} \times I_{OUT}$ .

Table 23. Bit Descriptions for PIN\_OP\_WARN\_LIMIT

| Bits   | Bit Name          | Settings | Description                                                                                                | Reset  | Access   |
|--------|-------------------|----------|------------------------------------------------------------------------------------------------------------|--------|----------|
| 15     | RESERVED          |          | Always reads as 0.                                                                                         | 0x0    | RESERVED |
| [14:0] | PIN_OP_WARN_LIMIT |          | Overpower warning threshold for the $V_{IN} \times I_{OUT}$ power calculation, expressed in direct format. | 0x7FFF | RW       |

**STATUS BYTE REGISTER**

Address: 0x78, Reset: 0x00, Name: STATUS\_BYTE

Provides status information for critical faults and certain top-level status commands in the device. This is also the lower byte returned by STATUS\_WORD. A bit set to 1 indicates that a fault or warning has occurred.

Table 24. Bit Descriptions for STATUS\_BYTE

| Bits | Bit Name      | Settings | Description                                                                                                                                                                                                                                                                                                                                                           | Reset | Access   |
|------|---------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| 7    | RESERVED      |          | Always reads as 0.                                                                                                                                                                                                                                                                                                                                                    | 0x0   | RESERVED |
| 6    | HOTSWAP_OFF   | 0<br>1   | Hot swap gate is off. This bit is live.<br>The hot swap gate drive output is enabled.<br>The hot swap gate drive output is disabled, and the GATE pin is pulled down. This can be due to, for example, an overcurrent fault that causes the device to latch off, an undervoltage condition on the UV pin, or the use of the OPERATION command to turn the output off. | 0x0   | R        |
| 5    | RESERVED      |          | Always reads as 0.                                                                                                                                                                                                                                                                                                                                                    | 0x0   | RESERVED |
| 4    | IOUT_OC_FAULT | 0<br>1   | I <sub>OUT</sub> overcurrent fault. This bit is latched.<br>No overcurrent output fault detected.<br>The hot swap controller detected an overcurrent condition and the time limit set by the capacitor on the TIMER pin has elapsed, causing the hot swap gate drive to shut down.                                                                                    | 0x0   | R        |
| 3    | VIN_UV_FAULT  | 0<br>1   | V <sub>IN</sub> fault. This bit is latched.<br>No undervoltage input fault detected on the UV pin.<br>An undervoltage input fault was detected on the UV pin.                                                                                                                                                                                                         | 0x0   | R        |
| 2    | TEMP_FAULT    | 0<br>1   | Temperature fault or warning. This bit is live.<br>There are no active status bits to be read by STATUS_TEMPERATURE.<br>There are one or more active status bits to be read by STATUS_TEMPERATURE.                                                                                                                                                                    | 0x0   | R        |
| 1    | CML_FAULT     | 0<br>1   | CML fault. This bit is latched.<br>No communications error detected on the I <sup>2</sup> C/PMBus interface.<br>An error was detected on the I <sup>2</sup> C/PMBus interface. Errors detected include an unsupported command, invalid PEC byte, and incorrectly structured message.                                                                                  | 0x0   | R        |

| Bits | Bit Name         | Settings | Description                                                                                                                                                                           | Reset | Access |
|------|------------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|--------|
| 0    | NONEABOVE_STATUS | 0<br>1   | None of the above. This bit is live.<br>No other active status bit reported by any other status command.<br>Active status bits are waiting to be read by one or more status commands. | 0x0   | R      |

## STATUS WORD REGISTER

Address: 0x79, Reset: 0x0000, Name: STATUS\_WORD

Provides status information for critical faults and all top-level status commands in the device. The lower byte is also returned by STATUS\_BYTE.

Table 25. Bit Descriptions for STATUS\_WORD

| Bits   | Bit Name         | Settings | Description                                                                                                                                                                                                                         | Reset | Access   |
|--------|------------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| 15     | VOUT_STATUS      | 0<br>1   | V <sub>OUT</sub> warning. This bit is live.<br>There are no active status bits to be read by the STATUS_VOUT register.<br>There are one or more active status bits to be read by STATUS_VOUT.                                       | 0x0   | R        |
| 14     | IOUT_STATUS      | 0<br>1   | I <sub>OUT</sub> fault or warning. This bit is live.<br>There are no active status bits to be read by the STATUS_IOUT register.<br>There are one or more active status bits to be read by the STATUS_IOUT register.                 | 0x0   | R        |
| 13     | INPUT_STATUS     | 0<br>1   | Input warning. This bit is live.<br>There are no active status bits to be read by the STATUS_INPUT register.<br>There are one or more active status bits to be read by STATUS_INPUT.                                                | 0x0   | R        |
| 12     | MFR_STATUS       | 0<br>1   | Manufacture specific fault or warning. This bit is live.<br>There are no active status bits to be read by the STATUS_MFR_SPECIFIC register.<br>There are one or more active status bits to be read by STATUS_MFR_SPECIFIC register. | 0x0   | R        |
| 11     | PGB_STATUS       | 0<br>1   | Power is not good. This bit is live.<br>Output power is good. The voltage on the PWGIN pin is above the threshold.<br>Output power is bad. The voltage on the PWGIN pin is below the threshold.                                     | 0x0   | R        |
| [10:9] | RESERVED         |          |                                                                                                                                                                                                                                     | 0x0   | RESERVED |
| 8      | FET_HEALTH_FAULT | 0<br>1   | FET health fault. This bit is latched.<br>No FET faults have been detected.<br>A fault condition has been detected on the FET.                                                                                                      | 0x0   | R        |
| 7      | RESERVED         |          | Always set to 0.                                                                                                                                                                                                                    | 0x0   | RESERVED |
| 6      | HOTSWAP_OFF      |          | Duplicate of corresponding bit in the STATUS_BYTE register.                                                                                                                                                                         | 0x0   | R        |
| 5      | RESERVED         |          | Always set to 0.                                                                                                                                                                                                                    | 0x0   | RESERVED |
| 4      | IOUT_OC_FAULT    |          | Duplicate of corresponding bit in the STATUS_BYTE register.                                                                                                                                                                         | 0x0   | R        |
| 3      | VIN_UV_FAULT     |          | Duplicate of corresponding bit in the STATUS_BYTE register.                                                                                                                                                                         | 0x0   | R        |
| 2      | TEMP_FAULT       |          | Duplicate of corresponding bit in the STATUS_BYTE register.                                                                                                                                                                         | 0x0   | R        |
| 1      | CML_FAULT        |          | Duplicate of corresponding bit in the STATUS_BYTE register.                                                                                                                                                                         | 0x0   | R        |
| 0      | NONEABOVE_STATUS |          | Duplicate of corresponding bit in the STATUS_BYTE register.                                                                                                                                                                         | 0x0   | R        |

**V<sub>OUT</sub> STATUS REGISTER**

Address: 0x7A, Reset: 0x00, Name: STATUS\_VOUT

Provides status information for warnings related to V<sub>OUT</sub>.

Table 26. Bit Descriptions for STATUS\_VOUT

| Bits  | Bit Name     | Settings | Description                                                                                                                                                                                                                    | Reset | Access   |
|-------|--------------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| 7     | RESERVED     |          | Always reads as 0.                                                                                                                                                                                                             | 0x0   | RESERVED |
| 6     | VOUT_OV_WARN | 0<br>1   | V <sub>OUT</sub> Overvoltage Warning.<br>No overvoltage condition on the output supply detected by the power monitor.<br>An overvoltage condition on the output supply was detected by the power monitor. This bit is latched. | 0x0   | R        |
| 5     | VOUT_UV_WARN | 0<br>1   | V <sub>OUT</sub> UV warning.<br>No undervoltage condition on the output supply detected by the power monitor.<br>An undervoltage condition on the output supply was detected by the power monitor. This bit is latched.        | 0x0   | R        |
| [4:0] | RESERVED     |          | Always reads as 00000.                                                                                                                                                                                                         | 0x00  | RESERVED |

**I<sub>OUT</sub> STATUS REGISTER**

Address: 0x7B, Reset: 0x00, Name: STATUS\_IOUT

Provides status information for faults and warnings related to I<sub>OUT</sub>.

Table 27. Bit Descriptions for STATUS\_IOUT

| Bits  | Bit Name      | Settings | Description                                                                                                                                                                                                                                                                         | Reset | Access   |
|-------|---------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| 7     | IOUT_OC_FAULT | 0<br>1   | I <sub>OUT</sub> overcurrent fault.<br>No overcurrent output fault detected.<br>The hot swap controller detected an overcurrent condition and the time limit set by the capacitor on the TIMER pin has elapsed, causing the hot swap gate drive to shut down. This bit is latched.  | 0x0   | R        |
| 6     | RESERVED      |          | Always reads as 0.                                                                                                                                                                                                                                                                  | 0x0   | RESERVED |
| 5     | IOUT_OC_WARN  | 0<br>1   | I <sub>OUT</sub> overcurrent warning.<br>No overcurrent condition on the output supply detected by the power monitor using the IOUT_OC_WARN_LIMIT command.<br>An overcurrent condition was detected by the power monitor using the IOUT_OC_WARN_LIMIT command. This bit is latched. | 0x0   | R        |
| [4:0] | RESERVED      |          | Always reads as 00000.                                                                                                                                                                                                                                                              | 0x00  | RESERVED |

**INPUT STATUS REGISTER**

Address: 0x7C, Reset: 0x00, Name: STATUS\_INPUT

Provides status information for faults and warnings related to V<sub>IN</sub> and P<sub>IN</sub>.

Table 28. Bit Descriptions for STATUS\_INPUT

| Bits | Bit Name     | Settings | Description                                                                                                                                                                                                                       | Reset | Access |
|------|--------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|--------|
| 7    | VIN_OV_FAULT | 0<br>1   | V <sub>IN</sub> overvoltage fault.<br>No overvoltage detected on the OV pin.<br>An overvoltage was detected on the OV pin. This bit is latched.                                                                                   | 0x0   | R      |
| 6    | VIN_OV_WARN  | 0<br>1   | V <sub>IN</sub> overvoltage warning fault.<br>No overvoltage condition on the input supply detected by the power monitor.<br>An overvoltage condition on the input supply was detected by the power monitor. This bit is latched. | 0x0   | R      |

| Bits  | Bit Name     | Settings | Description                                                                                                                                                                                                                    | Reset | Access   |
|-------|--------------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| 5     | VIN_UV_WARN  | 0<br>1   | V <sub>IN</sub> undervoltage warning.<br>No undervoltage condition on the input supply detected by the power monitor.<br>An undervoltage condition on the input supply was detected by the power monitor. This bit is latched. | 0x0   | R        |
| 4     | VIN_UV_FAULT | 0<br>1   | V <sub>IN</sub> undervoltage fault.<br>No undervoltage detected on the UV pin.<br>An undervoltage was detected on the UV pin. This bit is latched.                                                                             | 0x0   | R        |
| [3:1] | RESERVED     |          | Always reads as 000.                                                                                                                                                                                                           | 0x0   | RESERVED |
| 0     | PIN_OP_WARN  | 0<br>1   | P <sub>IN</sub> overpower warning.<br>No overpower condition on the input supply detected by the power monitor.<br>An overpower condition on the input supply was detected by the power monitor. This bit is latched.          | 0x0   | R        |

## TEMPERATURE STATUS REGISTER

Address: 0x7D, Reset: 0x00, Name: STATUS\_TEMPERATURE

Provides status information for faults and warnings related to temperature.

Table 29. Bit Descriptions for STATUS\_TEMPERATURE

| Bits  | Bit Name   | Settings | Description                                                                                                                                             | Reset | Access   |
|-------|------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| 7     | OT_FAULT   | 0<br>1   | Overtemperature fault.<br>No overtemperature fault detected by the ADC.<br>An overtemperature fault was detected by the ADC. This bit is latched.       | 0x0   | R        |
| 6     | OT_WARNING | 0<br>1   | Overtemperature warning.<br>No overtemperature warning detected by the ADC.<br>An overtemperature warning was detected by the ADC. This bit is latched. | 0x0   | R        |
| [5:0] | RESERVED   |          | Always reads as 000000.                                                                                                                                 | 0x0   | RESERVED |

## MANUFACTURER SPECIFIC STATUS REGISTER

Address: 0x80, Reset: 0x00, Name: STATUS\_MFR\_SPECIFIC

Provides status information for manufacturer specific faults and warnings.

Table 30. Bit Descriptions for STATUS\_MFR\_SPECIFIC

| Bits | Bit Name         | Settings | Description                                                                                                                                                              | Reset | Access |
|------|------------------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|--------|
| 7    | FET_HEALTH_FAULT | 0<br>1   | FET health fault.<br>No FET health problems have been detected.<br>An FET health fault has been detected. This bit is latched.                                           | 0x0   | R      |
| 6    | UV_CMP_OUT       | 0<br>1   | UV input comparator fault output.<br>Input voltage to UV pin is above threshold.<br>Input voltage to UV pin is below threshold. This bit is live.                        | 0x0   | R      |
| 5    | OV_CMP_OUT       | 0<br>1   | OV input comparator fault output.<br>Input voltage to OV pin is below threshold.<br>Input voltage to OV pin is above threshold. This bit is live.                        | 0x0   | R      |
| 4    | SEVERE_OC_FAULT  | 0<br>1   | Severe overcurrent fault.<br>A severe overcurrent has not been detected by the hot swap.<br>A severe overcurrent has been detected by the hot swap. This bit is latched. | 0x0   | R      |

| Bits  | Bit Name          | Settings                               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Reset | Access |
|-------|-------------------|----------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|--------|
| 3     | HS_INLIM_FAULT    | 0<br>1                                 | Hot swap in limit fault.<br>The hot swap has not actively limited the current into the load.<br>The hot swap has actively limited current into the load. This bit differs from the IOUT_OC_FAULT bit in that the HS_INLIM_FAULT bit is set immediately, whereas the IOUT_OC_FAULT bit is not set unless the time limit set by the capacitor on the TIMER pin elapses. This bit is latched.                                                                                                                                                                                                               | 0x0   | R      |
| [2:0] | HS_SHUTDOWN_CAUSE | 000<br>001<br>010<br>011<br>100<br>110 | Cause of last hot swap shutdown. This bit is latched until the status registers are cleared.<br>The hot swap is either enabled and working correctly, or has been shut down using the OPERATION command.<br>An OT_FAULT condition occurred that caused the hot swap to shut down.<br>An IOUT_OC_FAULT condition occurred that caused the hot swap to shut down.<br>An FET_HEALTH_FAULT condition occurred that caused the hot swap to shut down.<br>A VIN_UV_FAULT condition occurred that caused the hot swap to shut down.<br>A VIN_OV_FAULT condition occurred that caused the hot swap to shut down. | 0x0   | R      |

## READ E<sub>IN</sub> REGISTER

Address: 0x86, Reset: 0x000000000000, Name: READ\_EIN

Read the energy metering registers in a single operation to ensure time consistent data.

Table 31. Bit Descriptions for READ\_EIN

| Bits    | Bit Name       | Settings | Description                                                                                                                                                                                                                                                                                         | Reset    | Access |
|---------|----------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|--------|
| [47:24] | SAMPLE_COUNT   |          | This is the total number of P <sub>IN</sub> samples acquired and accumulated in the energy count accumulator. This is an unsigned 24-bit binary value. Byte 5 is the high byte, Byte 4 is the middle byte, and Byte 3 is the low byte.                                                              | 0x000000 | R      |
| [23:16] | ROLLOVER_COUNT |          | Number of times that the energy count has rolled over from 0x7FFF to 0x0000. This is an unsigned 8-bit binary value.                                                                                                                                                                                | 0x00     | R      |
| [15:0]  | ENERGY_COUNT   |          | Energy accumulator value in PMBus direct format. Byte 1 is the high byte, and Byte 0 is the low byte. Internally, the energy accumulator is a 24-bit value, but only the most significant 16 bits are returned with this command. Use the READ_EIN_EXT register to access the nontruncated version. | 0x0000   | R      |

## READ V<sub>IN</sub> REGISTER

Address: 0x88, Reset: 0x0000, Name: READ\_VIN

Reads the input voltage, V<sub>IN</sub>, from the device.

Table 32. Bit Descriptions for READ\_VIN

| Bits    | Bit Name | Settings | Description                                                                             | Reset | Access   |
|---------|----------|----------|-----------------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED |          | Always reads as 0000.                                                                   | 0x0   | RESERVED |
| [11:0]  | READ_VIN |          | Input voltage from the HS+ pin measurement after averaging, expressed in direct format. | 0x000 | R        |

**READ V<sub>OUT</sub> REGISTER**

Address: 0x8B, Reset: 0x0000, Name: READ\_VOUT

Reads the output voltage, V<sub>OUT</sub>, from the device.

Table 33. Bit Descriptions for READ\_VOUT

| Bits    | Bit Name  | Settings | Description                                                                              | Reset | Access   |
|---------|-----------|----------|------------------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED  |          | Always reads as 0000.                                                                    | 0x0   | RESERVED |
| [11:0]  | READ_VOUT |          | Input voltage from the VOUT pin measurement after averaging, expressed in direct format. | 0x000 | R        |

**READ I<sub>OUT</sub> REGISTER**

Address: 0x8C, Reset: 0x0000, Name: READ\_IOUT

Reads the output current, I<sub>OUT</sub>, from the device.

Table 34. Bit Descriptions for READ\_IOUT

| Bits    | Bit Name  | Settings | Description                                                                                                    | Reset | Access   |
|---------|-----------|----------|----------------------------------------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED  |          | Always reads as 0000.                                                                                          | 0x0   | RESERVED |
| [11:0]  | READ_IOUT |          | Output current derived from MO+/MO– sense pin voltage measurement after averaging, expressed in direct format. | 0x000 | R        |

**READ TEMPERATURE 1 REGISTER**

Address: 0x8D, Reset: 0x0000, Name: READ\_TEMPERATURE\_1

Reads the temperature measured by the device.

Table 35. Bit Descriptions for READ\_TEMPERATURE\_1

| Bits    | Bit Name           | Settings | Description                                                                            | Reset | Access   |
|---------|--------------------|----------|----------------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED           |          | Always reads as 0000.                                                                  | 0x0   | RESERVED |
| [11:0]  | READ_TEMPERATURE_1 |          | Temperature from the TEMP pin measurement after averaging, expressed in direct format. | 0x000 | R        |

**READ P<sub>IN</sub> REGISTER**

Address: 0x97, Reset: 0x0000, Name: READ\_PIN

Reads the calculated input power, P<sub>IN</sub>, from the device.

Table 36. Bit Descriptions for READ\_PIN

| Bits   | Bit Name | Settings | Description                                                                                                                                                                                                                                                                                    | Reset  | Access |
|--------|----------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|--------|
| [15:0] | READ_PIN |          | Input power calculation, using $V_{IN} \times I_{OUT}$ , after averaging, expressed in PMBus direct format. P <sub>IN</sub> values are calculated for each $V_{IN} \times I_{OUT}$ sample, all P <sub>IN</sub> values are then averaged before the value is returned to the READ_PIN register. | 0x0000 | R      |

**PMBUS REVISION REGISTER**

Address: 0x98, Reset: 0x22, Name: PMBUS\_REVISION

Allows the system to read the PMBus revision that the device supports.

Table 37. Bit Descriptions for PMBUS\_REVISION

| Bits  | Bit Name          | Settings | Description                          | Reset | Access |
|-------|-------------------|----------|--------------------------------------|-------|--------|
| [7:4] | PMBUS_P1_REVISION | 0010     | PMBus Part I Support. Revision 1.2.  | 0x2   | R      |
| [3:0] | PMBUS_P2_REVISION | 0010     | PMBus Part II Support. Revision 1.2. | 0x2   | R      |

**MANUFACTURER ID REGISTER**

Address: 0x99, Reset: ASCII = ADI, Name: MFR\_ID

Returns a string identifying the Manufacturer of the device.

Table 38. Bit Descriptions for MFR\_ID

| Bits   | Bit Name | Settings | Description                                              | Reset    | Access |
|--------|----------|----------|----------------------------------------------------------|----------|--------|
| [23:0] | MFR_ID   |          | String identifying manufacturer as Analog Devices (ADI). | 0x494441 | R      |

**MANUFACTURER MODEL REGISTER**

Address: 0x9A, Reset: ASCII = ADM1278-xy, Name: MFR\_MODEL

Returns a string identifying the specific model of the device.

Table 39. Bit Descriptions for MFR\_MODEL

| Bits   | Bit Name  | Settings | Description                                                                                                                                                                   | Reset                  | Access |
|--------|-----------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|--------|
| [79:0] | MFR_MODEL |          | String identifying model as ADM1278-xy, where xy identifies the particular model type. Note that the ADM1278-1AA model is identified as ADM1278-1A in the MFR_MODEL register. | 0x41312D383732314D4441 | R      |

**MANUFACTURER REVISION REGISTER**

Address: 0x9B, Reset: 0x33, Name: MFR\_REVISION

Returns a string identifying the hardware revision of the device.

Table 40. Bit Descriptions for MFR\_REVISION

| Bits  | Bit Name     | Settings | Description                                              | Reset | Access |
|-------|--------------|----------|----------------------------------------------------------|-------|--------|
| [7:0] | MFR_REVISION |          | String identifying hardware revision as, for example, 3. | 0x33  | R      |

**MANUFACTURER DATE REGISTER**

Address: 0x9D, Reset: ASCII = YYMMDD, Name: MFR\_DATE

Returns a string identifying the production test date of the device.

Table 41. Bit Descriptions for MFR\_DATE

| Bits   | Bit Name | Settings | Description                                          | Reset          | Access |
|--------|----------|----------|------------------------------------------------------|----------------|--------|
| [47:0] | DATE     |          | String identifying test date, in the form of YYMMDD. | 0x313338303231 | R      |

**PEAK I<sub>OUT</sub> REGISTER**

Address: 0xD0, Reset: 0x0000, Name: PEAK\_IOUT

Reports the peak output current, I<sub>OUT</sub>. Writing 0x0000 with this command resets the peak value.

Table 42. Bit Descriptions for PEAK\_IOUT

| Bits    | Bit Name  | Settings | Description                                                                     | Reset | Access   |
|---------|-----------|----------|---------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED  |          | Always reads as 0000.                                                           | 0x0   | RESERVED |
| [11:0]  | PEAK_IOUT |          | Peak output current measurement, I <sub>OUT</sub> , expressed in direct format. | 0x000 | R        |

**PEAK  $V_{IN}$  REGISTER**

Address: 0xD1, Reset: 0x0000, Name: PEAK\_VIN

Reports the peak input voltage,  $V_{IN}$ . Writing 0x0000 with this command resets the peak value.

Table 43. Bit Descriptions for PEAK\_VIN

| Bits    | Bit Name | Settings | Description                                                            | Reset | Access   |
|---------|----------|----------|------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED |          | Always reads as 0000.                                                  | 0x0   | RESERVED |
| [11:0]  | PEAK_VIN |          | Peak input voltage measurement, $V_{IN}$ , expressed in direct format. | 0x000 | R        |

**PEAK  $V_{OUT}$  REGISTER**

Address: 0xD2, Reset: 0x0000, Name: PEAK\_VOUT

Reports the peak output voltage,  $V_{OUT}$ . Writing 0x0000 with this command resets the peak value.

Table 44. Bit Descriptions for PEAK\_VOUT

| Bits    | Bit Name  | Settings | Description                                                              | Reset | Access   |
|---------|-----------|----------|--------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED  |          | Always reads as 0000.                                                    | 0x0   | RESERVED |
| [11:0]  | PEAK_VOUT |          | Peak output voltage measurement, $V_{OUT}$ , expressed in direct format. | 0x000 | R        |

**POWER MONITOR CONTROL REGISTER**

Address: 0xD3, Reset: 0x01, Name: PMON\_CONTROL

This command starts and stops the power monitor.

Table 45. Bit Descriptions for PMON\_CONTROL

| Bits  | Bit Name | Settings                  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                             | Reset | Access   |
|-------|----------|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| [7:1] | RESERVED |                           | Always reads as 0000000.                                                                                                                                                                                                                                                                                                                                                                                                                                | 0x00  | RESERVED |
| 0     | CONVERT  | <div>0</div> <div>1</div> | <div>Conversion enable.</div> <div>Power monitor is not running.</div> <div>Power monitor is sampling. Default. In single shot mode, this bit clears itself after one complete cycle. In continuous mode, this bit must be written to 0 to stop sampling. A rising edge on the conversion input (CONV function of Pin 13) or a falling edge on SPI_SS sets this bit to 1. During sampling, additional conversion edges on these pins are ignored.</div> | 0x1   | RW       |

**POWER MONITOR CONFIGURATION REGISTER**

Address: 0xD4, Reset: 0x0714, Name: PMON\_CONFIG

This command configures the power monitor. Different combinations of channels can be included in the rotational sampling, and averaging can be set for different measurements.

Table 46. Bit Descriptions for PMON\_CONFIG

| Bits | Bit Name     | Settings                  | Description                                                                                                                                                                         | Reset | Access |
|------|--------------|---------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|--------|
| 15   | TSFILT       | <div>0</div> <div>1</div> | <div>Temperature sensor filter enable.</div> <div>Disabled.</div> <div>Enabled. Data sheet specifications are with the temperature sensor filter disabled.</div>                    | 0x0   | RW     |
| 14   | SIMULTANEOUS | <div>0</div> <div>1</div> | <div>Simultaneous sampling.</div> <div>Disabled.</div> <div>Enabled. Power monitoring accuracy is reduced. Data sheet specifications are with simultaneous sampling disabled.</div> | 0x0   | RW     |

| Bits    | Bit Name  | Settings | Description                                                     | Reset | Access   |
|---------|-----------|----------|-----------------------------------------------------------------|-------|----------|
| [13:11] | PWR_AVG   |          | P <sub>IN</sub> averaging.                                      | 0x0   | RW       |
|         |           | 000      | Disables sample averaging for power.                            |       |          |
|         |           | 001      | Sets sample averaging for power to two samples.                 |       |          |
|         |           | 010      | Sets sample averaging for power to four samples.                |       |          |
|         |           | 011      | Sets sample averaging for power to eight samples.               |       |          |
|         |           | 100      | Sets sample averaging for power to 16 samples.                  |       |          |
|         |           | 101      | Sets sample averaging for power to 32 samples.                  |       |          |
|         |           | 110      | Sets sample averaging for power to 64 samples.                  |       |          |
|         |           | 111      | Sets sample averaging for power to 128 samples.                 |       |          |
| [10:8]  | VI_AVG    |          | V <sub>IN</sub> /V <sub>OUT</sub> /I <sub>OUT</sub> averaging.  | 0x7   | RW       |
|         |           | 000      | Disables sample averaging for current and voltage.              |       |          |
|         |           | 001      | Sets sample averaging for current and voltage to two samples.   |       |          |
|         |           | 010      | Sets sample averaging for current and voltage to four samples.  |       |          |
|         |           | 011      | Sets sample averaging for current and voltage to eight samples. |       |          |
|         |           | 100      | Sets sample averaging for current and voltage to 16 samples.    |       |          |
|         |           | 101      | Sets sample averaging for current and voltage to 32 samples.    |       |          |
|         |           | 110      | Sets sample averaging for current and voltage to 64 samples.    |       |          |
|         |           | 111      | Sets sample averaging for current and voltage to 128 samples.   |       |          |
| [7:5]   | RESERVED  |          | Always reads as 000.                                            | 0x0   | RESERVED |
| 4       | PMON_MODE |          | Conversion mode.                                                | 0x1   | RW       |
|         |           | 0        | Single shot sampling.                                           |       |          |
|         |           | 1        | Continuous sampling.                                            |       |          |
| 3       | TEMP1_EN  |          | Enable temperature sampling.                                    | 0x0   | RW       |
|         |           | 0        | Temperature sampling disabled.                                  |       |          |
|         |           | 1        | Temperature sampling enabled.                                   |       |          |
| 2       | VIN_EN    |          | Enable V <sub>IN</sub> sampling.                                | 0x1   | RW       |
|         |           | 0        | V <sub>IN</sub> sampling disabled.                              |       |          |
|         |           | 1        | V <sub>IN</sub> sampling enabled.                               |       |          |
| 1       | VOUT_EN   |          | Enable V <sub>OUT</sub> sampling.                               | 0x0   | RW       |
|         |           | 0        | V <sub>OUT</sub> sampling disabled.                             |       |          |
|         |           | 1        | V <sub>OUT</sub> sampling enabled.                              |       |          |
| 0       | RESERVED  |          | Always reads as 0.                                              | 0x0   | RESERVED |

## ALERT 1 CONFIGURATION REGISTER

Address: 0xD5, Reset: 0x0000, Name: ALERT1\_CONFIG

This commands allows different combinations of faults and warnings to be configured on the GPO1 output of the GPO1/ $\overline{\text{ALERT1}}$ /CONV pin. The pin can operate in different modes, configured using the DEVICE\_CONFIG command.

Table 47. Bit Descriptions for ALERT1\_CONFIG

| Bits | Bit Name             | Settings | Description                                   | Reset | Access |
|------|----------------------|----------|-----------------------------------------------|-------|--------|
| 15   | FET_HEALTH_FAULT_EN1 |          | FET health fault enable.                      | 0x0   | RW     |
| 14   | IOUT_OC_FAULT_EN1    |          | I <sub>OUT</sub> overcurrent fault enable.    | 0x0   | RW     |
| 13   | VIN_OV_FAULT_EN1     |          | V <sub>IN</sub> overvoltage fault enable.     | 0x0   | RW     |
| 12   | VIN_UV_FAULT_EN1     |          | V <sub>IN</sub> undervoltage fault enable.    | 0x0   | RW     |
| 11   | CML_ERROR_EN1        |          | Communications error enable.                  | 0x0   | RW     |
| 10   | IOUT_OC_WARN_EN1     |          | I <sub>OUT</sub> overcurrent warning enable.  | 0x0   | RW     |
| 9    | HYSTERETIC_EN1       |          | Hysteretic output enable.                     | 0x0   | RW     |
| 8    | VIN_OV_WARN_EN1      |          | V <sub>IN</sub> overvoltage warning enable.   | 0x0   | RW     |
| 7    | VIN_UV_WARN_EN1      |          | V <sub>IN</sub> undervoltage warning enable.  | 0x0   | RW     |
| 6    | VOUT_OV_WARN_EN1     |          | V <sub>OUT</sub> overvoltage warning enable.  | 0x0   | RW     |
| 5    | VOUT_UV_WARN_EN1     |          | V <sub>OUT</sub> undervoltage warning enable. | 0x0   | RW     |
| 4    | HS_INLIM_EN1         |          | Hot swap in-limit enable.                     | 0x0   | RW     |

| Bits | Bit Name        | Settings | Description                               | Reset | Access   |
|------|-----------------|----------|-------------------------------------------|-------|----------|
| 3    | PIN_OP_WARN_EN1 |          | P <sub>IN</sub> overpower warning enable. | 0x0   | RW       |
| 2    | OT_FAULT_EN1    |          | Overtemperature fault enable.             | 0x0   | RW       |
| 1    | OT_WARN_EN1     |          | Overtemperature warning enable.           | 0x0   | RW       |
| 0    | RESERVED        |          | Always reads as 0.                        | 0x0   | RESERVED |

## ALERT 2 CONFIGURATION REGISTER

Address: 0xD6, Reset: 0x0000, Name: ALERT2\_CONFIG

This commands allows different combinations of faults and warnings to be configured on the GPO2 output of the GPO2/ALERT2 pin. The pin can operate in different modes, configured using the DEVICE\_CONFIG command.

Table 48. Bit Descriptions for ALERT2\_CONFIG

| Bits | Bit Name             | Settings | Description                                   | Reset | Access   |
|------|----------------------|----------|-----------------------------------------------|-------|----------|
| 15   | FET_HEALTH_FAULT_EN2 |          | FET health fault enable.                      | 0x0   | RW       |
| 14   | IOUT_OC_FAULT_EN2    |          | I <sub>OUT</sub> overcurrent fault enable.    | 0x0   | RW       |
| 13   | VIN_OV_FAULT_EN2     |          | V <sub>IN</sub> overvoltage fault enable.     | 0x0   | RW       |
| 12   | VIN_UV_FAULT_EN2     |          | V <sub>IN</sub> undervoltage fault enable.    | 0x0   | RW       |
| 11   | CML_ERROR_EN2        |          | Communications error enable.                  | 0x0   | RW       |
| 10   | IOUT_OC_WARN_EN2     |          | I <sub>OUT</sub> overcurrent warning enable.  | 0x0   | RW       |
| 9    | HYSTERETIC_EN2       |          | Hysteretic output enable.                     | 0x0   | RW       |
| 8    | VIN_OV_WARN_EN2      |          | V <sub>IN</sub> overvoltage warning enable.   | 0x0   | RW       |
| 7    | VIN_UV_WARN_EN2      |          | V <sub>IN</sub> undervoltage warning enable.  | 0x0   | RW       |
| 6    | VOUT_OV_WARN_EN2     |          | V <sub>OUT</sub> overvoltage warning enable.  | 0x0   | RW       |
| 5    | VOUT_UV_WARN_EN2     |          | V <sub>OUT</sub> undervoltage warning enable. | 0x0   | RW       |
| 4    | HS_INLIM_EN2         |          | Hot swap in-limit enable.                     | 0x0   | RW       |
| 3    | PIN_OP_WARN_EN2      |          | P <sub>IN</sub> overpower warning enable.     | 0x0   | RW       |
| 2    | OT_FAULT_EN2         |          | Overtemperature fault enable.                 | 0x0   | RW       |
| 1    | OT_WARN_EN2          |          | Overtemperature warning enable.               | 0x0   | RW       |
| 0    | RESERVED             |          | Always reads as 0.                            | 0x0   | RESERVED |

## PEAK TEMPERATURE REGISTER

Address: 0xD7, Reset: 0x0000, Name: PEAK\_TEMPERATURE

Reports the peak measured temperature. Writing 0x0000 with this command resets the peak value.

Table 49. Bit Descriptions for PEAK\_TEMPERATURE

| Bits    | Bit Name         | Settings | Description                                               | Reset | Access   |
|---------|------------------|----------|-----------------------------------------------------------|-------|----------|
| [15:12] | RESERVED         |          | Always reads as 0000.                                     | 0x0   | RESERVED |
| [11:0]  | PEAK_TEMPERATURE |          | Peak temperature measurement, expressed in direct format. | 0x000 | R        |

## DEVICE CONFIGURATION REGISTER

Address: 0xD8, Reset: 0x000D, Name: DEVICE\_CONFIG

This command configures the hot swap overcurrent threshold and filtering, and GPO1/GPO2 output modes. Note that dual function pin names are referenced by the relevant function only, for example, GPO2 for the general-purpose output function of the GPO2/ALERT2 pin (see the Pin Configurations and Function Descriptions section for full pin mnemonics and descriptions).

Table 50. Bit Descriptions for DEVICE\_CONFIG

| Bits    | Bit Name | Settings | Description                                                                      | Reset | Access   |
|---------|----------|----------|----------------------------------------------------------------------------------|-------|----------|
| [15:12] | RESERVED |          | Always reads as 0000.                                                            | 0x0   | RESERVED |
| 11      | FHDIS    | 0<br>1   | FET health disable.<br>FET health checks enabled.<br>FET health checks disabled. | 0x0   | RW       |

| Bits  | Bit Name       | Settings             | Description                                                                                                                                                                                                                                                                                                                                                                                                                         | Reset | Access |
|-------|----------------|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|--------|
| 10    | PWR_HYST_EN    | 0<br>1               | When enabled, the general-purpose output alert hysteresis functions refer to power rather than current. The HYSTERETIC_ENx bit also needs to be set in ALERT_CONFIG.<br>Current hysteresis mode.<br>Power hysteresis mode.                                                                                                                                                                                                          | 0x0   | RW     |
| [9:8] | GPO2_MODE      | 00<br>01<br>10<br>11 | GPO2 configuration mode.<br>Default. GPO2 is configured to generate SMBAlerts.<br>GPO2 can be used as a general-purpose digital output pin. Use the GPO2_INVERT bit to change the output state.<br>Reserved.<br>This is digital comparator mode. The output pin now reflects the live status of the warning or fault bit selected for the output. In effect, this is a nonlatched SMBAlert.                                         | 0x0   | RW     |
| 7     | GPO2_INVERT    | 0<br>1               | GPO2 invert mode.<br>In SMBAlert mode, the output is not inverted, and active low. In GPO mode, the output is set low.<br>In SMBAlert mode, the output is inverted, and active high. In GPO mode, the output is set high.                                                                                                                                                                                                           | 0x0   | RW     |
| [6:5] | GPO1_MODE      | 00<br>01<br>10<br>11 | GPO1 configuration mode.<br>Default. GPO1 is configured to generate SMBAlerts.<br>GPO1 can be used as a general-purpose digital output pin. Use the GPO1_INVERT bit to change the output state.<br>GPO1 is configured as a convert (CONV) input pin.<br>This is digital comparator mode. The output pin now reflects the live status of the warning or fault bit selected for the output. In effect, this is a nonlatched SMBAlert. | 0x0   | RW     |
| 4     | GPO1_INVERT    | 0<br>1               | GPO1 invert mode.<br>In SMBAlert mode, the output is not inverted, and active low. In GPO mode, the output is set low.<br>In SMBAlert mode, the output is inverted, and active high. In GPO mode, the output is set high.                                                                                                                                                                                                           | 0x0   | RW     |
| [3:2] | OC_TRIP_SELECT | 00<br>01<br>10<br>11 | Severe overcurrent threshold select.<br>125%.<br>150%.<br>200%.<br>Default, 225%.                                                                                                                                                                                                                                                                                                                                                   | 0x11  | RW     |
| 1     | OC_RETRY_DIS   | 0<br>1               | Severe OC retry mode.<br>Retry once immediately after severe overcurrent event.<br>Latch off after severe overcurrent event.                                                                                                                                                                                                                                                                                                        | 0x0   | RW     |
| 0     | OC_FILT_SELECT | 0<br>1               | Severe overcurrent filter select.<br>200 ns.<br>Default, 900 ns.                                                                                                                                                                                                                                                                                                                                                                    | 0x1   | RW     |

## POWER CYCLE REGISTER

Address: 0xD9, Send Byte, No Data, Name: POWER\_CYCLE

This command is provided to allow a processor to request the hot swap to turn off and turn back on again approximately five seconds later. This is useful in the event that the hot swap output is powering the processor.

This command does not require any data.

**PEAK P<sub>IN</sub> REGISTER**

Address: 0xDA, Reset: 0x0000, Name: PEAK\_PIN

Reports the peak input power, P<sub>IN</sub>. Writing 0x0000 with this command resets the peak value.

Table 51. Bit Descriptions for PEAK\_PIN

| Bits   | Bit Name | Settings | Description                                                                 | Reset  | Access |
|--------|----------|----------|-----------------------------------------------------------------------------|--------|--------|
| [15:0] | PEAK_PIN |          | Peak input power calculation, P <sub>IN</sub> , expressed in direct format. | 0x0000 | R      |

**READ P<sub>IN</sub> (EXTENDED) REGISTER**

Address: 0xDB, Reset: 0x000000, Name: READ\_PIN\_EXT

Reads the extended precision version of the calculated input power, P<sub>IN</sub>, from the device.

Table 52. Bit Descriptions for READ\_PIN\_EXT

| Bits   | Bit Name     | Settings | Description                                                                                                     | Reset    | Access |
|--------|--------------|----------|-----------------------------------------------------------------------------------------------------------------|----------|--------|
| [23:0] | READ_PIN_EXT |          | Extended precision version of peak input power calculation, P <sub>IN</sub> , expressed in PMBus direct format. | 0x000000 | R      |

**READ E<sub>IN</sub> (EXTENDED) REGISTER**

Address: 0xDC, Reset: 0x0000000000000000, Name: READ\_EIN\_EXT

Read the extended precision energy metering registers in a single operation to ensure time consistent data.

Table 53. Bit Descriptions for READ\_EIN\_EXT

| Bits    | Bit Name     | Settings | Description                                                                                                                                                                                                                            | Reset    | Access |
|---------|--------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|--------|
| [63:40] | SAMPLE_COUNT |          | This is the total number of P <sub>IN</sub> samples acquired and accumulated in the energy count accumulator. This is an unsigned 24-bit binary value. Byte 7 is the high byte, Byte 6 is the middle byte, and Byte 5 is the low byte. | 0x000000 | R      |
| [39:24] | ROLLOVER_EXT |          | Number of times that the energy count has rolled over from 0x7FFFFFFF to 0x000000. This is an unsigned 16-bit binary value. Byte 4 is the high byte, and Byte 3 is the low byte.                                                       | 0x0000   | R      |
| [23:0]  | ENERGY_EXT   |          | Extended precision energy accumulator value in PMBus direct format. Byte 2 is the high byte, Byte 1 is the middle byte, and Byte 0 is the low byte.                                                                                    | 0x000000 | R      |

**HYSTERESIS LOW LEVEL REGISTER**

Address: 0xF2, Reset: 0x0000, Name: HYSTERESIS\_LOW

This sets the lower threshold used to generate the hysteretic output signal, which can be made available on a general-purpose output pin.

Table 54. Bit Descriptions for HYSTERESIS\_LOW

| Bits   | Bit Name       | Settings | Description                                                               | Reset | Access |
|--------|----------------|----------|---------------------------------------------------------------------------|-------|--------|
| [15:0] | HYSTERESIS_LOW |          | Value setting the lower hysteresis threshold, expressed in direct format. | 0x000 | RW     |

**HYSTERESIS HIGH LEVEL REGISTER**

Address: 0xF3, Reset: 0xFFFF, Name: HYSTERESIS\_HIGH

This sets the higher threshold used to generate the hysteretic output signal, which can be made available on a general-purpose output pin.

Table 55. Bit Descriptions for HYSTERESIS\_HIGH

| Bits   | Bit Name        | Settings | Description                                                                | Reset  | Access |
|--------|-----------------|----------|----------------------------------------------------------------------------|--------|--------|
| [15:0] | HYSTERESIS_HIGH |          | Value setting the higher hysteresis threshold, expressed in direct format. | 0xFFFF | RW     |

**HYSTERESIS STATUS REGISTER****Address:** 0xF4, **Reset:** 0x00, **Name:** STATUS\_HYSTERESIS

This status register reports whether the hysteretic comparison is above or below the user defined thresholds, and the IOUT\_OC\_WARNING status bit as well.

**Table 56. Bit Descriptions for STATUS\_HYSTERESIS**

| Bits  | Bit Name     | Settings | Description                                                                                                                                                                                                                                                    | Reset | Access   |
|-------|--------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|
| [7:4] | RESERVED     |          | Always reads as 0000.                                                                                                                                                                                                                                          | 0x0   | RESERVED |
| 3     | IOUT_OC_WARN | 0<br>1   | I <sub>OUT</sub> overcurrent warning.<br>No overcurrent condition on the output supply detected by the power monitor using the IOUT_OC_WARN_LIMIT command.<br>An overcurrent condition was detected by the power monitor using the IOUT_OC_WARN_LIMIT command. | 0x0   | R        |
| 2     | HYST_STATE   | 0<br>1   | Hysteretic comparison output.<br>Comparison output low.<br>Comparison output high.                                                                                                                                                                             | 0x0   | R        |
| 1     | HYST_GT_HIGH | 0<br>1   | Hysteretic upper threshold comparison.<br>Compared value is below upper threshold.<br>Compared value is above upper threshold.                                                                                                                                 | 0x0   | R        |
| 0     | HYST_LT_LOW  | 0<br>1   | Hysteretic lower threshold comparison.<br>Compared value is above lower threshold.<br>Compared value is below lower threshold.                                                                                                                                 | 0x0   | R        |

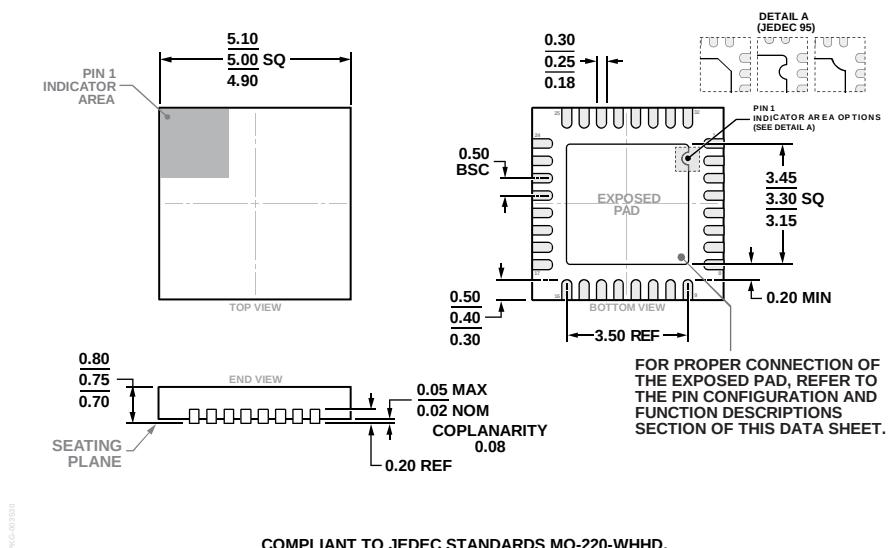
**START-UP I<sub>OUT</sub> LIMIT REGISTER****Address:** 0xF6, **Reset:** 0x000F, **Name:** STRT\_UP\_IOUT\_LIM

This sets the current limit initially used while the hot swap is turning on the FET.

**Table 57. Bit Descriptions for STRT\_UP\_IOUT\_LIM**

| Bits   | Bit Name         | Settings | Description                                                    | Reset | Access   |
|--------|------------------|----------|----------------------------------------------------------------|-------|----------|
| [15:4] | RESERVED         |          | Always reads as 0x00.                                          | 0x00  | RESERVED |
| [3:0]  | STRT_UP_IOUT_LIM |          | Current limit used during startup, expressed in direct format. | 0xF   | RW       |

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WHHD.

Figure 74. 32-Lead Lead Frame Chip Scale Package [LFCSP]  
5 mm × 5 mm Body and 0.75 mm Package Height  
(CP-32-13)  
Dimensions shown in millimeters

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                           | Package Option |
|--------------------|-------------------|-----------------------------------------------|----------------|
| ADM1278-1AAPZ      | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-1AAPZ-RL   | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-1ACPZ      | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-1ACPZ-RL   | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-1BCPZ      | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-1BCPZ-RL   | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-2ACPZ      | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-2ACPZ-RL   | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-3ACPZ      | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| ADM1278-3ACPZ-RL   | –40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-13       |
| EVAL-ADM1278EBZ    |                   | Evaluation Kit                                |                |

<sup>1</sup> Z = RoHS Compliant Part.

I<sup>2</sup>C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

## Looking for pricing, stock, or lifecycle information?

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 [Analog Devices Inc.](#) Information

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